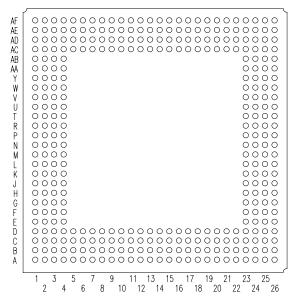
- Single Chip Parallel MIMD DSP
- Over 1.5 Billion RISC-like Operations per Second
- Master Processor (MP)
 - 32-Bit RISC Processor
 - IEEE-754 Floating Point
 - 4K-Byte Instruction Cache
 - 4K-Byte Data Cache
- Two Parallel Processors (PPs)
 - 32-Bit Advanced DSP Processors
 - 64-Bit Opcode Provides Many
 Parallel Operations per Cycle
 - 4K-Byte Instruction Cache, 4K-Byte Parameter RAM, and 8K Bytes of Data RAM per PP
- Transfer Controller (TC)
 - 64-Bit Data Transfers
 - Up to 480M-Byte/s Transfer Rate
 - 32-Bit Addressing
 - Direct EDO DRAM/VRAM Interface
 - Direct SDRAM Interface
 - Dynamic Bus Sizing
 - Intelligent Queuing and Cycle Prioritization

GGP PACKAGE (BOTTOM VIEW)



- Big or Little Endian Operation
- 44K Bytes of On-Chip RAM
- 4G-Byte Address Space
- 16.6 ns Cycle Time
- 3.3-V Operation
- IEEE 1149.1 Test Port (JTAG)

description

The TMS320C82 is a single chip, MIMD (multiple instruction/multiple data) parallel processor capable of performing over 1.5 billion operations per second. It consists of a 32-bit RISC Master Processor with a 120-MFlop IEEE Floating Point Unit, two 32-bit parallel-processing DSPs (PPs), and a Transfer Controller with up to 480 Mbyte/sec transfer rate. All the processors are tightly coupled via an on-chip crossbar which provides shared access to on-chip RAM. This performance and programmability make the 'C82 ideally suited for video, imaging, and high-speed telecommunication applications.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

architecture

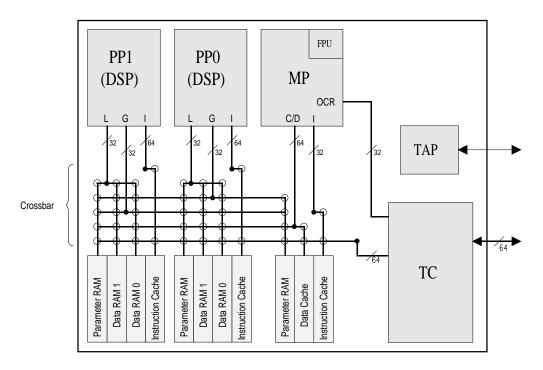


Figure 1. 'C82 Block Diagram Showing Datapaths

The 'C82 Block Diagram shows the major components of the 'C82: the Master Processor (MP), Parallel Processors (PPs), Transfer Controller (TC), and JTAG Emulation Interface. Shared access to on-chip RAMs is achieved through the Crossbar. Crossbar connections are represented by O. Each PP can perform three accesses per cycle through its Local, Global, and Instruction ports. The MP can access two RAMs per cycle through its Crossbar/Data and Instruction ports and the TC can access one RAM through its crossbar interface. Thus, up to nine simultaneous accesses are supported in each cycle. Addresses can be changed every cycle, allowing the crossbar matrix to be changed on a cycle-by-cycle basis. Contention between processors for the same RAM in the same cycle is resolved by a round-robin priority scheme. In addition to the Crossbar, a 32-bit data path exists between the MP and the TC. This allows the MP to access TC control registers which are memory-mapped into the MP's memory space.

pin assignments - numerical listing

| PIN NO. | FUNCTION | PIN NO. | FUNCTION | PIN NO. | FUNCTION | PIN NO. | FUNCTION | | | |
|---------|----------|---------|-----------------|---------|--------------------|---------|--------------------|--|--|--|
| A1 | NC | B1 | NC | C1 | NC | D1 | NC | | | |
| A2 | NC | B2 | NC | C2 | /DDIN | D2 | /TRG/CAS | | | |
| A3 | NC | В3 | /DBEN | C3 | NC | D3 | V _{SS} | | | |
| A4 | NC | B4 | V _{DD} | C4 | V _{DD} | D4 | NC | | | |
| A5 | NC | B5 | STATUS0 | C5 | V _{SS} | D5 | STATUS1 | | | |
| A6 | NC | B6 | /CAS/DQM6 | C6 | V _{DD} | D6 | /CAS/DQM7 | | | |
| A7 | NC | B7 | V _{SS} | C7 | /CAS/DQM5 | D7 | V _{SS} | | | |
| A8 | NC | B8 | v_{DD} | C8 | /CAS/DQM3 | D8 | /CAS/DQM4 | | | |
| A9 | NC | B9 | /CAS/DQM1 | C9 | /CAS/DQM2 | D9 | V _{DD} | | | |
| A10 | NC | B10 | V _{SS} | C10 | /CAS/DQM0 | D10 | V _{SS} | | | |
| A11 | NC | B11 | /HACK | C11 | v_{DD} | D11 | REQ | | | |
| A12 | NC | B12 | CLKOUT | C12 | V _{SS} | D12 | V _{SS} | | | |
| A13 | NC | B13 | LF | C13 | v_{DD} | D13 | V _{DDPLL} | | | |
| A14 | NC | B14 | CLKIN | C14 | V _{SSPLL} | D14 | V _{SS} | | | |
| A15 | NC | B15 | V_{DD} | C15 | /HREQ | D15 | /RESET | | | |
| A16 | NC | B16 | /XPT3 | C16 | /XPT2 | D16 | /XPT1 | | | |
| A17 | NC | B17 | V _{SS} | C17 | /XPT0 | D17 | /LINT4 | | | |
| A18 | NC | B18 | V_{DD} | C18 | /EINT3 | D18 | /EINT2 | | | |
| A19 | NC | B19 | /EINT1 | C19 | TCK | D19 | TMS | | | |
| A20 | NC | B20 | /TRST | C20 | TDI | D20 | V _{SS} | | | |
| A21 | NC | B21 | EMU1 | C21 | EMU0 | D21 | V _{DD} | | | |
| A22 | NC | B22 | V _{DD} | C22 | TDO | D22 | V _{SS} | | | |
| A23 | NC | B23 | AD31 | C23 | AD30 | D23 | NC | | | |
| A24 | NC | B24 | AD29 | C24 | NC | D24 | AD28 | | | |
| A25 | NC | B25 | NC | C25 | V _{DD} | D25 | V _{SS} | | | |
| A26 | NC | B26 | NC | C26 | NC | D26 | NC | | | |
| | | | | | | | | | | |

TMS320C82 DIGITAL SIGNAL PROCESSOR

SPRS048 — APRIL 1998

pin assignments – numerical listing (continued)

| DIN NO | FUNCTION | 1 | - FUNCTION | | FUNCTION | DIN NO | FUNCTION |
|---------|-----------------|---------|-----------------|---------|-----------------|---------|-----------------|
| PIN NO. | FUNCTION |
| E1 | NC | J23 | V _{DD} | P1 | NC | V23 | V _{SS} |
| E2 | V _{SS} | J24 | AD20 | P2 | V _{DD} | V24 | AD7 |
| E3 | /W | J25 | AD19 | P3 | RCA5 | V25 | V _{SS} |
| E4 | V _{SS} | J26 | NC | P4 | v_{DD} | V26 | NC |
| E23 | AD27 | K1 | NC | P23 | AD13 | W1 | NC |
| E24 | V _{SS} | K2 | v_{DD} | P24 | v_{DD} | W2 | RCA11 |
| E25 | AD26 | K3 | RCA1 | P25 | AD14 | W3 | V _{SS} |
| E26 | NC | K4 | V _{SS} | P26 | NC | W4 | V _{SS} |
| F1 | NC | K23 | V _{SS} | R1 | NC | W23 | V_{DD} |
| F2 | /RL | K24 | V_{SS} | R2 | RCA6 | W24 | AD6 |
| F3 | V_{DD} | K25 | AD18 | R3 | v_{SS} | W25 | V_{SS} |
| F4 | DSF | K26 | NC | R4 | RCA7 | W26 | NC |
| F23 | V_{DD} | L1 | NC | R23 | V _{SS} | Y1 | NC |
| F24 | AD25 | L2 | V_{DD} | R24 | AD11 | Y2 | RCA12 |
| F25 | V_{DD} | L3 | RCA2 | R25 | AD12 | Y3 | v_{DD} |
| F26 | NC | L4 | V_{DD} | R26 | NC | Y4 | RCA13 |
| G1 | NC | L23 | V _{SS} | T1 | NC | Y23 | V_{DD} |
| G2 | /EXCEPT0 | L24 | AD17 | T2 | V _{SS} | Y24 | AD5 |
| G3 | /RAS | L25 | V _{DD} | Т3 | V _{SS} | Y25 | V _{DD} |
| G4 | V _{DD} | L26 | NC | T4 | RCA8 | Y26 | NC |
| G23 | AD24 | M1 | NC | T23 | AD9 | AA1 | NC |
| G24 | AD23 | M2 | V _{SS} | T24 | AD10 | AA2 | V _{DD} |
| G25 | V _{SS} | M3 | RCA3 | T25 | V _{SS} | AA3 | V _{DD} |
| G26 | NC | M4 | v_{DD} | T26 | NC | AA4 | V_{DD} |
| H1 | NC | M23 | v_{DD} | U1 | NC | AA23 | v _{ss} |
| H2 | READY | M24 | AD16 | U2 | v_{DD} | AA24 | AD3 |
| НЗ | V_{DD} | M25 | V_{DD} | U3 | RCA9 | AA25 | AD4 |
| H4 | /EXCEPT1 | M26 | NC | U4 | v _{DD} | AA26 | NC |
| H23 | AD22 | N1 | NC | U23 | AD8 | AB1 | NC |
| H24 | AD21 | N2 | V _{SS} | U24 | V_{DD} | AB2 | RCA14 |
| H25 | V_{DD} | N3 | RCA4 | U25 | v_{DD} | AB3 | V _{SS} |
| H26 | NC | N4 | V _{SS} | U26 | NC | AB4 | RCA15 |
| J1 | NC | N23 | V _{SS} | V1 | NC | AB23 | V_{DD} |
| J2 | RCA0 | N24 | V _{SS} | V2 | V_{DD} | AB24 | AD2 |
| J3 | V _{SS} | N25 | AD15 | V3 | RCA10 | AB25 | V _{SS} |
| J4 | V _{SS} | N26 | NC | V4 | V _{SS} | AB26 | NC |
| | | | | | | | |

pin assignments – numerical listing (continued)

| PIN NO. FUNCTION PIN NO. FUNCTION PIN NO. FUNCTION PIN NO. FUNCTION AC1 NC AD1 NC AE1 NC AF1 NC AC2 V _{SS} AD2 RCA16 AE2 NC AF2 NC AC3 V _{SS} AD3 NC AE3 AD32 AF3 NC AC4 NC AD4 V _{DD} AE4 AD33 AF4 NC AC5 AD34 AD5 V _{SS} AE5 AD35 AF5 NC AC6 AD36 AD6 V _{DD} AE6 AD37 AF6 NC AC7 AD38 AD7 V _{SS} AE7 AD39 AF7 NC AC8 V _{DD} AD8 AD40 AE8 V _{DD} AF8 NC AC9 V _{DD} AD9 AD41 AE9 V _{SS} AF10 NC AC11 AD43 AD11 AD44 AE11 | | | | | , | | | |
|---|---------|-----------------|---------|-----------------|---------|-----------------|---------|----------|
| AC2 V _{SS} AD2 RCA16 AE2 NC AF2 NC AC3 V _{SS} AD3 NC AE3 AD32 AF3 NC AC4 NC AD4 V _{DD} AE4 AD33 AF4 NC AC5 AD34 AD5 V _{SS} AE5 AD35 AF5 NC AC6 AD36 AD6 V _{DD} AE6 AD37 AF6 NC AC7 AD38 AD7 V _{SS} AE7 AD39 AF7 NC AC8 V _{DD} AD8 AD40 AE8 V _{DD} AF8 NC AC9 V _{DD} AD9 AD41 AE9 V _{SS} AF9 NC AC10 AD42 AD10 V _{SS} AE10 V _{SS} AF10 NC AC11 AD43 AD11 AD44 AE11 V _{DD} AF11 NC AC12 AD45 AD12 AD46 AE12 V _{SS} </th <th>PIN NO.</th> <th>FUNCTION</th> <th>PIN NO.</th> <th>FUNCTION</th> <th>PIN NO.</th> <th>FUNCTION</th> <th>PIN NO.</th> <th>FUNCTION</th> | PIN NO. | FUNCTION | PIN NO. | FUNCTION | PIN NO. | FUNCTION | PIN NO. | FUNCTION |
| AC3 VSS AD3 NC AE3 AD32 AF3 NC AC4 NC AD4 VDD AE4 AD33 AF4 NC AC5 AD34 AD5 VSS AE5 AD35 AF6 NC AC6 AD36 AD6 VDD AE6 AD37 AF6 NC AC7 AD38 AD7 VSS AE7 AD39 AF7 NC AC8 VDD AB8 AD40 AE8 VDD AF8 NC AC9 VDD AD9 AD41 AE9 VSS AF9 NC AC10 AD42 AD10 VSS AE10 VSS AF10 NC AC11 AD43 AD11 AD44 AE11 VDD AF11 NC AC12 AD45 AD12 AD46 AE12 VSS AF13 NC AC13 AD47 AD13 AD48 AE13 VSS AF13 NC AC14 AD49 AD14 VDD AE14 VDD AF14 NC AC15 VSS AD15 AD50 AE15 VDD AF15 NC AC16 AD52 AD16 VSS AE16 AD51 AF16 NC AC17 AD54 AD17 AD53 AE17 VDD AF17 NC AC18 AD56 AD18 AD55 AE18 VSS AF18 NC AC20 AD59 AD20 VSS AE10 VSS AF18 NC AC21 VDD AF17 NC AC22 VSS AF18 NC AC23 NC AD23 VSS AE23 AD62 AF23 NC AC24 VDD AD24 NC AE24 AD63 AF24 NC AC25 AD1 AD25 AD0 AE25 NC AF25 NC | AC1 | NC | AD1 | NC | AE1 | NC | AF1 | NC |
| AC3 VSS AD3 NC AE3 AD32 AF3 NC AC4 NC AD4 VDD AE4 AD33 AF4 NC AC5 AD34 AD5 VSS AE5 AD35 AF5 NC AC6 AD36 AD6 VDD AE6 AD37 AF6 NC AC7 AD38 AD7 VSS AE7 AD39 AF7 NC AC8 VDD AD8 AD40 AE8 VDD AF8 NC AC9 VDD AD9 AD41 AE9 VSS AF9 NC AC10 AD42 AD10 VSS AE10 VSS AF10 NC AC11 AD43 AD11 AD44 AE11 VDD AF11 NC AC12 AD45 AD12 AD46 AE12 VSS AF13 NC AC13 AD47 AD13 AD48 AE13 VSS AF13 <td>AC2</td> <td>V_{SS}</td> <td>AD2</td> <td>RCA16</td> <td>AE2</td> <td>NC</td> <td>AF2</td> <td>NC</td> | AC2 | V _{SS} | AD2 | RCA16 | AE2 | NC | AF2 | NC |
| AC4 NC AD4 VDD AE4 AD33 AF4 NC AC5 AD34 AD5 VSS AE5 AD35 AF5 NC AC6 AD36 AD6 VDD AE6 AD37 AF6 NC AC7 AD38 AD7 VSS AE7 AD39 AF7 NC AC8 VDD AD8 AD40 AE8 VDD AF8 NC AC9 VDD AD9 AD41 AE9 VSS AF9 NC AC10 AD42 AD10 VSS AE10 VSS AF10 NC AC11 AD43 AD11 AD44 AE11 VDD AF11 NC AC12 AD45 AD12 AD46 AE12 VSS AF12 NC AC13 AD47 AD13 AD48 AE13 VSS AF13 NC AC14 AD49 AD14 VDD AE14 VDD AF | AC3 | | AD3 | NC | AE3 | AD32 | AF3 | NC |
| AC5 AD34 AD5 V _{SS} AE5 AD35 AF5 NC AC6 AD36 AD6 V _{DD} AE6 AD37 AF6 NC AC7 AD38 AD7 V _{SS} AE7 AD39 AF7 NC AC8 V _{DD} AD8 AD40 AE8 V _{DD} AF8 NC AC9 V _{DD} AD9 AD41 AE9 V _{SS} AF9 NC AC10 AD42 AD10 V _{SS} AE10 V _{SS} AF10 NC AC11 AD43 AD11 AD44 AE11 V _{DD} AF11 NC AC12 AD45 AD12 AD46 AE12 V _{SS} AF12 NC AC13 AD47 AD13 AD48 AE13 V _{SS} AF13 NC AC14 AD49 AD14 V _{DD} AE14 V _{DD} AF14 NC AC15 V _{SS} AD15 AD50 AE15 | AC4 | | AD4 | V_{DD} | AE4 | AD33 | AF4 | NC |
| AC6 AD36 AD6 VDD AE6 AD37 AF6 NC AC7 AD38 AD7 VSS AE7 AD39 AF7 NC AC8 VDD AD8 AD40 AE8 VDD AF8 NC AC9 VDD AD9 AD41 AE9 VSS AF9 NC AC10 AD42 AD10 VSS AE10 VSS AF10 NC AC11 AD43 AD11 AD44 AE11 VDD AF11 NC AC12 AD45 AD12 AD46 AE12 VSS AF12 NC AC13 AD47 AD13 AD48 AE13 VSS AF13 NC AC14 AD49 AD14 VDD AE14 VDD AF14 NC AC15 VSS AD15 AD50 AE15 VDD AF15 NC AC16 AD52 AD16 VSS AE16 AD51 | AC5 | AD34 | AD5 | | AE5 | AD35 | AF5 | NC |
| AC8 VDD AD8 AD40 AE8 VDD AF8 NC AC9 VDD AD9 AD41 AE9 VSS AF9 NC AC10 AD42 AD10 VSS AE10 VSS AF10 NC AC11 AD42 AD10 VSS AE11 VDD AF11 NC AC11 AD43 AD11 AD44 AE11 VDD AF11 NC AC12 AD45 AD12 AD46 AE12 VSS AF12 NC AC13 AD47 AD13 AD48 AE13 VSS AF13 NC AC14 AD49 AD14 VDD AE14 VDD AF14 NC AC15 VSS AD15 AD50 AE15 VDD AF15 NC AC16 AD52 AD16 VSS AE16 AD51 AF16 NC AC17 AD54 AD17 AD53 AE17 VDD <td>AC6</td> <td>AD36</td> <td>AD6</td> <td></td> <td>AE6</td> <td>AD37</td> <td>AF6</td> <td>NC</td> | AC6 | AD36 | AD6 | | AE6 | AD37 | AF6 | NC |
| AC8 VDD AD8 AD40 AE8 VDD AF8 NC AC9 VDD AD9 AD41 AE9 VSS AF9 NC AC10 AD42 AD10 VSS AE10 VSS AF10 NC AC11 AD42 AD10 VSS AE10 VSS AF10 NC AC11 AD43 AD11 AD44 AE11 VDD AF11 NC AC12 AD45 AD12 AD46 AE12 VSS AF12 NC AC13 AD47 AD13 AD48 AE13 VSS AF13 NC AC14 AD49 AD14 VDD AE14 VDD AF14 NC AC15 VSS AD15 AD50 AE15 VDD AF15 NC AC16 AD52 AD16 VSS AE16 AD51 AF16 NC AC17 AD54 AD17 AD53 AE17 VDD <td>AC7</td> <td>AD38</td> <td>AD7</td> <td>V_{SS}</td> <td>AE7</td> <td>AD39</td> <td>AF7</td> <td>NC</td> | AC7 | AD38 | AD7 | V _{SS} | AE7 | AD39 | AF7 | NC |
| AC9 V _{DD} AD9 AD41 AE9 V _{SS} AF9 NC AC10 AD42 AD10 V _{SS} AE10 V _{SS} AF10 NC AC11 AD43 AD11 AD44 AE11 V _{DD} AF11 NC AC12 AD45 AD12 AD46 AE12 V _{SS} AF12 NC AC13 AD47 AD13 AD48 AE13 V _{SS} AF13 NC AC14 AD49 AD14 V _{DD} AE14 V _{DD} AF14 NC AC14 AD49 AD14 V _{DD} AE14 V _{DD} AF15 NC AC15 V _{SS} AD15 AD50 AE15 V _{DD} AF15 NC AC16 AD52 AD16 V _{SS} AE16 AD51 AF16 NC AC17 AD54 AD17 AD53 AE17 V _{DD} AF17 NC AC18 AD56 AD18 AD55 | AC8 | V_{DD} | AD8 | | AE8 | V _{DD} | AF8 | NC |
| AC10 AD42 AD10 VSS AE10 VSS AF10 NC AC11 AD43 AD11 AD44 AE11 VDD AF11 NC AC12 AD45 AD12 AD46 AE12 VSS AF12 NC AC13 AD47 AD13 AD48 AE13 VSS AF13 NC AC14 AD49 AD14 VDD AE14 VDD AF14 NC AC15 VSS AD15 AD50 AE15 VDD AF15 NC AC16 AD52 AD16 VSS AE16 AD51 AF16 NC AC17 AD54 AD17 AD53 AE17 VDD AF17 NC AC18 AD56 AD18 AD55 AE18 VSS AF18 NC AC19 AD57 AD19 VDD AE19 VDD AF19 NC AC20 AD59 AD20 VSS AE20 <t< td=""><td>AC9</td><td></td><td>AD9</td><td>AD41</td><td>AE9</td><td></td><td>AF9</td><td>NC</td></t<> | AC9 | | AD9 | AD41 | AE9 | | AF9 | NC |
| AC12 AD45 AD12 AD46 AE12 V _{SS} AF12 NC AC13 AD47 AD13 AD48 AE13 V _{SS} AF13 NC AC14 AD49 AD14 V _{DD} AE14 V _{DD} AF14 NC AC15 V _{SS} AD15 AD50 AE15 V _{DD} AF15 NC AC16 AD52 AD16 V _{SS} AE16 AD51 AF16 NC AC17 AD54 AD17 AD53 AE17 V _{DD} AF18 NC AC18 AD56 AD18 AD55 AE18 V _{SS} AF18 NC AC19 AD57 AD19 V _{DD} AE19 V _{DD} AF19 NC AC20 AD59 AD20 V _{SS} AE20 AD58 AF20 NC AC21 V _{DD} AD21 AD60 AE21 V _{DD} AF21 NC AC22 V _{SS} AD22 V _{SS} AE22 AD61 AF22 NC AC23 NC AD24 NC AE24 AD63 AF24 NC AC25 AD1 AD25 AD0 AE25 NC AF25 NC | AC10 | | AD10 | V _{SS} | AE10 | | AF10 | NC |
| AC13 AD47 AD13 AD48 AE13 V _{SS} AF13 NC AC14 AD49 AD14 V _{DD} AE14 V _{DD} AF14 NC AC15 V _{SS} AD15 AD50 AE15 V _{DD} AF15 NC AC16 AD52 AD16 V _{SS} AE16 AD51 AF16 NC AC17 AD54 AD17 AD53 AE17 V _{DD} AF17 NC AC18 AD56 AD18 AD55 AE18 V _{SS} AF18 NC AC19 AD57 AD19 V _{DD} AE19 V _{DD} AF19 NC AC20 AD59 AD20 V _{SS} AE20 AD58 AF20 NC AC21 V _{DD} AD21 AD60 AE21 V _{DD} AF21 NC AC22 V _{SS} AD22 V _{SS} AE22 AD61 AF22 NC AC23 NC AD24 NC AE24 AD63 AF24 NC AC25 AD1 AD25 AD0 AE25 NC AF25 NC | AC11 | AD43 | AD11 | AD44 | AE11 | | AF11 | NC |
| AC13 AD47 AD13 AD48 AE13 V _{SS} AF13 NC AC14 AD49 AD14 V _{DD} AE14 V _{DD} AF14 NC AC15 V _{SS} AD15 AD50 AE15 V _{DD} AF15 NC AC16 AD52 AD16 V _{SS} AE16 AD51 AF16 NC AC17 AD54 AD17 AD53 AE17 V _{DD} AF16 NC AC18 AD56 AD18 AD55 AE18 V _{SS} AF18 NC AC19 AD57 AD19 V _{DD} AE19 V _{DD} AF19 NC AC20 AD59 AD20 V _{SS} AE20 AD58 AF20 NC AC21 V _{DD} AD21 AD60 AE21 V _{DD} AF21 NC AC22 V _{SS} AD22 V _{SS} AE22 AD61 AF22 NC AC23 NC AD23 V _{SS} | AC12 | AD45 | AD12 | AD46 | AE12 | V _{SS} | AF12 | NC |
| AC14 AD49 AD14 VDD AE14 VDD AF14 NC AC15 VSS AD15 AD50 AE15 VDD AF15 NC AC16 AD52 AD16 VSS AE16 AD51 AF16 NC AC17 AD54 AD17 AD53 AE17 VDD AF17 NC AC18 AD56 AD18 AD55 AE18 VSS AF18 NC AC19 AD57 AD19 VDD AE19 VDD AF19 NC AC20 AD59 AD20 VSS AE20 AD58 AF20 NC AC21 VDD AD21 AD60 AE21 VDD AF21 NC AC22 VSS AD22 VSS AE22 AD61 AF22 NC AC23 NC AD23 VSS AE23 AD62 AF23 NC AC24 VDD AD24 NC AE24 AD6 | AC13 | AD47 | AD13 | AD48 | AE13 | | AF13 | NC |
| AC16 AD52 AD16 V _{SS} AE16 AD51 AF16 NC AC17 AD54 AD17 AD53 AE17 V _{DD} AF17 NC AC18 AD56 AD18 AD55 AE18 V _{SS} AF18 NC AC19 AD57 AD19 V _{DD} AE19 V _{DD} AF19 NC AC20 AD59 AD20 V _{SS} AE20 AD58 AF20 NC AC21 V _{DD} AD21 AD60 AE21 V _{DD} AF21 NC AC22 V _{SS} AD22 V _{SS} AE22 AD61 AF22 NC AC23 NC AD23 V _{SS} AE23 AD62 AF23 NC AC24 V _{DD} AD24 NC AE24 AD63 AF24 NC AC25 AD1 AD25 AD0 AE25 NC AF25 NC | AC14 | AD49 | AD14 | V_{DD} | AE14 | | AF14 | NC |
| AC17 AD54 AD17 AD53 AE17 V _{DD} AF17 NC AC18 AD56 AD18 AD55 AE18 V _{SS} AF18 NC AC19 AD57 AD19 V _{DD} AE19 V _{DD} AF19 NC AC20 AD59 AD20 V _{SS} AE20 AD58 AF20 NC AC21 V _{DD} AD21 AD60 AE21 V _{DD} AF21 NC AC22 V _{SS} AD22 V _{SS} AE22 AD61 AF22 NC AC23 NC AD23 V _{SS} AE23 AD62 AF23 NC AC24 V _{DD} AD24 NC AE24 AD63 AF24 NC AC25 AD1 AD25 AD0 AE25 NC AF25 NC | AC15 | V _{SS} | AD15 | AD50 | AE15 | V_{DD} | AF15 | NC |
| AC17 AD54 AD17 AD53 AE17 VDD AF17 NC AC18 AD56 AD18 AD55 AE18 VSS AF18 NC AC19 AD57 AD19 VDD AE19 VDD AF19 NC AC20 AD59 AD20 VSS AE20 AD58 AF20 NC AC21 VDD AD21 AD60 AE21 VDD AF21 NC AC22 VSS AD22 VSS AE22 AD61 AF22 NC AC23 NC AD23 VSS AE23 AD62 AF23 NC AC24 VDD AD24 NC AE24 AD63 AF24 NC AC25 AD1 AD25 AD0 AE25 NC AF25 NC | AC16 | AD52 | AD16 | V _{SS} | AE16 | AD51 | AF16 | NC |
| AC19 AD57 AD19 V _{DD} AE19 V _{DD} AF19 NC AC20 AD59 AD20 V _{SS} AE20 AD58 AF20 NC AC21 V _{DD} AD21 AD60 AE21 V _{DD} AF21 NC AC22 V _{SS} AD22 V _{SS} AE22 AD61 AF22 NC AC23 NC AD23 V _{SS} AE23 AD62 AF23 NC AC24 V _{DD} AD24 NC AE24 AD63 AF24 NC AC25 AD1 AD25 AD0 AE25 NC AF25 NC | AC17 | AD54 | AD17 | | AE17 | V_{DD} | AF17 | NC |
| AC19 AD57 AD19 VDD AE19 VDD AF19 NC AC20 AD59 AD20 VSS AE20 AD58 AF20 NC AC21 VDD AD21 AD60 AE21 VDD AF21 NC AC22 VSS AD22 VSS AE22 AD61 AF22 NC AC23 NC AD23 VSS AE23 AD62 AF23 NC AC24 VDD AD24 NC AE24 AD63 AF24 NC AC25 AD1 AD25 AD0 AE25 NC AF25 NC | AC18 | AD56 | AD18 | AD55 | AE18 | V _{SS} | AF18 | NC |
| AC21 V _{DD} AD21 AD60 AE21 V _{DD} AF21 NC AC22 V _{SS} AD22 V _{SS} AE22 AD61 AF22 NC AC23 NC AD23 V _{SS} AE23 AD62 AF23 NC AC24 V _{DD} AD24 NC AE24 AD63 AF24 NC AC25 AD1 AD25 AD0 AE25 NC AF25 NC | AC19 | AD57 | AD19 | V_{DD} | AE19 | | AF19 | NC |
| AC21 VDD AD21 AD60 AE21 VDD AF21 NC AC22 VSS AD22 VSS AE22 AD61 AF22 NC AC23 NC AD23 VSS AE23 AD62 AF23 NC AC24 VDD AD24 NC AE24 AD63 AF24 NC AC25 AD1 AD25 AD0 AE25 NC AF25 NC | AC20 | AD59 | AD20 | V _{SS} | AE20 | AD58 | AF20 | NC |
| AC22 V _{SS} AD22 V _{SS} AE22 AD61 AF22 NC AC23 NC AD23 V _{SS} AE23 AD62 AF23 NC AC24 V _{DD} AD24 NC AE24 AD63 AF24 NC AC25 AD1 AD25 AD0 AE25 NC AF25 NC | AC21 | V _{DD} | AD21 | | AE21 | V _{DD} | AF21 | NC |
| AC23 NC AD23 V _{SS} AE23 AD62 AF23 NC AC24 V _{DD} AD24 NC AE24 AD63 AF24 NC AC25 AD1 AD25 AD0 AE25 NC AF25 NC | AC22 | | AD22 | V _{SS} | AE22 | | AF22 | NC |
| AC24 V _{DD} AD24 NC AE24 AD63 AF24 NC AC25 AD1 AD25 AD0 AE25 NC AF25 NC | AC23 | | AD23 | | AE23 | AD62 | AF23 | NC |
| AC25 AD1 AD25 AD0 AE25 NC AF25 NC | AC24 | V _{DD} | AD24 | | AE24 | AD63 | AF24 | NC |
| AC26 NC AD26 NC AE26 NC AF26 NC | AC25 | | AD25 | AD0 | AE25 | NC | AF25 | NC |
| | AC26 | NC | AD26 | NC | AE26 | NC | AF26 | NC |

pin assignments - alphabetical listing

| FUNCTION | PIN NO. | FUNCTION | PIN NO. | FUNCTION | PIN NO. | | |
|----------|---------|-----------|---------|----------|---------|--|--|
| AD0 | AD25 | AD40 | AD8 | EMU0 | C21 | | |
| AD1 | AC25 | AD41 | AD9 | EMU1 | B21 | | |
| AD2 | AB24 | AD42 | AC10 | /EXCEPT0 | G2 | | |
| AD3 | AA24 | AD43 | AC11 | /EXCEPT1 | H4 | | |
| AD4 | AA25 | AD44 | AD11 | /HACK | B11 | | |
| AD5 | Y24 | AD45 | AC12 | /HREQ | C15 | | |
| AD6 | W24 | AD46 | AD12 | /LINT4 | D17 | | |
| AD7 | V24 | AD47 | AC13 | LF | B13 | | |
| AD8 | U23 | AD48 | AD13 | /RAS | G3 | | |
| AD9 | T23 | AD49 | AC14 | RCA0 | J2 | | |
| AD10 | T24 | AD50 | AD15 | RCA1 | K3 | | |
| AD11 | R24 | AD51 | AE16 | RCA2 | L3 | | |
| AD12 | R25 | AD52 | AC16 | RCA3 | M3 | | |
| AD13 | P23 | AD53 | AD17 | RCA4 | N3 | | |
| AD14 | P25 | AD54 | AC17 | RCA5 | P3 | | |
| AD15 | N25 | AD55 | AD18 | RCA6 | R2 | | |
| AD16 | M24 | AD56 | AC18 | RCA7 | R4 | | |
| AD17 | L24 | AD57 | AC19 | RCA8 | T4 | | |
| AD18 | K25 | AD58 | AE20 | RCA9 | U3 | | |
| AD19 | J25 | AD59 | AC20 | RCA10 | V3 | | |
| AD20 | J24 | AD60 | AD21 | RCA11 | W2 | | |
| AD21 | H24 | AD61 | AE22 | RCA12 | Y2 | | |
| AD22 | H23 | AD62 | AE23 | RCA13 | Y4 | | |
| AD23 | G24 | AD63 | AE24 | RCA14 | AB2 | | |
| AD24 | G23 | /CAS/DQM0 | C10 | RCA15 | AB4 | | |
| AD25 | F24 | /CAS/DQM1 | В9 | RCA16 | AD2 | | |
| AD26 | E25 | /CAS/DQM2 | C9 | READY | H2 | | |
| AD27 | E23 | /CAS/DQM3 | C8 | REQ | D11 | | |
| AD28 | D24 | /CAS/DQM4 | D8 | /RESET | D15 | | |
| AD29 | B24 | /CAS/DQM5 | C7 | /RL | F2 | | |
| AD30 | C23 | /CAS/DQM6 | В6 | STATUS0 | B5 | | |
| AD31 | B23 | /CAS/DQM7 | D6 | STATUS1 | D5 | | |
| AD32 | AE3 | CLKIN | B14 | TCK | C19 | | |
| AD33 | AE4 | CLKOUT | B12 | TDI | C20 | | |
| AD34 | AC5 | /DBEN | В3 | TDO | C22 | | |
| AD35 | AE5 | /DDIN | C2 | TMS | D19 | | |
| AD36 | AC6 | DSF | F4 | /TRG/CAS | D2 | | |
| AD37 | AE6 | /EINT1 | B19 | /TRST | B20 | | |
| AD38 | AC7 | /EINT2 | D18 | | | | |
| AD39 | AE7 | /EINT3 | C18 | | | | |



pin assignments – alphabetical listing (continued)

| FUNCTION | PIN NO. | FUNCTION | PIN NO. | FUNCTION | PIN NO. | FUNCTION | PIN NO. |
|-----------------|---------|--------------------|---------|-----------------|---------|--------------------|---------|
| V _{DD} | B4 | V _{DD} | U24 | V _{SS} | C12 | V _{SS} | V25 |
| V _{DD} | B8 | V _{DD} | U25 | Vss | D3 | V _{SS} | W3 |
| V _{DD} | B15 | V _{DD} | V2 | Vss | D7 | V _{SS} | W4 |
| V _{DD} | B18 | V _{DD} | W23 | Vss | D10 | V _{SS} | W25 |
| V _{DD} | B22 | V _{DD} | Y3 | V _{SS} | D12 | V _{SS} | AA23 |
| V _{DD} | C4 | V _{DD} | Y23 | V _{SS} | D14 | V _{SS} | AB3 |
| V _{DD} | C6 | V _{DD} | Y25 | V _{SS} | D20 | V _{SS} | AB25 |
| V _{DD} | C11 | V _{DD} | AA2 | Vss | D22 | V _{SS} | AC2 |
| V_{DD} | C13 | V_{DD} | AA3 | V _{SS} | D25 | V _{SS} | AC3 |
| V _{DD} | C25 | V_{DD} | AA4 | V _{SS} | E2 | V _{SS} | AC15 |
| V _{DD} | D9 | V _{DD} | AB23 | V _{SS} | E4 | V _{SS} | AC22 |
| V _{DD} | D21 | V _{DD} | AC8 | V _{SS} | E24 | V _{SS} | AD5 |
| V _{DD} | F3 | V _{DD} | AC9 | V _{SS} | G25 | V _{SS} | AD7 |
| V _{DD} | F23 | V _{DD} | AC21 | Vss | J3 | V _{SS} | AD10 |
| V _{DD} | F25 | V _{DD} | AC24 | V _{SS} | J4 | V _{SS} | AD16 |
| V _{DD} | G4 | V _{DD} | AD4 | V _{SS} | K4 | V _{SS} | AD20 |
| V _{DD} | НЗ | V _{DD} | AD6 | V _{SS} | K23 | V_{SS} | AD22 |
| V _{DD} | H25 | V _{DD} | AD14 | V _{SS} | K24 | V _{SS} | AD23 |
| V_{DD} | J23 | V _{DD} | AD19 | V _{SS} | L23 | v _{ss} | AE9 |
| V_{DD} | K2 | V _{DD} | AE8 | V _{SS} | M2 | V _{SS} | AE10 |
| V_{DD} | L2 | V _{DD} | AE11 | V _{SS} | N2 | v _{ss} | AE12 |
| V_{DD} | L4 | V _{DD} | AE14 | V _{SS} | N4 | V _{SS} | AE13 |
| V_{DD} | L25 | V _{DD} | AE15 | V _{SS} | N23 | V _{SS} | AE18 |
| V_{DD} | M4 | V _{DD} | AE17 | V _{SS} | N24 | V _{SSPLL} | C14 |
| V_{DD} | M23 | V_{DD} | AE19 | V _{SS} | R3 | /W | E3 |
| V_{DD} | M25 | V_{DD} | AE21 | V _{SS} | R23 | /XPT0 | C17 |
| V_{DD} | P2 | V _{DDPLL} | D13 | V _{SS} | T2 | /XPT1 | D16 |
| V _{DD} | P4 | V _{SS} | В7 | V _{SS} | Т3 | /XPT2 | C16 |
| V _{DD} | P24 | V _{SS} | B10 | V _{SS} | T25 | /XPT3 | B16 |
| V _{DD} | U2 | V _{SS} | B17 | V _{SS} | V4 | | |
| V _{DD} | U4 | V _{SS} | C5 | V _{SS} | V23 | | |

TMS320C82 DIGITAL SIGNAL PROCESSOR

SPRS048 — APRIL 1998

signal descriptions

| NAME | I/O | DESCRIPTION | | | | |
|---|---|---|--|--|--|--|
| | ı | LOCAL MEMORY INTERFACE | | | | |
| AD63-AD40 | I/O | Data. The upper 24 bits of data are read in/driven out over this bus. | | | | |
| AD39-AD32 | I/O | Data/Status. This bus drives out the access code at row time. During column time, bits 39-32 of data are read in/driven out over this bus. | | | | |
| AD31-AD0 | I/O | Address/Data. Outputs the 32-bit address at row time. During column time, the lower 32 bits of data are read in/driven out on this bus. | | | | |
| RCA16-RCA0 | 0 | Address. Outputs the multiplexed row/column addresses. | | | | |
| /DBEN | 0 | Data buffer enable. This signal drives the active-low output enables on bidirectional transceivers which may be used to buffer input and output data on AD63-AD0. | | | | |
| /DDIN | Data direction indicator. Indicates the direction that data needs to pass through the transceivers. A low on this signal indicates a transfer from external memory into the 'C82. | | | | | |
| /EXCEPT1-/EXCEPT0 | I | Memory exception. Two-bit encodings on these inputs request retries, faults, or configuration cache flushes. Additionally, these inputs are used to indicate the cycle type for refreshes. | | | | |
| READY | I | Ready. Indicates that the external device is ready to complete the memory cycle. This signal is driven inactive low by external circuitry to insert wait states into a memory cycle. READY is also used at reset to determine the endianness of the 'C82. If READY is low at the rising edge of /RESET, the 'C82 will operate in big-endian mode. If READY is high, the 'C82 will operate in little-endian mode. | | | | |
| /RL | 0 | Row latch. The high-to-low transition of /RL can be used to latch the source information, status code, and 32-bit byte address present on AD39-AD0 at row time. | | | | |
| STATUS1-STATUS0 | 0 | Status. Two-bit encoded outputs which indicate row, column, XPT end and idle conditions on the bus. | | | | |
| | -1 | DRAM, VRAM, AND SDRAM CONTROL | | | | |
| /CAS/DQM7-/CAS/DQM0 | 0 | Column address strobes. These outputs drive the /CAS inputs of DRAMs and VRAMs or the DQM inputs of SDRAMs. The eight strobes provide byte write access to memory. | | | | |
| DSF | 0 | Special function. This signal is used to select special VRAM functions such as block write, load color register, and split register transfers, and SGRAM block writes. | | | | |
| /RAS | 0 | Row address strobe. The /RAS output drives the /RAS inputs of DRAMs, VRAMs, and SDRAMs. | | | | |
| /TRG/CAS O Transfer/output enable or column address strobe. /TRG/CAS is used as an output enable for DRAMs and VRAMs and as a transfer enable for VRAMs. /TRG/CAS also drives the /CAS input SDRAMs. | | | | | | |
| /W O Write enable. /W is driven active-low prior to /CAS during DRAM/VRAM write cycles. During VRAM transfer cycles, /W is used to control the direction of the transfer. For SDRAM writes, /W driven low concurrent with the DQM signals, and is also low during DCAB cycles. | | | | | | |

signal descriptions (continued)

| NAME | I/O | DESCRIPTION | | | | | |
|---|-----|---|--|--|--|--|--|
| | • | HOST INTERFACE | | | | | |
| /HACK | 0 | Host acknowledge. The 'C82 will drive this output low following an active /HREQ, to indicate that it has driven the local memory bus signals to high impedance and is relinquishing the bus. /HACK is driven high asynchronously following /HREQ being detected inactive, and the 'C82 will resume driving the bus. | | | | | |
| /HREQ | ı | Host request. An external device drives this input active-low to request ownership of the local memory bus. When /HREQ is inactive high, the 'C82 will own and drive the bus. /HREQ is internally synchronized to the 'C82's internal clock. /HREQ is used at reset to determine the power-up state of the MP. If /HREQ is low at the rising edge of /RESET, the MP will come up running. If /HREQ is high, the MP will remain halted until the first interrupt occurrence on /EINT3. | | | | | |
| REQ O Internal cycle request. This signal provides an indication that the 'C82 is receiving a high request (urgent refresh or XPT request). External logic can monitor this signal to determine necessary to relinquish the local memory bus to the 'C82. | | | | | | | |
| | | SYSTEM CONTROL | | | | | |
| CLKIN | I | Input clock. This clock is used to generate the internal 'C82 clocks to which all processor functions are synchronous. | | | | | |
| LF | I | Loop filter. An external filter is connected to this pin to provide filtering for the C82's on-chip PLL circuitry. | | | | | |
| CLKOUT | 0 | Local output clock. This clock provides a way to synchronize external circuitry to internal timings. This clock is internally phase-locked to CLKIN. | | | | | |
| /EINT1, /EINT2, /EINT3 | I | Edge-triggered interrupts. These signals allow external devices to interrupt the MP on one of three interrupt levels (/EINT1 being the highest priority). The interrupts are rising-edge triggered. /EINT3 also serves as an unhalt signal. If the MP is powered-up halted, the first rising edge on /EINT3 will cause the MP to unhalt and fetch its reset vector. (The /EINT3 interrupt pending bit will not be set in this case.) | | | | | |
| /LINT4 | I | Level-triggered interrupt. This input provides an active-low level-triggered interrupt to the MP. Its priority falls below that of the edge-triggered interrupts. Any interrupt request should remain active-low until it is recognized by the 'C82. The /LINT4 interrupt service routine is expected to clear the interrupt condition. | | | | | |
| /RESET | I | Reset. The /RESET input is driven low to reset the 'C82 (all processors). During reset, all internal registers are set to their initial state and all output pins are driven to high-impedance levels with the exception of CLKOUT, /HACK, and REQ, which continue to be driven. During the rising edge of /RESET, the MP reset mode and the 'C82's operating endian are determined by the levels of /HREQ and READY pins, respectively. | | | | | |
| /XPT3-/XPT0 | I | External Packet Transfer. These encoded inputs are used by external devices to request a high-priority external packet transfer (XPT) by the TC. Fifteen XPT codes are supported. Code 1111 indicates that no request is being submitted. The XPT inputs should remain valid until the TC begins servicing the request. | | | | | |
| | | EMULATION CONTROL | | | | | |
| EMU0, EMU1 [†] | I/O | Emulation pins. These two pins are used to support emulation host interrupts, special functions targeted at a single processor, and multiprocessor halt event communications. | | | | | |
| TCK † | I | Test clock. This input provides the clock for the 'C82's JTAG logic allowing it to be compatible with other JTAG devices, controllers, and test equipment designed for different clock rates. | | | | | |
| TDI [†] | I | Test data input. This pin provides input data for all JTAG instructions and data scans of the 'C82. | | | | | |
| TDO | 0 | Test data output. This pin provides output data for all JTAG instructions and data scans of the 'C82. | | | | | |
| TMS † | I | Test mode select. This signal controls the JTAG state machine. | | | | | |
| /TRST [‡] | I | Test reset. This input resets the 'C82's JTAG module. When active-low, all boundary scan logic is disabled, allowing normal 'C82 operation. | | | | | |

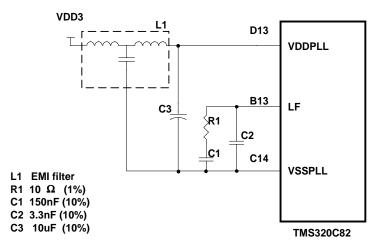


[†] This pin has an internal pullup and may be left unconnected during normal operation. ‡ This pin has an internal pulldown and may be left unconnected during normal operation.

signal descriptions (continued)

| NAME I/O DESCRIPTION | | | | | | | | | | | |
|--|-------|--|--|--|--|--|--|--|--|--|--|
| | POWER | | | | | | | | | | |
| V _{DD} § Power. Nominal 3.3-volt power supply inputs. | | | | | | | | | | | |
| V _{DDPLL} | | Power. Nominal 3.3-volt power supply input for the on-chip PLL. | | | | | | | | | |
| V _{SS} § | | Ground. Electrical ground inputs. | | | | | | | | | |
| VSSPLL | | Ground. Electrical ground input for the on-chip PLL (tied to V _{SS} internally). | | | | | | | | | |

 $[\]S$ For proper operation, all V_{DD} and V_{SS} pins must be connected externally.



NOTE: To ensure proper operation, the on-chip PLL should be powered with a stable supply. To minimize noise injection into the PLL, it is suggested that an external EMI filter be applied as shown. The RC filter network on the LF pin provides an external filter for the PLL.

Figure 2. PLL Support Circuitry

memory map

The 'C82 has a 4G-byte address space. The lower 32M bytes are used to address internal RAM and memory-mapped registers.

| | 0xFFFFFFF | | 0x01800FFF |
|---|--|---------------------------------|--|
| External Memory (4064 M bytes) | | Reserved (8128K bytes) | |
| (************************************** | 0x02000000 | MP Parameter RAM (4K bytes) | 0x01011000 0x01010FFF 0x01010000 |
| Reserved (8063K bytes) | 0x01FFFFFF 0x01820200 | Reserved (56K bytes) | 0x0100FFFF |
| Memory-Mapped TC Registers | 0x018201FF 0x01820000 0x0181FFFF | PP1 Parameter RAM (4K bytes) | 0x01002000 0x01001FFF 0x01001000 |
| Reserved (28K bytes) | 0x01819000 | PP0 Paramater RAM (4K bytes) | 0x01000FFF |
| MP Instruction Cache (4K bytes) | 0x01818FFF 0x01818000 | Reserved | 0x01000000 0x00FFFFF |
| Reserved (28K bytes) | 0x01817FFF 0x01811000 | (16M bytes) | 0x0000A000 |
| MP Data Cache (4K bytes) | 0x01810FFF 0x01810000 | PP1 Data RAM 1 (4K bytes) | 0x00009FFF 0x00009000 |
| Reserved (48K bytes) | 0x0180FFFF 0x01804000 | PP0 Data RAM 1 (4K bytes) | 0x00008FFF 0x00008000 |
| PP1 Instruction Cache (4K bytes) | 0x01803FFF | Reserved (24K bytes) | 0x00007FFF |
| Reserved (4K bytes) | 0x01802000 | PP1 Data RAM 0 (4K bytes) | 0x00001FFF |
| PP0 Instruction Cache (4K bytes) | 0x01801FFF 0x01801000 | PP0 Data RAM 0 (4K bytes) | 0x000000000000000000000000000000000000 |

Figure 3. TMS320C82 Memory Map

master processor architecture

The Master Processor (MP) is a 32-bit RISC processor with an integral IEEE-754 floating-point unit. The MP has been designed for executing C code and is capable of performing at over 130k dhrystones. Major tasks which the MP will typically perform are:

- Task control and user interface
- Information processing and analysis
- IEEE-754 floating point (including graphics transforms)

functional block diagram

Figure 4 shows a block diagram of the master processor. Key features of the MP include:

- 32-bit RISC processor
 - Load/store architecture
 - 3 operand arithmetic and logical instructions
- 4K-byte instruction cache and 4K-byte data cache
 - 4-way set associative
 - LRU replacement
 - Data writeback
- 4K-byte non-cached parameter RAM
- Thirty-one 32-bit general-purpose registers
- Register and accumulator scoreboard
- 15-bit or 32-bit immediate constants
- 32-bit byte-addressing
- Scalable timer

- Leftmost-one and rightmost-one logic
- IEEE-754 floating-point hardware
 - Four double-precision floating-point vector accumulators
 - Vector floating-point instructions
 - Floating-point operation and parallel load or store
 - Multiply and accumulate
- High performance
 - 60 MIPS
 - 120 MFLOPS
 - Over 130,000 Dhrystones

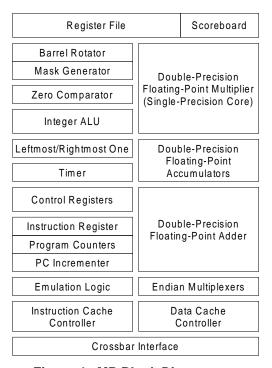


Figure 4. MP Block Diagram



general-purpose registers

The MP contains 31 32-bit general-purpose registers, R1 - R31. Register R0 always reads as zero and writes to it are discarded. Double-precision values are always stored in an even-odd register pair with the higher numbered register always holding the sign bit, and exponent. The R0/R1 pair is not available for this use. A scoreboard keeps track of which registers are awaiting loads or the result of a previous instruction and stalls the pipeline until the register contains valid data. As a recommended software convention, R1 is typically used as a stack pointer and R31 as a return address link register.

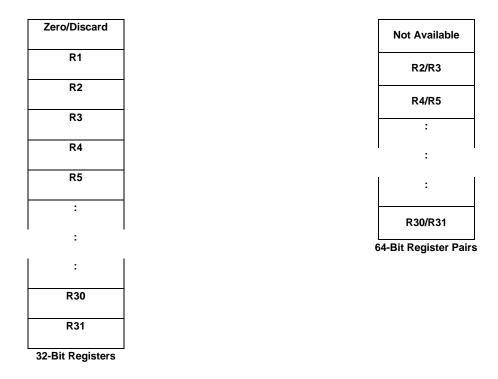


Figure 5. MP General-Purpose Registers

The 32-bit registers may contain signed-integer, unsigned-integer, or single-precision floating-point values. Signed and unsigned bytes and halfwords are sign-extended or zero-filled. Doublewords may be stored in a 64-bit even/odd register pair. Double-precision floating-point values are referenced using the even register number or the register pair. Figure 6 through Figure 8 show the register data formats.

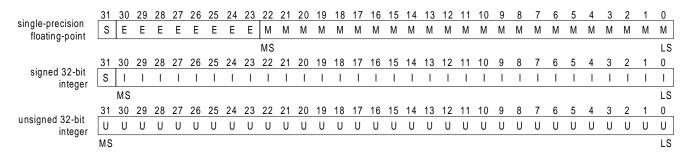


Figure 6. MP Register 32-Bit Data Formats

general-purpose registers (continued)

| 2.00 | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----------------------|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|---|---|----|---|---|----|---|---|---|----|
| signed byte | S | S | S | S | S | S | S | S | S | S | S | S | S | S | S | S | S | S | S | S | S | S | S | S | S | I | I | -1 | 1 | 1 | I | 1 |
| 5,10 | | | | | | | | | | | | | | | | | | | | | | | | | MS | | | | | | | LS |
| | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| unsigned byte | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | U | U | U | U | U | U | U | U |
| byto | | | | | | | | | | | | | | | | | | | | | | | | | MS | | | | | | | LS |
| | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| signed halfword | S | S | S | S | S | S | S | S | S | S | S | S | S | S | S | S | S | -1 | Ι | I | 1 | 1 | I | I | I | I | I | -1 | 1 | 1 | I | 1 |
| nammora | | | | | | | | | | | | | | | | | MS | | | | | | | | | | | | | | | LS |
| | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| unsigned halfword | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | U | U | U | U | U | U | U | U | U | U | U | U | U | U | U | U |
| | | | | | | | | | | | | | | | | | MS | | | | | | | | | | | | | | | LS |

Figure 7. MP Register 8-Bit and 16-Bit Data

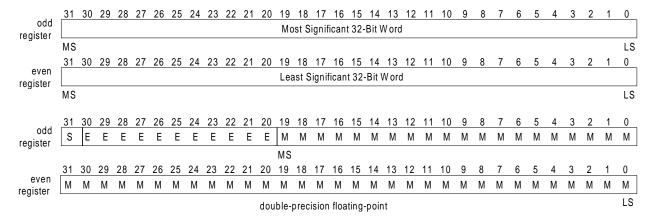


Figure 8. MP Register 64-Bit Data

double-precision floating-point accumulators

There are four double-precision floating-point registers to accumulate intermediate floating-point results.

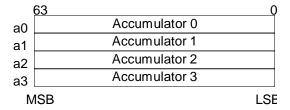


Figure 9. Floating-Point Accumulators

control registers

In addition to the general-purpose registers, there are a number of control registers that are used to represent the state of the processor. The control register numbers of the accessible registers are shown in Table 1.

Table 1. MP Control Registers

| NUMBER | NAME | DESCRIPTION | | | | | | |
|--------|---------|-------------------------------|--|--|--|--|--|--|
| 0x0000 | EPC | Exception Program Counter | | | | | | |
| 0x0001 | EIP | Exception Instruction Pointer | | | | | | |
| 0x0002 | CONFIG | Configuration | | | | | | |
| 0x0003 | | Reserved | | | | | | |
| 0x0004 | INTPEN | Interrupt Pending | | | | | | |
| 0x0005 | | Reserved | | | | | | |
| 0x0006 | IE | Interrupt Enable | | | | | | |
| 0x0007 | | Reserved | | | | | | |
| 0x0008 | FPST | Floating-Point Status | | | | | | |
| 0x0009 | | Reserved | | | | | | |
| 0x000A | PPERROR | PP Error Indicators | | | | | | |
| 0x000B | | Reserved | | | | | | |
| 0x000C | | Reserved | | | | | | |
| 0x000D | PKTREQ | Packet Request Register | | | | | | |
| 0x000E | TCOUNT | Current Counter Value | | | | | | |
| 0x000F | TSCALE | Counter Reload Value | | | | | | |
| 0x0010 | FLTOP | Faulting Operation | | | | | | |
| 0x0011 | FLTADR | Faulting Address | | | | | | |
| 0x0012 | FLTTAG | Faulting Tag | | | | | | |
| 0x0013 | FLTDTL | Faulting Data (low) | | | | | | |
| 0x0014 | FLTDTH | Faulting Data (high) | | | | | | |

| NUMBER | NAME | DESCRIPTION | | | | | | | |
|-----------------|----------|------------------------------------|--|--|--|--|--|--|--|
| 0x0015-0x001F | | Reserved | | | | | | | |
| 0x0020 | SYSSTK | System Stack Pointer | | | | | | | |
| 0x0021 | SYSTMP | System Temporary Register | | | | | | | |
| 0x0022-0x002F | | Reserved | | | | | | | |
| 0x0030 | MPC | Emulator Exception Program Cntr | | | | | | | |
| 0x0031 | MIP | Emulator Exception Instruction Ptr | | | | | | | |
| 0x0032 | | Reserved | | | | | | | |
| 0x0033 | ECOMCNTL | Emulator Communication Control | | | | | | | |
| 0x0034 | ANASTAT | Emulation Analysis Status Reg | | | | | | | |
| 0x0035-0x0038 | | Reserved | | | | | | | |
| 0x0039 | BRK1 | Emulation Breakpoint 1 Reg. | | | | | | | |
| 0x003A | BRK2 | Emulation Breakpoint 2 Reg. | | | | | | | |
| 0x003B-0x01FF | | Reserved | | | | | | | |
| 0x0200 - 0x020F | ITAG0-15 | Instruction Cache Tags 0 to 15 | | | | | | | |
| 0x0300 | ILRU | Instruction Cache LRU Register | | | | | | | |
| 0x0400-0x040F | DTAG0-15 | Data Cache Tags 0 to 15 | | | | | | | |
| 0x0500 | DLRU | Data Cache LRU Register | | | | | | | |
| 0x4000 | IN0P | Vector Load Pointer 0 | | | | | | | |
| 0x4001 | IN1P | Vector Load Pointer 1 | | | | | | | |
| 0x4002 | OUTP | Vector Store Pointer | | | | | | | |

pipeline registers

The MP uses a three-stage Fetch, Execute, Access pipeline. The primary pipeline registers are manipulated implicitly by branch and trap instructions and are not accessible by the user. The exception and emulation pipeline registers are user-accessible as control registers. All pipeline registers are 32 bits.

Table 2. MP FEA Pipeline Registers

| | Progra | am Execution | Mode |
|----------------------|--------|--------------|-----------|
| | Normal | Exception | Emulation |
| Program Counter | PC | EPC | MPC |
| Instruction Pointer | IP | EIP | MIP |
| Instruction Register | IR | | • |

• Instruction Register (IR): contains the instruction being executed

Instruction Pointer (IP): points to the instruction being executed
 Program Counter (PC): points to the instruction being fetched

• Exception/Emulator Instruction Pointer (EIP/MIP): points to the instruction that would have been executed had the exception / emulation trap not

• Exception/Emulator Program Counter (EPC/MPC): points to the instruction to be fetched on returning from the exception / emulation trap.

occurred.

config register (0x0002)

The CONFIG register controls or reflects the state of certain options.

| 31 30 29 28 27 26 25 24 23 22 21 20 19 18 17 16 | 15 14 13 12 | 11 10 9 8 | 7 6 5 4 | 3 2 1 0 | | | | | | | |
|---|-------------------------|-------------------------------|------------------|---|--|--|--|--|--|--|--|
| E R T H X Reserved | Туре | Type Deriv Release Res | | | | | | | | | |
| E - Endian Mode; 0 = big endian, 1 = little endian, Read only R - PP Data RAM Round Robin; 0 = variable, 1 = fixed, Read, T - TC PT Round Robin; 0 = variable, 1 = fixed, Read/Write H - High-Priority MP Events; 0 = disabled, 1 = enabled, Read, X - Externally Initiated Packet Transfers; 0 = disabled, 1 = enabled | /Write D R /Write | eriv - C8x f elease - TMS3 | amily derivative | evice, Read only e, Read onlý0x2) n number, Read only | | | | | | | |

Figure 10. CONFIG Register

interrupt enable register (0x0006)

The IE register contains enable bits for each of the interrupts/traps. The global interrupt enable bit (ie) and the individual interrupt enable must be set in order for an interrupt to occur.

| 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------------------|--------------------------------------|---|--|----------------------------------|---------------------------------|----|------|----|----|----|----|--------------------------------------|---------------------------|---|--------------------------------------|------------------------------------|------------------|-------------|----|----|----|---|--------------------------------|--|------------------------------------|--------------------------------|-------------------------|------------------------------------|-----------|----|----|
| ре | x4 | х3 | bp | pb | рс | mi | | | | | | | | p1 | p0 | io | mf | | x2 | x1 | ti | | | fx | fu | fo | | fz | fi | | ie |
| x x b p | :3 - ()p - b)b - p)c - (| exterexterexterexterexterexterexterexte | nal i nal i pack et tra et tra | nteri et tra ansfe ansf | rupt ansfe er bu er co | | INT3 | 3) | | | | p0 - io - mf - x2 - x1 - | PP integ me exte | 0 me ger o mory ernal ernal | essagessage overfly fau I inte | ge in low It rrup rrup | t 2 (Ī t 1 (Ī | upt EINT | _ | | | | fu - fo - fz - fi - f | float float float float floati glob | ting ting ting ting | poin poin point point | t und t ove t div | derflov erflov ide b alid | v y ze | ro | |

Figure 11. IE Register



interrupt pending register (0x0004)

The bits in INTPEN show the current state of each interrupt/trap. Pending interrupts will not occur unless the ie bit and corresponding interrupt enable bit are set (note: some memory faults are nonmaskable). Software must write a "1" to the appropriate INTPEN bit to clear an interrupt.

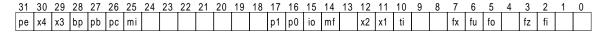


Figure 12. INTPEN Register

floating-point status register (0x0008)

FPST contains status and control information for the FPU. Bits 17-21 are read/write FPU control bits. Bits 22-26 are read/write accumulated status bits. All other bits show the status of the last FPU instruction to complete and are read-only bits.

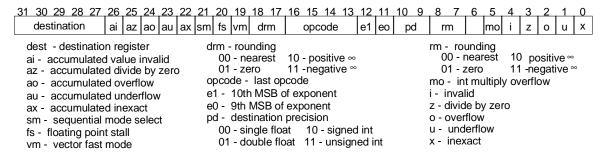


Figure 13. FPST Register

PP error register (0x000A)

The bits in the PPERROR register reflect Parallel Processor errors. The MP may use these when a PP Error occurs to determine the cause of the error.

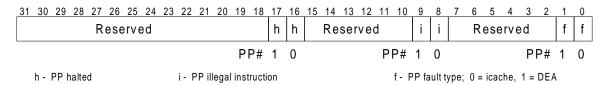


Figure 14. PPERROR Register

packet transfer request register (0x000D)

PKTREQ controls the submission and priority of packet-transfer requests. It also indicates if a PT is currently active.

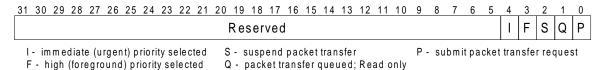


Figure 15. PKTREQ Register



memory fault registers

The five read-only memory fault registers contain information about memory address exceptions.

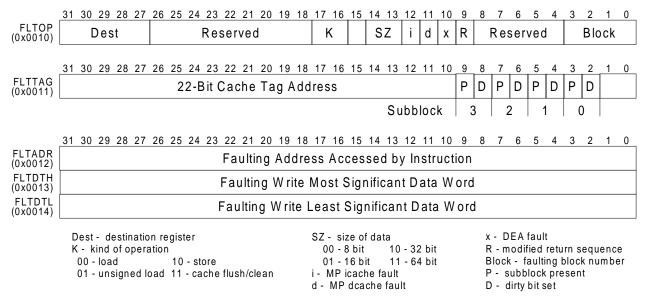
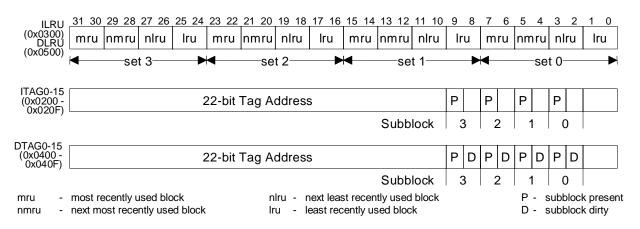


Figure 16. Memory Fault Registers

cache registers

The ILRU and DLRU registers track least recently used information for the sixteen instruction cache and sixteen data cache blocks. The ITAGxx registers contain block addresses and the present flags for each subblock. DTAGxx registers are identical to ITAGxx registers but include dirty bits for each subblock.



mru, nmru, nlru, and lru have the value 0, 1, 2, or 3 representing the block number and are mutually exclusive for each set.

Figure 17. Cache Registers

cache architecture

The MP contains two four-way set associative 4K caches—one for instructions and one for data. Each cache is divided into four sets with four blocks in each set. Each block represents 256 bytes of contiguous instructions or data and is aligned to a 256-byte address boundary. Each block is partitioned into eight subblocks that each contain sixteen 32-bit words and are aligned to 64-byte boundaries within the block. Cache misses cause one subblock to be loaded into cache. Figure 18 shows the cache architecture for one of the four sets in each cache. Figure 19 shows how addresses map into the cache using the cache tags and address bits.

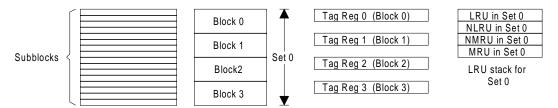


Figure 18. MP Cache Architecture (x4 Sets)

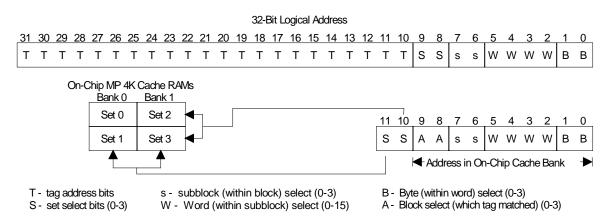


Figure 19. Cache Addressing

MP parameter RAM

The parameter RAM is a non-cacheable, 4K-byte, on-chip RAM which contains MP interrupt vectors, MP requested TC task buffers, and a general-purpose area. Figure 20 shows the parameter RAM address map.

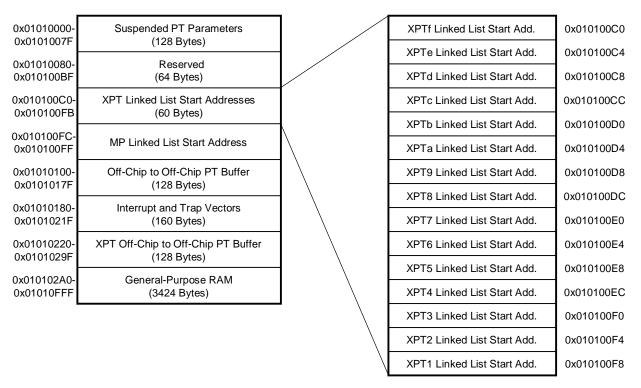


Figure 20. MP Parameter RAM

MP interrupt vectors

The MP interrupts and traps and their vector addresses are shown in Table 3 and Table 4.

Table 3. Maskable Interrupts

| IE BIT | | VECTOR | |
|----------|------|------------|-------------------------------|
| (TRAP #) | NAME | ADDRESS | MASKABLE INTERRUPT |
| 0 | ie | 0x01010180 | |
| 2 | fi | 0x01010188 | Floating-point invalid |
| 3 | fz | 0x0101018C | Floating-point divide by zero |
| 5 | fo | 0x01010194 | Floating-point overflow |
| 6 | fu | 0x01010198 | Floating-point underflow |
| 7 | fx | 0x0101019C | Floating-point inexact |
| 8 | f0 | 0x010101A0 | Reserved |
| 9 | f1 | 0x010101A4 | Reserved |
| 10 | ti | 0x010101A8 | MP timer |
| 11 | x1 | 0x010101AC | External interrupt 1 (/EINT1) |
| 12 | x2 | 0x010101B0 | External interrupt 2 (/EINT2) |
| 14 | mf | 0x010101B8 | Memory fault |
| 15 | io | 0x010101BC | Integer overflow |
| 16 | p0 | 0x010101C0 | PP0 message |
| 17 | p1 | 0x010101C4 | PP1 message |
| 18 | p2 | 0x010101C8 | Reserved |
| 19 | р3 | 0x010101CC | Reserved |
| 25 | mi | 0x010101E4 | MP message |
| 26 | рс | 0x010101E8 | Packet transfer complete |
| 27 | pb | 0x010101EC | Packet transfer busy |
| 28 | bp | 0x010101F0 | Bad packet transfer |
| 29 | х3 | 0x010101F4 | External interrupt 3 (/EINT3) |
| 30 | x4 | 0x010101F8 | External interrupt 4 (/LINT4) |
| 31 | pe | 0x010101FC | PP error |

Table 4. Nonmaskable Traps

| TRAP | | VECTOR | |
|-----------|------|-----------------------------|---------------------------|
| NUMBER | NAME | ADDRESS | NONMASKABLE TRAP |
| 32 | e1 | 0x01010200 | Emulator trap1 (reserved) |
| 33 | e2 | 0x01010204 | Emulator trap2 (reserved) |
| 34 | e3 | 0x01010208 | Emulator trap3 (reserved) |
| 35 | e4 | 0x0101020C | Emulator trap4 (reserved) |
| 36 | fe | 0x01010210 | Floating-point error |
| 37 | | 0x01010214 | Reserved |
| 38 | er | 0x01010218 | Illegal MP instruction |
| 39 | | 0x0101021C | Reserved |
| 72 to 415 | | 0x010102A0 to 0x010107FC | System- or user-defined |

MP opcode formats

The three basic classes of MP instruction opcodes are short immediate, three register, and long immediate. The opcode structure for each class of instruction is shown in Figure 21.

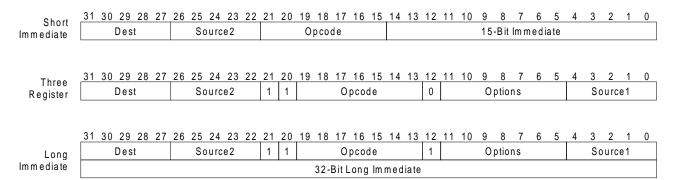


Figure 21. MP Opcode Formats

MP opcode summary

The opcode formats for the MP are shown in Table 5 through Table 7. Table 8 summarizes the master processor instruction set.

MP opcode summary (continued)

Table 5. Short Immediate Opcodes

| | 31 30 29 28 27 | 26 25 24 23 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0 | | | | | | | |
|----------|----------------|----------------|----|----|----|----|----|----|--------------------|------------------------------------|--|--|--|--|--|--|--|
| illop0 | Dest | Source | 0 | 0 | 0 | 0 | 0 | 0 | 0 | Unsigned Immediate | | | | | | | |
| trap | E | | 0 | 0 | 0 | 0 | 0 | 0 | 1 | Unsigned Trap Number | | | | | | | |
| cmnd | | | 0 | 0 | 0 | 0 | 0 | 1 | 0 | Unsigned Immediate | | | | | | | |
| rdcr | Dest | | 0 | 0 | 0 | 0 | 1 | 0 | 0 | Unsigned Control Register Number | | | | | | | |
| swcr | Dest | Source | 0 | 0 | 0 | 0 | 1 | 0 | 1 | Unsigned Control Register Number | | | | | | | |
| brcr | | | 0 | 0 | 0 | 0 | 1 | 1 | 0 | Unsigned Control Register Number | | | | | | | |
| shift.dz | Dest | Source | 0 | 0 | 0 | 1 | 0 | 0 | 0 | i n Endmask Rotate | | | | | | | |
| shift.dm | Dest | Source | 0 | 0 | 0 | 1 | 0 | 0 | 1 | i n Endmask Rotate | | | | | | | |
| shift.ds | Dest | Source | 0 | 0 | 0 | 1 | 0 | 1 | 0 | i n Endmask Rotate | | | | | | | |
| shift.ez | Dest | Source | 0 | 0 | 0 | 1 | 0 | 1 | 1 | i n Endmask Rotate | | | | | | | |
| shift.em | Dest | Source | 0 | 0 | 0 | 1 | 1 | 0 | 0 | i n Endmask Rotate | | | | | | | |
| shift.es | Dest | Source | 0 | 0 | 0 | 1 | 1 | 0 | 1 | i n Endmask Rotate | | | | | | | |
| shift.iz | Dest | Source | 0 | 0 | 0 | 1 | 1 | 1 | 0 | i n Endmask Rotate | | | | | | | |
| shift.im | Dest | Source | 0 | 0 | 0 | 1 | 1 | 1 | 1 | i n Endmask Rotate | | | | | | | |
| and.tt | Dest | Source2 | 0 | 0 | 1 | 0 | 0 | 0 | 1 | Unsigned Immediate | | | | | | | |
| and.tf | Dest | Source2 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | Unsigned Immediate | | | | | | | |
| and.ft | Dest | Source2 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | Unsigned Immediate | | | | | | | |
| xor | Dest | Source2 | 0 | 0 | 1 | 0 | 1 | 1 | 0 | Unsigned Immediate | | | | | | | |
| or.tt | Dest | Source2 | 0 | 0 | 1 | 0 | 1 | 1 | 1 | Unsigned Immediate | | | | | | | |
| and.ff | Dest | Source2 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | Unsigned Immediate | | | | | | | |
| xnor | Dest | Source2 | 0 | 0 | 1 | 1 | 0 | 0 | 1 | Unsigned Immediate | | | | | | | |
| or.tf | Dest | Source2 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | Unsigned Immediate | | | | | | | |
| or.ft | Dest | Source2 | 0 | 0 | 1 | 1 | 1 | 0 | 1 | Unsigned Immediate | | | | | | | |
| or.ff | Dest | Source2 | 0 | 0 | 1 | 1 | 1 | 1 | 0 | Unsigned Immediate | | | | | | | |
| ld | Dest | Base | 0 | 1 | 0 | 0 | М | S | Z | Signed Offset | | | | | | | |
| ld.u | Dest | Base | 0 | 1 | 0 | 1 | М | S | Z | Signed Offset | | | | | | | |
| st | Source | Base | 0 | 1 | 1 | 0 | М | S | Z | Signed Offset | | | | | | | |
| dcache | F | Source2 | 0 | 1 | 1 | 1 | М | 0 | 0 | Signed Offset | | | | | | | |
| bsr | Link | | 1 | 0 | 0 | 0 | 0 | 0 | Α | Signed Offset | | | | | | | |
| jsr | Link | Base | 1 | 0 | 0 | 0 | 1 | 0 | Α | Signed Offset | | | | | | | |
| bbz | BITNUM | Source | 1 | 0 | 0 | 1 | 0 | 0 | Α | A Signed Offset | | | | | | | |
| bbo | BITNUM | Source | 1 | 0 | 0 | 1 | 0 | 1 | Α | A Signed Offset | | | | | | | |
| bcnd | Cond | Source | 1 | 0 | 0 | 1 | 1 | 0 | Α | Signed Offset | | | | | | | |
| cmp | Dest | Source2 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | Signed Immediate | | | | | | | |
| add | Dest | Source2 | 1 | 0 | 1 | 1 | 0 | 0 | С | Signed Immediate | | | | | | | |
| sub | Dest | Source2 | 1 | 0 | 1 | 1 | 0 | 1 | U Signed Immediate | | | | | | | | |

- Reserved bit (code as 0)
 A Annul delay slot instruction if branch taken
- E Emulation trap bit
- Clear present flags
- Invert endmask

- $\begin{array}{ll} M & \mbox{Modify, write modified address back to register} \\ n & \mbox{Rotate sense for shifting} \end{array}$
- SZ Size (0=byte, 1=halfword, 2=word, 3=doubleword) U Unsigned form

MP opcode summary (continued)

Table 6. Long Immediate and Three Register Opcodes

| | 31 30 29 28 27 | 26 25 24 23 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 3 2 1 0 |
|----------|----------------|----------------|----|----|----|----|----|----|----|----|----|----|----|----|---|----|---------|-----|---|-----------|
| trap | E | | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | _ | - | - | - | - | - | - | - | IND TR |
| cmnd | | | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | I | - | - | - | - | - | - | - | Source1 |
| rdcr | Dest | | 1 | 1 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | I | - | - | - | - | - | - | - | IND CR |
| swcr | Dest | Source | 1 | 1 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | Ι | - | - | - | - | - | - | - | IND CR |
| brcr | | | 1 | 1 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | Ι | - | - | - | - | - | - | - | IND CR |
| shift.dz | Dest | Source | 1 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | ı | i | n | | En | dma | ask | | Rotate |
| shift.dm | Dest | Source | 1 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | i | n | | En | dma | ask | | Rotate |
| shift.ds | Dest | Source | 1 | 1 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | 1 | i | n | | En | dma | ask | | Rotate |
| shift.ez | Dest | Source | 1 | 1 | 0 | 0 | 0 | 1 | 0 | 1 | 1 | Ι | i | n | | En | dma | ask | | Rotate |
| shift.em | Dest | Source | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | Ι | i | n | | En | dma | ask | | Rotate |
| shift.es | Dest | Source | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | i | n | | En | dma | ask | | Rotate |
| shift.iz | Dest | Source | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 1 | 0 | 1 | i | n | | En | dma | ask | | Rotate |
| shift.im | Dest | Source | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | Ι | i | n | | En | dma | ask | | Rotate |
| and.tt | Dest | Source2 | 1 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 1 | 1 | - | - | - | - | - | - | - | Source1 |
| and.tf | Dest | Source2 | 1 | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | 1 | - | - | - | - | - | - | - | Source1 |
| and.ft | Dest | Source2 | 1 | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | 1 | - | - | - | - | - | - | - | Source1 |
| xor | Dest | Source2 | 1 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 0 | Ι | - | - | - | | | | | Source1 |
| or.tt | Dest | Source2 | 1 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 1 | 1 | - | - | - | - | - | - | - | Source1 |
| and.ff | Dest | Source2 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 1 | - | - | - | - | - | - | - | Source1 |
| xnor | Dest | Source2 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 1 | 1 | - | - | - | - | - | - | - | Source1 |
| or.tf | Dest | Source2 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | Ι | - | - | - | - | - | - | - | Source1 |
| or.ft | Dest | Source2 | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 0 | 1 | Ι | - | - | - | - | - | - | - | Source1 |
| or.ff | Dest | Source2 | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | 0 | Ι | - | - | - | - | - | - | - | Source1 |
| ld | Dest | Base | 1 | 1 | 0 | 1 | 0 | 0 | М | S | Z | 1 | S | D | - | - | - | - | - | Offset |
| ld.u | Dest | Base | 1 | 1 | 0 | 1 | 0 | 1 | М | S | Z | 1 | S | D | - | - | - | - | - | Offset |
| st | Source | Base | 1 | 1 | 0 | 1 | 1 | 0 | М | S | Z | Ι | S | D | - | - | - | - | - | Offset |
| dcache | F | Source2 | 1 | 1 | 0 | 1 | 1 | 1 | М | 0 | 0 | Ι | 0 | 0 | - | - | - | - | - | Source1 |
| bsr | Link | | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | Α | Ι | - | - | - | - | - | - | - | Offset |
| jsr | Link | Base | 1 | 1 | 1 | 0 | 0 | 0 | 1 | 0 | Α | 1 | - | - | - | - | - | - | - | Offset |
| bbz | BITNUM | Source | 1 | 1 | 1 | 0 | 0 | 1 | 0 | 0 | Α | 1 | - | - | - | - | - | - | - | Target |
| bbo | BITNUM | Source | 1 | 1 | 1 | 0 | 0 | 1 | 0 | 1 | Α | 1 | - | - | - | - | - | - | - | Target |
| bcnd | Cond | Source | 1 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | Α | 1 | | | | | Target | | | |
| cmp | Dest | Source2 | 1 | 1 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | _ | | | | | Source1 | | | |
| add | Dest | Source2 | 1 | 1 | 1 | 0 | 1 | 1 | 0 | 0 | U | 1 | | | | | Source1 | | | |
| sub | Dest | Source2 | 1 | 1 | 1 | 0 | 1 | 1 | 0 | 1 | U | Ι | - | - | - | - | - | - | - | Source1 |

- Reserved bit (code as 0)
- D Direct external access bit
- E Emulation trap bit
- F Clear present flags
- i Invert endmask
- I Long immediate
- I Long immediateM Modify, write modified address back to register
 - n Rotate sense for shifting
 - S Scale offset by data size
 SZ Size (0=byte, 1=halfword, 2=word, 3=doubleword)

MP opcode summary (continued)

Table 7. Miscellaneous Instruction Opcode

| | 31 30 29 28 27 | 26 25 24 23 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 (| 0 |
|------------|----------------|----------------|----|----|----|----|----|----|----|----|----|----|----|----|---|----|---|---|---|---|----|------|-----|---|
| vadd | Mem Dst | Source2/Dest | 1 | 1 | 1 | 1 | 0 | - | 0 | 0 | 0 | I | - | m | Р | - | d | m | s | | So | urce | 1 | |
| vsub | Mem Dst | Source2/Dest | 1 | 1 | 1 | 1 | 0 | - | 0 | 0 | 1 | ı | - | m | Р | - | d | m | s | | So | urce | 1 | |
| vmpy | Mem Dst | Source2/Dest | 1 | 1 | 1 | 1 | 0 | - | 0 | 1 | 0 | ı | - | m | Р | - | d | m | s | | So | urce | 1 | |
| vmsub | Mem Dst | Dest | 1 | 1 | 1 | 1 | 0 | а | 0 | 1 | 1 | I | а | m | Р | Z | - | m | - | | So | urce | 1 | |
| vrnd(FP) | Mem Dst | Dest | 1 | 1 | 1 | 1 | 0 | а | 1 | 0 | 0 | I | а | m | Р | Р | D | m | s | | So | urce | 1 | |
| vrnd (Int) | Mem Dst | Dest | 1 | 1 | 1 | 1 | 0 | - | 1 | 0 | 1 | ı | - | m | Р | - | d | m | s | | So | urce | 1 | |
| vmac | Mem Dst | Source2 | 1 | 1 | 1 | 1 | 0 | а | 1 | 1 | 0 | _ | а | m | Р | Z | - | m | - | | So | urce | 1 | |
| vmsc | Mem Dst | Source2 | 1 | 1 | 1 | 1 | 0 | а | 1 | 1 | 1 | I | а | m | Р | Z | - | m | - | | So | urce | 1 | |
| fadd | Dest | Source2 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0 | 0 | I | - | Р | D | Р | 2 | Р | 1 | | So | urce | 1 | |
| fsub | Dest | Source2 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0 | 1 | ı | - | Р | D | Р | 2 | Р | 1 | | So | urce | 1 | |
| fmpy | Dest | Source2 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 1 | 0 | ı | - | Р | D | Р | 2 | Р | 1 | | So | urce | 1 | |
| fdiv | Dest | Source2 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 1 | 1 | ı | - | Р | D | Р | 2 | Р | 1 | | So | urce | 1 | |
| frndx | Dest | | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 0 | 0 | ı | - | Р | D | RI | M | Р | 1 | | So | urce | 1 | |
| fcmp | Dest | Source2 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 0 | 1 | ı | - | - | - | Р | 2 | Р | 1 | | So | urce | 1 | |
| fsqrt | Dest | | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 1 | 1 | ı | - | Р | D | - | - | Р | 1 | | So | urce | 1 | |
| lm o | Dest | Source | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0 | - | - | - | - | - | - | - | - | - | - | - | - | - |
| rm o | Dest | Source | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 1 | - | - | - | - | - | - | - | - | - | - | - | - | - |
| estop | | | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | - | - | - | - | - | - | - | - | - | - | - | - | - |
| illopF | | | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | С | - | - | - | - | - | - | - | - | - | - | - | - |

- Reserved (code as 0)
 Floating-point accumulator select
- C Constant operands rather than register
- Destination precision for vector (0=sp, 1=dp)
- Long-immediate 32-bit data
- m Parallel memory operation specifier
- Dest precision for parallel load/store (0=single, 1=double)
- P1 Precision of source1 operand
- P2 Precision of source2 operand
- PD Precision of destination result
- RM Rounding Mode (0=N, 1=Z, 2=P, 3=M)
- s Scale offset by data size
- Z Use 0 rather than accumulator

MP opcode summary (continued)

Table 8. Summary of MP Opcodes

| INSTRUCTION | DESCRIPTION | INSTRUCTION | DESCRIPTION |
|-------------|---------------------------------|-------------|--|
| add | Signed integer add | or.ff | Bitwise OR with 1's complement |
| and.tt | Bitwise AND | or.ft | Bitwise OR with 1's complement |
| and.ff | Bitwise AND with 1's complement | or.tf | Bitwise OR with 1's complement |
| and.ft | Bitwise AND with 1's complement | rdcr | Read control register |
| and.tf | Bitwise AND with 1's complement | rmo | Rightmost one |
| bbo | Branch bit one | shift.dz | Shift, disable mask, zero extend |
| bbz | Branch bit zero | shift.dm | Shift, disable mask, merge |
| bcnd | Branch conditional | shift.ds | Shift, disable mask, sign extend |
| br | Branch always | shift.ez | Shift, enable mask, zero extend |
| brcr | Branch control register | shift.em | Shift, enable mask, merge |
| bsr | Branch and save return | shift.es | Shift, enable mask, sign extend |
| cmnd | Send command | shift.iz | Shift, invert mask, zero extend |
| cmp | Integer compare | shift.im | Shift, invert mask, merge |
| dcache | Flush data cache subblock | st | Store register into memory |
| estop | Emulation stop | sub | Signed integer subtract |
| fadd | Floating-point add | swcr | Swap control register |
| fcmp | Floating-point compare | trap | Trap |
| fdiv | Floating-point divide | vadd | Vector floating-point add |
| fmpy | Floating-point multiply | vmac | Vector floating-point multiply and add to accumulator |
| frndx | Floating-point convert/round | vmpy | Vector floating-point multiply |
| fsqrt | Floating-point square root | vmsc | Vector floating-point multiply and subtract from accumulator |
| fsub | Floating-point subtract | vmsub | Vector floating-point subtract accumulator from source |
| illop | Illegal operation | vrnd(FP) | Vector round with floating-point input |
| jsr | Jump and save return | vrnd(Int) | Vector round with integer input |
| ld | Load signed into register | vsub | Vector floating-point subtract |
| ld.u | Load unsigned into register | xnor | Bitwise exclusive NOR |
| lmo | Leftmost one | xor | Bitwise exclusive OR |
| or.tt | Bitwise OR | | |

parallel processor architecture

The Parallel Processor (PP) is a 32-bit integer digital signal processor (DSP) optimized for imaging and graphics applications. The PP can execute in parallel a multiply, ALU operation, and two memory accesses within a single instruction. This internal parallelism allows a single PP to achieve over 500 million operations per second for certain algorithms. The PP has a three-input ALU that supports all 256 three input Boolean combinations and many combinations of arithmetic and Boolean functions. Data merging and bit-to-byte, bit-to-word, and bit-to-halfword translations are supported by hardware in the input data path to the ALU. Typical tasks performed by a PP include:

- Pixel-intensive processing
 - Motion estimation
 - Convolution
 - PixBLTs
 - Warp
 - Histogram
 - Mean square error
- Domain transforms
 - DCT
 - FFT
 - Hough

- Core graphics functions
 - Line
 - Circle
 - Shaded fills
 - Fonts
- Image Analysis
 - Segmentation
 - Feature extraction
- Bit-stream encoding/decoding
 - Data merging
 - Table look-ups

functional block diagram

Figure 22 shows a block diagram of a parallel processor. Key features of the PP include:

- 64-bit instruction word (supports multiple parallel operations)
- 3-stage pipeline for fast instruction cycle
- Numerous registers
 - 8 data, 10 address, 6 index registers
 - 20 other user-visible registers
- Data Unit
 - 16x16 integer multiplies (optional 8x8)
 - Splittable 3-input ALU
 - 32-bit barrel rotator
 - Mask generator
 - Multiple-status flag expander for translations to/from 1 bit-per-pixel space.
 - Conditional assignment of data unit results
 - Conditional source selection
 - Special processing hardware
 leftmost one / rightmost one
 leftmost bit change / rightmost bit change

- Memory addressing
 - 2 address units (global and local) provide up to two 32-bit accesses in parallel with data unit operation.
 - 12 addressing modes (immediate and indexed)
 - Byte, halfword, and word addressability
 - Scaled indexed addressing
 - Conditional assignment for loads
 - Conditional source selection for stores
- Program flow
 - Three hardware loop controllers
 zero overhead looping / branching
 nested loops
 multiple loop endpoints
 - Instruction cache management
 - PC mapped to register file
 - Interrupts for messages and context switching
- Algebraic assembly language



functional block diagram (continued)

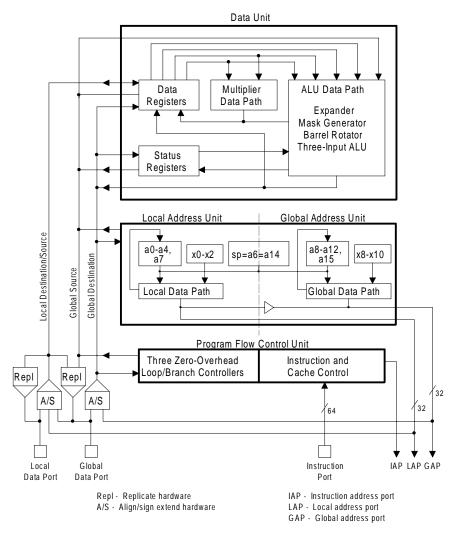


Figure 22. PP Block Diagram

PP registers

The PP contains many general-purpose registers. It also has a number of status registers and configuration registers. All PP registers are 32-bit registers. Below are the accessible registers of the various PP blocks.

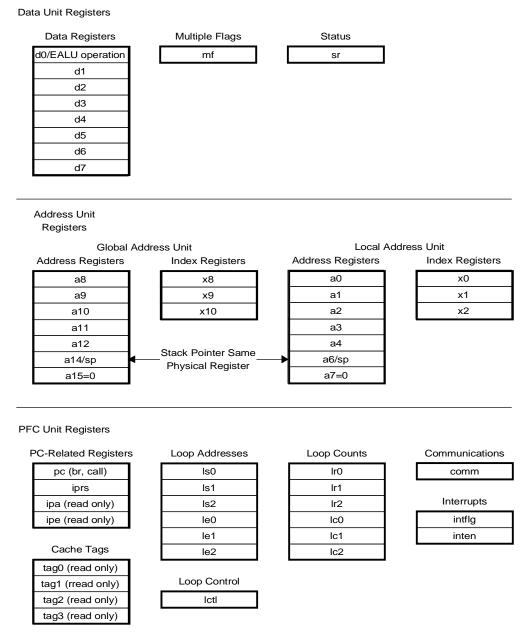


Figure 23. PP Registers

data unit registers

The data unit contains eight 32-bit general-purpose data registers (d0-d7) referred to as the D registers. The d0 register also acts as the control register for EALU operations.

d0 register

When used as the EALU control register, d0 has the format shown in Figure 24.

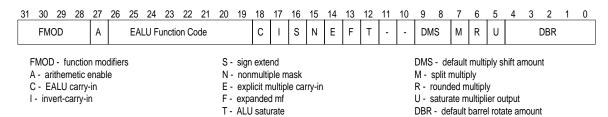


Figure 24. d0 Format for EALU Operations

mf register

The multiple flags (mf) register records status information from each split ALU segment for multiple arithmetic operations. The mf register may be expanded to generate a mask for the ALU.

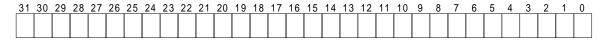


Figure 25. mf Register Format

sr register

The status register (sr) contains status and control bits for the PP ALU.

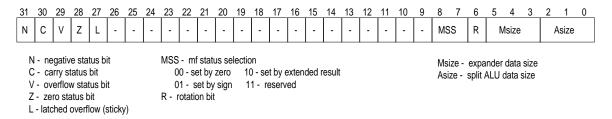


Figure 26. sr Register Format

address unit registers

address registers

The address unit contains ten 32-bit address registers which contain the base address for address computations or may be used for general-purpose data. The registers a0 - a4 are used for local address computations and registers a8-a12 are used for global address computations.

index registers

The six 32-bit index registers contain index values for use with the address registers in address computations or may be used for general-purpose data. Registers x0-x2 are used by the local address unit and registers x8-x10 are used by the global address unit.

stack pointer

The stack pointer contains the address of the top of the PP's system stack. The stack pointer is addressed as a6 by the local address unit and as a14 by the global address unit.

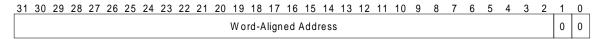


Figure 27. sp Register Format

zero register

The zero registers are read-as-zero address registers for the local address unit (a7) and global address unit (a15). Writes to the registers are ignored and may be specified when operational results are to be discarded.

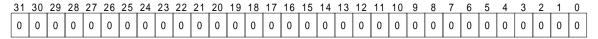


Figure 28. Zero Registers

PFC Unit Registers

loop registers

The loop registers control three levels of zero-overhead loops. The 32-bit loop start registers (Is0 - Is2) and loop end registers (Ie0 - Ie2) contain the starting and ending addresses for the loops. The loop counter registers (Ic0 - Ic2) contain the number of repetitions remaining in their associated loops. The Ir0 - Ir2 registers are loop reload registers used to support nested loops. The format for the loop control register (Ictl) is shown in Figure 29. There are also six special write-only mappings of the loop reload registers. The Irs0 - Irs2 codes are used for fast initialization of Isn, Irn, and Icn registers for multi-instruction loops while the Irse0 - Irse2 codes are used for single instruction-loop fast initialization.

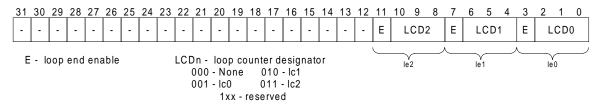


Figure 29. Ictl Register



pipeline registers

The pfc unit contains a pointer to each stage of the PP pipeline. The pc contains the program counter which points to the instruction being fetched. The ipa points to the instruction in the address stage of the pipeline and the ipe points to the instruction in the execute stage of the pipeline. The instruction pointer return-from-subroutine (iprs) register contains the return address for a subroutine call.

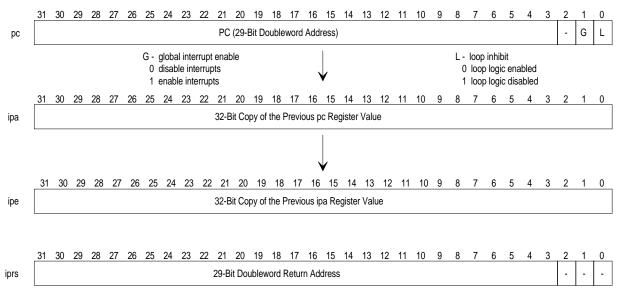


Figure 30. Pipeline Registers

interrupt registers

The interrupt enable register (inten) allows individual interrupts to be enabled and configures intflg operation. The interrupt flag register (intflg) contains interrupt flag bits.

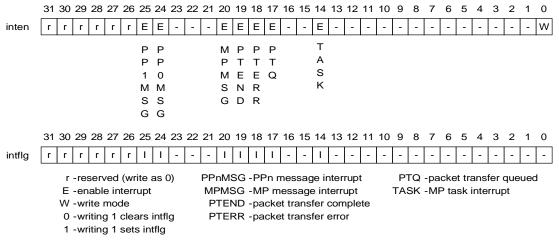


Figure 31. PP Interrupt Registers

communication register

The comm register contains the packet transfer handshake bits and PP indicator bits.

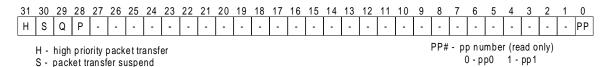


Figure 32. comm Register

cache tag registers

The tag0 - tag3 registers contain the tag address and subblock present bits for each cache block.

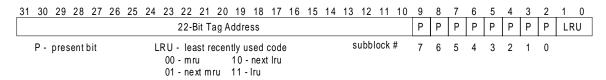


Figure 33. Cache Tag Registers

PP cache architecture

Each of the two PPs has its own 4K-byte instruction cache. Each cache is divided into four blocks and each block is divided into eight subblocks containing 16 64-bit instructions each. Cache misses cause one subblock to be loaded into cache. Figure 34 shows the cache architecture for one of the four sets in each cache. Figure 35 shows how addresses map into the cache using the cache tags and address bits.

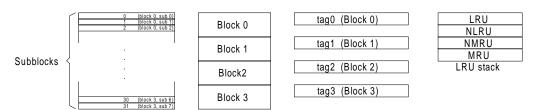


Figure 34. PP Cache Architecture

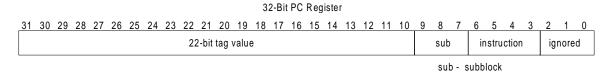


Figure 35. pc Register Cache Address Mapping

PP parameter RAM

The parameter RAM is a noncacheable, 4K-byte, on-chip RAM which contains PP interrupt vectors, PP requested TC task buffers, and a general-purpose area. Figure 36 shows the parameter RAM address map.

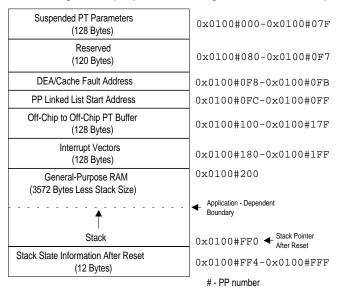


Figure 36. PP Parameter RAM

PP interrupt vectors

The PP interrupts and their vector addresses are shown in Table 9.

Table 9. PP Interrupt Vectors

| | VECTOR | |
|--------|------------|------------------------|
| NAME | ADDRESS | INTERRUPT |
| TASK | 0x0100#1B8 | Task Interrupt |
| PTQ | 0x0100#1C4 | Packet Transfer Queued |
| PTERR | 0x0100#1C8 | Packet Transfer Error |
| PTEND | 0x0100#1CC | Packet Transfer End |
| MPMSG | 0x0100#1D0 | MP Message |
| PP0MSG | 0x0100#1E0 | PP0 Message |
| PP1MSG | 0x010101E4 | PP1 Message |

PP data unit architecture

The data unit has independent data paths for the ALU and the multiplier, each with its own set of hardware functions. The multiplier data path includes a 16x16 multiplier, a halfword swapper and rounding hardware. The ALU data path includes a 32-bit three-input ALU, a barrel rotator, mask generator, mf expander, left/right most one and left/right most bit change logic, and several multiplexers.

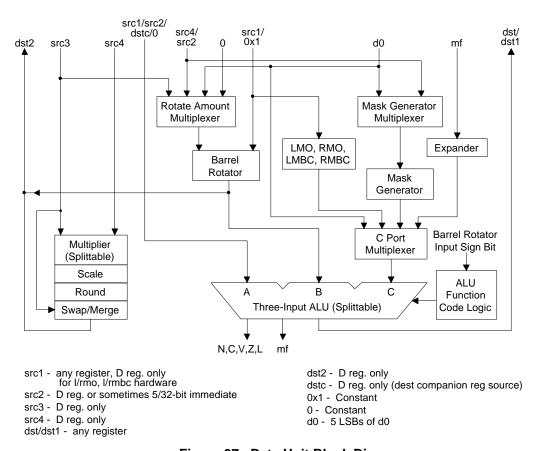


Figure 37. Data Unit Block Diagram

PP data unit architecture (continued)

The PP's ALU can be split into one 32-bit ALU, two 16-bit ALUs or four 8-bit ALUs. Figure 38 shows the multiple arithmetic data flow for the case of a four 8-bit split of the ALU (called multiple-byte arithmetic). The ALU operates as independent parallel ALUs where each ALU receives the same function code.

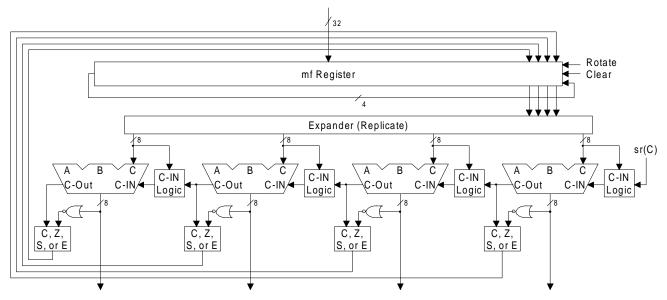


Figure 38. Multiple-Byte Arithmetic Data Flow

During EALU operations, the split ALU outputs may be saturated/clamped at maximum or minimum values. The ALU saturate feature is controlled by the T bit and the N bit in d0, as shown in Table 10. Saturation may only be specified for 32-bit signed arithmetic.

Table 10. ALU Saturate/Clamp Option

| D (EA | O LU) | NON-MULTIPLE MASK/SATURATE-CLAMP OPTION |
|----------|----------|--|
| N | Т | |
| 0 | 0 | Normal operation |
| 0 | 1 | Reserved |
| 1 | 0 | Non-multiple mask |
| 1 | 1 | Saturate-clamp-signed option |

32-BIT SIGNED ALU:

Result = 0x7FFFFFF ~Cout[31] & Cin[31] Saturate at max positive value Result = 0x80000000Cout[31] & ~Cin[31] Clamp at most negative value



PP multiplier

The PP's hardware multiplier can perform one 16x16 multiply with a 32-bit result or two 8x8 multiplies with two 16-bit results in a single cycle. A 16x16 multiply may use signed or unsigned operands as shown in Figure 39.

| 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----|----|----|----|----|----|----|----|----|----|----|----|----|------|------|------|-------|-----|------|-----|----|----|-----|------|-------|------|---|---|---|---|---|---|
| X | X | Х | Х | Х | Х | Х | Х | Х | Х | Х | Χ | Х | Х | Х | Х | S | | | | | | | Sign | ed l | npu | t | | | | | |
| | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| S | S | | | | | | | | | | | | | Sigr | ned | x Si | gne | d Re | sul | t | | | | | | | | | | | |
| | • | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| X | X | Х | Х | Х | Х | Х | Х | Х | Х | Х | Χ | Х | Х | Х | Х | | | | | | | Uns | sign | ıl bə | nput | | | | | | |
| | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | , |
| 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | | | | | | | | | | | Un | sigr | ned | x Ur | ısigı | ned | Res | ult | | | | | | | | | | | | |

Figure 39. 16 x 16 Multiplier Data Formats

When performing two simultaneous 8x8 split multiplies. The first input word contains unsigned byte operands and the second input word may contain signed or unsigned byte operands. These formats are shown in Figure 40 and Figure 41.

| 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----|-------------------------|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|-------|------|-------|-------|------|-----|----|---|-------|-----|------|------|----|---|
| X | Х | Х | Х | Х | Х | Х | Х | Х | Х | Х | Х | Х | Х | Х | Х | | U | Insig | gned | d inp | out 1 | b | | | U | Insig | nec | linp | ut 1 | а | |
| 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| X | Χ | Х | Χ | Х | Х | Х | Х | Х | Х | Х | Χ | Χ | Х | Х | Χ | S | | Si | gne | d in | put | 2b | | S | | Si | gne | d in | put | 2a | |
| | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| S | S 1b x 2b signed result | | | | | | | | | | | | S | | | | | 1 | ах | 2a : | sign | ed r | esu | lt | | | | | | | |

Figure 40. Signed Split-Multiply Data Formats

| 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------------------|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|------|-----|-------|------|------|-----|---|---|------|-----|--------|------|----|---|
| X | Х | Х | Х | Χ | Х | Х | Х | Х | Х | Х | Х | Χ | Х | Х | Х | | U | nsiç | nec | d inp | ut 1 | b | | | U | nsiç | nec | d in p | ut 1 | а | |
| 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| X | Χ | Χ | Χ | Χ | Χ | Х | Χ | Х | Χ | Χ | Χ | Χ | Х | Χ | Χ | | U | nsiç | nec | d inp | ut 2 | b | | | U | nsiç | nec | d inp | ut 2 | 2a | |
| | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 1b x 2b unsigned result | | | | | | | | | | | | | | | | | | 1a x | 2a | uns | igne | d re | sul | t | | | | | | | |

Figure 41. Unsigned Split-Multiply Data Formats

PP multiplier (continued)

Additionally, 16 x 16 multiplies may take on another form wherein the multiplier output is rounded by adding bit 15 to bit 16 of the result. The upper 16 bits of the result are written to the upper 16 bits of the destination register, while the lower 16 bits are filled with bits 31-16 of the first multiply source operand. This allows back-to-back multiplies to produce two rounded results, as shown below.

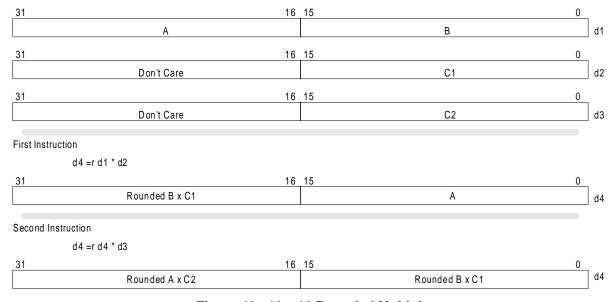


Figure 42. 16 x 16 Rounded Multiply

During MPY||EALU[†] operations, the multiplier output may be saturated as specified by the U bit in d0. Saturation is valid only for left shift of 0 and 1, as shown in Table 11. Like the ALU saturation option, multiplier saturation may only be specified during EALUs, and is valid only for signed multiplies. Multiplier and ALU saturation may be independently specified in a given EALU. Saturation is specified using the t function modifier.

Table 11. Multiplier Saturation

| DN | ИS | U | MULTIPLIER SATURATE OPTION |
|----|----|---|--|
| Χ | Χ | 0 | No saturation |
| 0 | 0 | 1 | set result to 0x3FFFFFFF (instead of 0x40000000) |
| 0 | 1 | 1 | set result to 0x7FFFFFFF (instead of 0x80000000) |
| 1 | Χ | 1 | No saturation |

When rounding is enabled, the 16 LSBs of the result are protected (i.e., unaffected by the saturation option). In this case a pre-saturated result of 0x4000XXXX (DMS = 00) will be saturated to 0x3FFXXXX, and a presaturated result of 0x7FFFXXXX (DMS = 01) is saturated to 0x8000XXXX. Saturation should not be specified with split multiplies.

[†]The || symbol indicates operations are to be performed in parallel.



PP program flow control unit architecture

The program flow control unit performs instruction fetching and decoding, loop control, and handshaking with the transfer controller. The pfc unit architecture is shown in Figure 43.

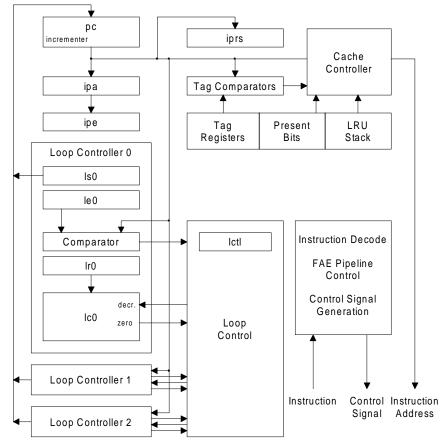


Figure 43. Program Flow Control Unit Block Diagram

The PP has a three-stage fetch, address, execute pipeline as shown in Figure 44. The pc, ipa, and ipe registers point to the address of the instruction in each stage of the pipeline. On each cycle in which the pipeline advances, ipa is copied into ipe, pc is copied into ipa, and the pc is incremented by one instruction (8 bytes).

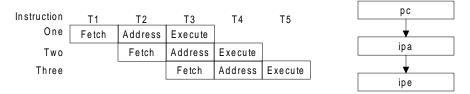


Figure 44. FAE Instruction Pipeline

PP address unit architecture

The PP has both a local and global address unit which operate independently of each other. The address units support twelve different addressing modes. In place of performing a memory access, either or both of the address units can perform an address computation that is written directly to a PP register instead of being used for a memory access. This address unit arithmetic provides additional arithmetic operation to supplement the data unit during compute-intensive algorithms.

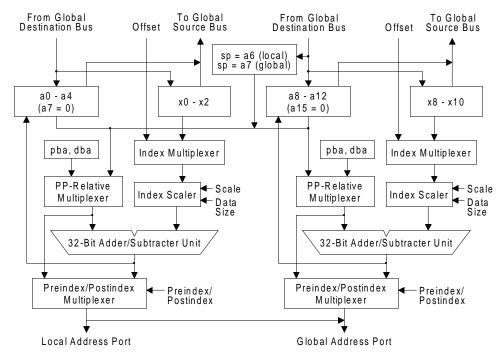


Figure 45. Address Unit Architecture

PP instruction set

PP instructions are represented by algebraic expressions for the operations performed in parallel by the multiplier, ALU, global address unit, and local address unit. The expressions use the || symbol to indicate operations that are to be performed in parallel. The PP ALU operator syntax is shown in Table 12. The data unit operations (multiplier and ALU) are summarized in Table 13 and the parallel transfers (global and local) are summarized in Table 14.

Table 12. PP Operators by Precedence

| OPERATOR | FUNCTION |
|-----------------|--|
| src1 [n] src1-1 | Select odd (n=true) or even (n=false) register of D register pair based on negative condition code |
| () | Subexpression delimiters |
| @mf | Expander operator |
| % | Mask generator |
| %% | Nonmultiple mask generator (EALU only) |
| %! | Modified mask generator (0xFFFFFFF output for 0 input) |
| %%! | Nonmultiple shift right mask generator (EALU only) |
| // | Rotate left |
| << | Shift left (pseudo-op for rotate and mask) |
| >>u | Unsigned shift right |
| >> or >>s | Signed shift right |
| & | Bitwise AND |
| ۸ | Bitwise XOR |
| 1 | Bitwise OR |
| + | Addition |
| - | Subtraction |
| =[cond] | Conditional assignment |
| =[cond.pro] | Conditional assignment with status protection |
| = | Equate |

PP instruction set (continued)

Table 13. Summary of Data Unit Operations

| Operation Description | Base set ALUs |
|--------------------------|--|
| | Perform an ALU operation specifying ALU function, 2 src and 1 dest operand, and operand routing. ALU function is one of |
| | 256 three-input Boolean operations or one of 16 arithmetic operations combined with one of 16 function modifiers |
| Syntax | dst = [fmod] [\{cond [.pro]\}] ALU_EXPRESSION |
| xamples | d6 = (d6 ^ d4) & d2 d3 = [nn.nv] d1 -1 |
| Operation | EALU ROTATE |
| Description | Perform an extended ALU (EALU) operation (specified in d0) with one of two data routings to the ALU and optionally write the barrel rotator output to a second dest register. ALU operation is one of 256 Boolean or 256 arithmetic. |
| Syntax | $ dst1 = [\{cond [.pro]\}] ealu (src2, [dst2 =] [\{cond\}] src1 \{n\} src1-1 \ src3, [\%] src4) $ |
| xamples | d7 = [nn] ealu(d2, d6 = [nn] d3\\d1, %d4) d3 = mzc ealu(mylabel: d4 + (d5\\d6 & %d7) d1 = d5\\d6) |
| Operation | MPY ADD |
| Description | Perform a 16x16 multiply with optional parallel add or subtract. Condition code applies to both multiply and add. |
| Syntax | |
| xample | $d7 = u d6 * d5 \parallel d5 = d4 - d1$ |
| Operation | MPY SADD |
| Description | Perform a 16x16 multiply with a parallel right-shift and add or subtract. Condition code applies to both multiply and shift and add. |
| Syntax | |
| xamples | $d7 = u d6 * d5 \parallel d5 = d4 - d1 >> -d0$ |
| Operation | MPY EALU |
| Description | Perform a multiply and an optional parallel EALU. Multiply can use rounding, scaling, or splitting features. |
| Syntax | Generic Form: dst2 = [sign] [\{cond \}] src3 * src4 dst = [\{cond [.pro] \}] ealu[f] (src2, src1 [\{n\} src1 -1] \\ d0, %d0) dst2 = [sign] [\{cond \}] src3 * src4 ealu() |
| | Explicit Form: dst2 = [sign] [opt] [\{cond\}] src3 * src4 [< <dms] (label:="" [="" [.pro]\}="" \{cond=""]="" dst1="[fmod]" ealu="" ealu_expression)<="" td="" =""></dms]> |
| | $dst2 = [sign] [opt] [\{cond\}] src3 * src4 [<$ |
| Examples | $d7 = [p] d5 * d3 d2 = [p] ealu(d1, d6\d0, %d0) ; generic form d2 = m d4 * d7 d3 = ealu (mylabel: d3 + d2 >> 9) ; explicit form$ |
| Operation | divi |
| Description | Perform one iteration of unsigned divide algorithm. Generates one quotient bit per execution using iterative subtraction. |
| Syntax | $dst1 = [\{cond [.pro]\}] divi (src2, dst2 = \{cond\} src1 [\{n\} src1-1])$ |
| Examples | d3 = divi (d1, d2 = d2) d3 = divi (d1, d2 = d3[n]d2) |
| Misc. Operations | dint; eint; dloop, eloop, qwait, nop |
| Description | Globally disable interrupts; globally enable interrupts; globally disable looping, globally enable looping; spin until comm Q bit is zero, on nothing in the data unit |
| | dint |
| Syntax | eint dloop eloop qwait nop |



fmod - function modifier

sign - u=unsigned, s=signed

PP instruction set (continued)

Table 14. Summary of Parallel Transfers

| Operation | Load |
|-------------|--|
| Description | Transfer from memory into PP register |
| Syntax | dst = [sign] [size] [{cond}] * addrexp |
| | dst = [sign] [size] [{cond}] * an.element |
| Examples | d3 = u h [n] * (a9++=[2]) |
| | d1 = * a2.sMY_ELEMENT |
| Operation | Store |
| Description | Transfer from PP register into memory |
| Syntax | * addrexp = [size] src [\langle n \rangle src-1] * an.element = [size] src [\langle n \rangle src-1] |
| Examples | *a2 = d3 *a9.sMY_ELEMENT = a3 |
| Operation | Address Unit Arithmetic |
| Description | Compute address and store in PP register. |
| Syntax | dst = [size] [\cond \chi] & * addrexp |
| -, | dst = [size] [{cond}] & * an.element |
| Examples | d2 = &*(a3 + x0) |
| | a1 = &*a9.sMY_ELEMENT |
| Operation | Move |
| Description | Transfer from PP register to PP register |
| Syntax | $dst = [g] [\{cond\}] src$ |
| Examples | x2 = mf |
| | d1 = g d3 |
| Operation | Field Extract Move |
| Description | Transfer from PP register to PP register extracting and right-aligning one byte or halfword |
| Syntax | dst = [sign] [size item] |
| Example | d3 = u b2 d1 |
| Operation | Field Replicate Move |
| Description | Transfer from PP register to PP register replicating the LSbyte or LShalfword to 32 bits. |
| Syntax | $dst = r [size] \{cond\} src$ |
| Example | d7 = rh d3 |

cond - condition code

g - use global unit

^{[] -} optional parameter extension {} - square brackets ([]) must be used sign - u=unsigned, s=signed

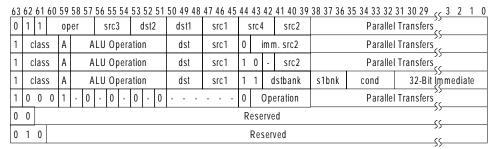
size - b=byte, h=halfword, w=word (default)

item - 0=byte0/halfword0, 1=byte1/halfword1, 2=byte2, 3=byte3

PP opcode formats

A PP instruction uses a 64-bit opcode. The opcode is essentially divided into a data unit portion and a parallel transfer portion. There are five data unit opcode formats comprising bits 39-63 of the opcode. Bits 0-38 of the opcode specify one of ten parallel transfer formats. An alphabetical list of the mnemonics used in Figure 46 for the data unit and parallel transfer portions of the opcode are shown in Table 15 and Table 16, respectively.

Data Unit Formats



- A. Six-Operand (MPY||ADD, etc.)
- B. Base Set ALU (5-Bit Immediate)
- C. Base Set ALU (Register src2)
- D. Base Set ALU (32-Bit Immediate)
- E. Miscellaneous

Transfer Formats

| 38 37 | 36 35 | 34 33 32 | 31 | 30 | 29 | 28 | 27 | 262 | 5 | 24 | 23 22 | 21 | 20 19 18 | 17 | 16 1 | 5 | 14 | 13 | 12 11 10 | 9 | 8 7 | 6 | 5 4 3 | 2 | 1 0 | |
|-------|-------|----------|----|------|----|-----|-----|-----|---|----|-------|----|----------|----|------|----|-----|----|----------|-----|--------|------|---------|---|------|-------------|
| Lm | ode | d | е | si | ze | S | | La | | G | im/X | L | 0bank | L | G | mc | ode | | reg | е | size | S | Ga | L | im/X | 1. Double |
| Lm | ode | d | е | si | ze | S | | La | | 0 | Lrm | d | Istbank | L | 0 (|) | 0 | 0 | src | S | rcban | k | dst | L | im/X | 2. Move |
| Lm | ode | d | е | si | ze | S | | La | | 0 | itm | d | Istbank | L | 0 (|) | 0 | 1 | src | е | size | D | dst | L | im/X | 3. Field M |
| Lm | ode | reg | е | si | ze | S | | La | | 1 | Lrm | | bank | L | 0 (|) | | | Lo | cal | Long | Offs | set / X | | | 4. Local (L |
| 0 0 | | Glo | ba | l Lo | ng | Off | set | / X | | | | | bank | L | G | mc | ode | | reg | е | size | s | Ga | 0 | Grm | 5. Global |
| Lm | ode | d | е | si | ze | s | | La | | 0 | Lrm | Α | dstbank | L | 0 (|) | 1 | - | | Α | s1ban | k | | L | im/X | 6. Non-D |
| 0 0 | - | cond | С | r | g | N | С | ۷ | Z | 0 | | d | Istbank | - | 0 (|) | 0 | 0 | src | S | rcbanl | k | dst | - | | 7. Conditio |
| 0 0 | - | cond | С | r | g | N | С | V | Z | 0 | itm | d | Istbank | - | 0 (|) | 0 | 1 | src | е | size | D | dst | - | | 8. Conditio |
| 0 0 | - | cond | С | r | g | N | С | V | Z | G | im/X | | bank | L | G | mc | ode | | reg | е | size | S | Ga | 1 | Grm | 9. Conditio |
| 0 0 | - | cond | С | r | - | N | С | ۷ | z | 0 | | Α | dstbank | - | 0 (|) | 1 | - | | A | s1ban | k | | | | 10. Conditi |

le Parallel

- || Local
- Move || Local
- (Long Offset)
- al (Long Offset)
- DU || Local
- tional DU || Conditional Mode
- tional DU || Conditional Field Move
- tional DU || Conditional Global
- itional Non-D DU

Figure 46. PP Opcode Formats

PP opcode formats (continued)

Table 15. Data Unit Mnemonics

| MNEMONIC | FUNCTION |
|------------------|--|
| Α | A = 1 selects arithmetic operations, A = 0 selects boolean operations |
| ALU Operation | For Boolean operation (A=0), select the eight ALU function signals. For Arithmetic operation (A=1), odd bits specify the ALU function and even bits define the ALU function modifiers. |
| class | Operation class, determines routing of ALU operands. |
| cond | condition code |
| dst | D register destination or lower three bits of non-D register code. |
| dst1 | ALU dest. for MPY ADD, MPY EALU, or EALU ROTATE operation. D register or lower three bits of non-D register code |
| dst2 | Multiply dest. for MPY ADD or MPY EALU operation or rotate dest. for EALU ROTATE operation. D register. |
| dstbank | ALU register bank. |
| imm.src2 | 5-bit immediate for src2 of ALU operation. |
| 32-Bit Immediate | 32-bit immediate for src2 of ALU operation. |
| oper | Six-operand data unit operation (MPY ADD, MPY SADD, MPY EALU, EALU ROTATE, divi) |
| Operation | Miscellaneous operation |
| src1 | ALU source 1 register code (D register unless srcbank or s1bank is used) |
| src2 | D register used as ALU source 2 |
| src3 | D register for multiplier source (MPY ADD or MPY EALU) or rotate amount (EALU ROTATE) |
| src4 | D register for ALU C port operand or EALU ROTATE mask generator input or multiplier source 2 for MPY ADD, MPY EALU |
| s1bank | Bits 5-3 of src1 register code (bit 6 assumed to be 0) |

PP opcode formats (continued)

Table 16. Parallel Transfer Mnemonics

| MNEMONIC | FUNCTION |
|----------|--|
| 0bank | Bits 5-3 of global transfer source/destination register code (bit 6 assumed to be 0) |
| Adstbnk | Bits 6-3 of ALU destination register code |
| As1bank | Bits 6-3 of ALU source 1 register code |
| bank | Bits 6-3 of global (or local) store source or load destination |
| С | Conditional choice of D register for src1 operand of the ALU |
| С | Protect status register's carry bit |
| cond | Condition code |
| d | D register or lower three bits of register code for local transfer source/destination |
| D | Duplicate least significant data during moves |
| dst | The three lower bits of the register code for move or field move destination |
| dstbank | Bits 6-3 of move destination register code |
| е | Sign extend local (bit 31), sign extend global (bit 9) |
| g | Conditional global transfer |
| Ga | Global address register for load, store, or address unit arithmetic |
| Gim / X | Global address unit immediate offset or index register |
| Gmode | Global unit addressing mode |
| Grm | Global PP-relative addressing mode |
| itm | Number of item selected for field extract move |
| L | L = 1 selects load operation, L = 0 selects store / address unit arithmetic operation |
| La | Local address register for load, store or address unit arithmetic |
| Lim / X | Local address unit immediate offset or index register |
| Lmode | Local unit addressing mode |
| Lrm | Local PP-relative addressing mode |
| N | Protect status register's negative bit |
| r | Conditional write of ALU result |
| reg | Register number used with bank or 0bank for global load, store or address unit arithmetic |
| S | Enable index scaling. Additional index bit for byte accesses or arithmetic operations (bit 28, local; bit 6, global) |
| size | Size of data transfer (bits 30-29, local; bits 8-7, global) |
| src | Three lower bits of register code for register-register move source or non-field moves. D register source for field move |
| srcbank | Bits 6-3 of register code for register-register move source |
| V | Protect status register's overflow bit [protects L (latched overflow) also] |
| Z | Protect status register's zero bit |
| - | Unused bit (fill with 0) |

PP opcode formats (continued)

Table 17 summarizes the supported parallel transfer formats, their formats, and whether the transfers are local or global. It also indicates the allowed ALU operations and whether conditions and status protection are supported.

Table 17. Parallel Transfer Format Summary

| | А | LU | | | G | lobal Tra | nsfer | | | Local Ti | ransfer | |
|----------------------|-------------------------------|-------|------|------------|-----------------------|-----------|-----------|-----|-----|----------|---------|--------|
| | Ope | rands | | Status | Move | Loa | d/Store/A | UA | | Load/Sto | re/AUA | |
| Format | dst1 | src1 | Cond | Protection | src → dst | s/d | Index | Rel | s/d | Index | Rel | Port |
| Double parallel | D | D | No | No | - | Lower | X/short | No | D | X/short | No | Local |
| Move Local | D | D | No | No | $Any \rightarrow Any$ | - | - | - | D | X/short | Yes | Local |
| Field move Local | D | D | No | No | $D \to Any$ | - | - | - | D | X/short | No | Local |
| Global (long offset) | D | D | No | No | - | Any | X/long | Yes | | - | - | - |
| Local (long offset) | D | D | No | No | - | - | - | - | Any | X/long | Yes | Global |
| Non-D DU Local | Any | Any | No | No | - | - | - | - | D | X/short | Yes | Global |
| Conditional move | D | D | Yes | Yes | $Any \rightarrow Any$ | - | - | - | | - | - | - |
| Cond. field move | D | D | Yes | Yes | $D\toAny$ | - | - | - | - | - | - | - |
| Cond. global | D | D | Yes | Yes | - | Any | X/short | Yes | - | - | - | - |
| Cond. non-D DU | Any | Any | Yes | Yes | - | - | - | - | - | - | - | - |
| 32-bit imm. base ALU | 2-bit imm. base ALU Any Lower | | Yes | No | | | | - | | | | |

DU - data unit

AUA - address unit arithmetic

s/d - source/destination register

Rel - relative addressing support

Table 18 shows the encoding used in the opcodes to specify particular PP registers. A 3-bit register field contains the three LSBs. The register codes are used for the src, src1, src2, src3, src4, dst, dst1, dst2, d, reg, Ga, La, Gim/X, and Lim/X opcode fields. The four MSBs specify the register bank which is concatenated to the register field for the full 7-bit code. The register bank codes are used for the dstbank, s1bnk, srcbank, 0bank, bank, Adstbnk, and As1bank opcode fields. When no associated bank is specified for a register field in the opcode, the D register bank is assumed. When the MSB of the bank code is not specified in the opcode (as in 0bank and s1bank) it is assumed to be 0, indicating a lower register.

PP opcode formats (continued)

Table 18. PP Register Codes

| | L | ower Registers | (MSB of I | Bank = (| 0) |
|------|------|----------------|-----------|----------|----------|
| Cod | ling | | Cod | ing | |
| Bank | Reg | Register | Bank | Reg | Register |
| 0000 | 000 | a0 | 0100 | 000 | d0 |
| 0000 | 001 | a1 | 0100 | 001 | d1 |
| 0000 | 010 | a2 | 0100 | 010 | d2 |
| 0000 | 011 | a3 | 0100 | 011 | d3 |
| 0000 | 100 | a4 | 0100 | 100 | d4 |
| 0000 | 101 | reserved | 0100 | 101 | d5 |
| 0000 | 110 | a6 (sp) | 0100 | 110 | d6 |
| 0000 | 111 | a7 (zero) | 0100 | 111 | d7 |
| 0001 | 000 | a8 | 0101 | 000 | reserved |
| 0001 | 001 | a9 | 0101 | 001 | sr |
| 0001 | 010 | a10 | 0101 | 010 | mf |
| 0001 | 011 | a11 | 0101 | 011 | reserved |
| 0001 | 100 | a12 | 0101 | 100 | reserved |
| 0001 | 101 | reserved | 0101 | 101 | reserved |
| 0001 | 110 | a14 (sp) | 0101 | 110 | reserved |
| 0001 | 111 | a15 (zero) | 0101 | 111 | reserved |
| 0010 | 000 | x0 | 0110 | 000 | reserved |
| 0010 | 001 | x1 | 0110 | 001 | reserved |
| 0010 | 010 | x2 | 0110 | 010 | reserved |
| 0010 | 011 | reserved | 0110 | 011 | reserved |
| 0010 | 100 | reserved | 0110 | 100 | reserved |
| 0010 | 101 | reserved | 0110 | 101 | reserved |
| 0010 | 110 | reserved | 0110 | 110 | reserved |
| 0010 | 111 | reserved | 0110 | 111 | reserved |
| 0011 | 000 | x8 | 0111 | 000 | pc/call |
| 0011 | 001 | x9 | 0111 | 001 | ipa/br |
| 0011 | 010 | x10 | 0111 | 010 | ipe # |
| 0011 | 011 | reserved | 0111 | 011 | iprs |
| 0011 | 100 | reserved | 0111 | 100 | inten |
| 0011 | 101 | reserved | 0111 | 101 | intflg |
| 0011 | 110 | reserved | 0111 | 110 | comm |
| 0011 | 111 | reserved | 0111 | 111 | lctl |

| Upper Registers (MSB of Bank = 1) | | | | | | | |
|-----------------------------------|-----|----------|------|-----|----------|--|--|
| Cod | ing | ing | | | | | |
| Bank | Reg | Register | Bank | Reg | Register | | |
| 1000 | 000 | reserved | 1100 | 000 | lc0 | | |
| 1000 | 001 | reserved | 1100 | 001 | lc1 | | |
| 1000 | 010 | reserved | 1100 | 010 | lc2 | | |
| 1000 | 011 | reserved | 1100 | 011 | reserved | | |
| 1000 | 100 | reserved | 1100 | 100 | lr0 | | |
| 1000 | 101 | reserved | 1100 | 101 | lr1 | | |
| 1000 | 110 | reserved | 1100 | 110 | lr2 | | |
| 1000 | 111 | reserved | 1100 | 111 | reserved | | |
| 1001 | 000 | reserved | 1101 | 000 | Irse0 | | |
| 1001 | 001 | reserved | 1101 | 001 | Irse1 | | |
| 1001 | 010 | reserved | 1101 | 010 | Irse2 | | |
| 1001 | 011 | reserved | 1101 | 011 | reserved | | |
| 1001 | 100 | reserved | 1101 | 100 | Irs0 | | |
| 1001 | 101 | reserved | 1101 | 101 | lrs1 | | |
| 1001 | 110 | reserved | 1101 | 110 | lrs2 | | |
| 1001 | 111 | reserved | 1101 | 111 | reserved | | |
| 1010 | 000 | reserved | 1110 | 000 | ls0 | | |
| 1010 | 001 | reserved | 1110 | 001 | ls1 | | |
| 1010 | 010 | reserved | 1110 | 010 | ls2 | | |
| 1010 | 011 | reserved | 1110 | 011 | reserved | | |
| 1010 | 100 | reserved | 1110 | 100 | le0 | | |
| 1010 | 101 | reserved | 1110 | 101 | le1 | | |
| 1010 | 110 | reserved | 1110 | 110 | le2 | | |
| 1010 | 111 | reserved | 1110 | 111 | reserved | | |
| 1011 | 000 | reserved | 1111 | 000 | reserved | | |
| 1011 | 001 | reserved | 1111 | 001 | reserved | | |
| 1011 | 010 | reserved | 1111 | 010 | reserved | | |
| 1011 | 011 | reserved | 1111 | 011 | reserved | | |
| 1011 | 100 | reserved | 1111 | 100 | tag0 # | | |
| 1011 | 101 | reserved | 1111 | 101 | tag1 # | | |
| 1011 | 110 | reserved | 1111 | 110 | tag2# | | |
| 1011 | 111 | reserved | 1111 | 111 | tag3# | | |

read only

data unit operation code

For data unit opcode Format A, a 4-bit operation code specifies one of sixteen six-operand operations and an associated data path. See Table 19 for six-operand operation codes.

Table 19. Six-Operand Format Operation Codes

| | ope | r Fie | ld Bit | | |
|---|-----|-------|--------|----|--|
| | 60 | 59 | 58 | 57 | Operation Type |
| | 0 | u | 0 | S | MPY ADD |
| | 0 | u | 1 | f | MPY EALU |
| | 1 | 0 | f | k | EALU ROTATE |
| | 1 | 0 | 1 | 0 | divi |
| | 1 | 1 | u | s | MPY SADD |
| • | | | | | 1's complement function code use mask or mf expander |

operation class code

The base set ALU opcodes (Formats B, C, D) use an operation class code to specify one of eight different routings to the A, B, and C ports of the ALU. See Table 20.

Table 20. Base Set ALU Class Summary

| Class | Destination | A Port | B P | ort | C Port |
|-------|-------------|--------|------|---------|--------|
| 0 0 0 | dst | src2 | src1 | | @mf |
| 0 0 1 | dst | dstc | src1 | \\ d0 | src2 |
| 0 1 0 | dst | dstc | src1 | | %src2 |
| 0 1 1 | dst | dstc | src1 | \\ src2 | %src2 |
| 1 0 0 | dst | src2 | src1 | // d0 | %d0 |
| 1 0 1 | dst | src2 | src1 | \\ d0 | @mf |
| 1 1 0 | dst | dstc | src1 | | src2 |
| 1 1 1 | dst | src1 | 1 | \\ src2 | src2 |

\\ - rotate left % - Mask generation @mf - expand function dstc - companion D reg.

ALU operation code

For base set ALU Boolean opcodes (A=0), the ALU function is formed by a sum of Boolean products selected by the ALU Operation opcode bits as shown in Table 21. For base set arithmetic opcodes (A=1), the four odd ALU Operation bits specify an arithmetic operation as described in Table 22, while the four even bits specify one of the ALU function modifiers as shown in Table 23.

ALU operation code (continued)

Table 21. Base Set ALU Boolean Function Codes

| OPCODE BIT | PRODUCT TERM |
|------------|--------------|
| 58 | A & B & C |
| 57 | ~A & B & C |
| 56 | A & ~B & C |
| 55 | ~A & ~B & C |
| 54 | A & B & ~C |
| 53 | ~A & B & ~C |
| 52 | A & ~B & ~C |
| 51 | ~A & ~B & ~C |

Table 22. Base Set Arithmetics

| OF | OPCODE BITS CARRY IN | | _ | ALGEBRAIC DESCRIPTION | NATURAL FUNCTION | MODIFIED FUNCTION (IF DIFFERENT FROM NATURAL | |
|----|----------------------|----|----|-----------------------|---------------------------|--|------------------------------------|
| 57 | 55 | 53 | 51 | | | | FUNCTION) |
| 0 | 0 | 0 | 0 | х | | | |
| 0 | 0 | 0 | 1 | 1 | A - (B C) | A - B <1< | |
| 0 | 0 | 1 | 0 | 0 | A + (B & ~C) | A + B <0< | |
| 0 | 0 | 1 | 1 | 1 | A-C | A - C | |
| 0 | 1 | 0 | 0 | 1 | A - (B ~C) | A - B >1> | (A - (B & C)) if sign=0 |
| 0 | 1 | 0 | 1 | 1 | A - B | A - B | |
| 0 | 1 | 1 | 0 | C(n) | A - (B & @mf -B & ~@mf) | A + B / A - B | if class 0 or 5 |
| | | | | 1/0 | A + B | A + B / A - B | if class 1-4 or 6-7, A-B if sign=1 |
| 0 | 1 | 1 | 1 | 1 | A - (B & C) | A - B>0> | |
| 1 | 0 | 0 | 0 | 0 | A + (B & C) | A + B>0> | |
| 1 | 0 | 0 | 1 | ~C(n) | A + (B & @mf -B & ~@mf) | A - B / A + B | if class 0 or 5 |
| | | | | 0/1 | A - B | A - B / A + B | if class 1-4 or 6-7, A+B if sign=1 |
| 1 | 0 | 1 | 0 | 0 | A + B | A + B | |
| 1 | 0 | 1 | 1 | 0 | A + (B ~C) | A + B >1> | (A + (B & C)) if sign=0 |
| 1 | 1 | 0 | 0 | 0 | A + C | A + C | |
| 1 | 1 | 0 | 1 | 1 | A - (B & ~C) | A - B <0< | |
| 1 | 1 | 1 | 0 | 0 | A + (B C) | A + B <1< | |
| 1 | 1 | 1 | 1 | 0 | (A & C) + (B & C) | field A + B | |

C(n) - LSB of each part of C port register

<0< - zero-extend shift left</p>
<1< - one-extend shift left</p>

>0> - zero-extend shift right

>1> - one-extend shift right

ALU operation code (continued)

Table 23. Function Modifier Codes

| FUNCTION MODIFIER BITS | | | | MODIFICATION PERFORMED |
|---------------------------|----|----|----|---|
| 58 | 56 | 54 | 52 | |
| 0 | 0 | 0 | 0 | Normal operation |
| 0 | 0 | 0 | 1 | cin |
| 0 | 0 | 1 | 0 | %! if maskgen instruction, Imo if not maskgen |
| 0 | 0 | 1 | 1 | %! and cin if maskgen instruction, rmo if not maskgen |
| 0 | 1 | 0 | 0 | A port = 0 |
| 0 | 1 | 0 | 1 | A port = 0 and cin |
| 0 | 1 | 1 | 0 | A port = 0 and %! if maskgen, Imbc if not maskgen |
| 0 | 1 | 1 | 1 | A port = 0, %! and cin if maskgen, rmbc if not maskgen |
| 1 | 0 | 0 | 0 | mf bit(s) set by carry out(s). (mc) |
| 1 | 0 | 0 | 1 | mf bit(s) set based on status register MSS field. (me) |
| 1 | 0 | 1 | 0 | Rotate mf by Asize, mf bit(s) set by carry out(s). (mrc) |
| 1 | 0 | 1 | 1 | Rotate mf by Asize, mf bit(s) set based on status register MSS field. (mre) |
| 1 | 1 | 0 | 0 | Clear mf, mf bit(s) set by carry out(s). (mzc) |
| 1 | 1 | 0 | 1 | Clear mf, mf bit(s) set based on status register MSS field. (mze) |
| 1 | 1 | 1 | 0 | No setting of bits in mf register. (mx) |
| 1 | 1 | 1 | 1 | Reserved |

cin - carry in

%! - modified mask generator

Imo - leftmost one rmo - rightmost one Imbc - leftmost bit change rmbc - rightmost bit change

miscellaneous operation code

For data unit opcode Format E, the Operation field selects one of the miscellaneous operations.

Table 24. Miscellaneous Operation Codes

| | OPCODE BITS | | | 1 | MNEMONIC | OPERATION |
|----|-------------|----|----|----|----------|--|
| 43 | 42 | 41 | 40 | 39 | | |
| 0 | 0 | 0 | 0 | 0 | nop | No data unit operation. Status not modified. |
| 0 | 0 | 0 | 0 | 1 | qwait | Wait until comm Q bit is clear |
| 0 | 0 | 0 | 1 | 0 | eint | Global interrupt enable |
| 0 | 0 | 0 | 1 | 1 | dint | Global interrupt disable |
| 0 | 0 | 1 | 0 | 0 | eloop | Global loop enable |
| 0 | 0 | 1 | 0 | 1 | dloop | Global loop disable |
| 0 | 0 | 1 | 1 | х | reserved | |
| 0 | 1 | х | х | х | reserved | |
| 1 | х | х | х | х | reserved | |

addressing mode codes

The Lmode (bits 35-38) and Gmode (bits 13-16) of the opcode specify the local and global transfer for various parallel transfer opcode formats (Lmode in formats 1,2,3,4, and 6 and Gmode in formats 1,5, and 9). The coding for the addressing mode fields is shown in Table 25.

Table 25. Addressing Mode Codes

| CODING | EXPRESSION | DESCRIPTION |
|--------|---------------|--|
| 00xx | | Nop (nonaddressing mode operation) |
| 0100 | *(an ++= xm) | Postaddition of index register, with modify |
| 0101 | *(an= xm) | Postsubtraction of index register, with modify |
| 0110 | *(an ++= imm) | Postaddition of immediate, with modify |
| 0111 | *(an= imm) | Postsubtraction of immediate, with modify |
| 1000 | *(an + xm) | Preaddition of index register |
| 1001 | *(an - xm) | Presubtraction of index register |
| 1010 | *(an + imm) | Preaddition of immediate |
| 1011 | *(an - imm) | Presubtraction of immediate |
| 1100 | *(an += xm) | Preaddition of index register, with modify |
| 1101 | *(an -= xm) | Presubtraction of index register, with modify |
| 1110 | *(an += imm) | Preaddition of immediate, with modify |
| 1111 | *(an -= imm) | Presubtraction of immediate, with modify |

an - address register in I/g address unit xm - index register in same unit as an register

imm - immediate offset

L, e codes

The L and e bits combine to specify the type of parallel transfer performed. For the local transfer, L and e are bits 21 and 31, respectively. For the global transfer, L and e are bits 17 and 9, respectively.

Table 26. Parallel Transfer Type

| L | е | PARALLEL TRANSFER |
|---|---|-------------------------|
| 1 | 0 | Zero-extend load |
| 1 | 1 | Sign-extend load |
| 0 | 0 | Store |
| 0 | 1 | Address unit arithmetic |

size codes

The size code specifies the data transfer size. For field moves (parallel transfer Format 3), only byte and halfword data sizes are valid. See Table 27.

Table 27. Transfer Data Size

| CODING | DATA SIZE |
|--------|--------------------|
| 00 | Byte (8 bits) |
| 01 | Halfword (16 bits) |
| 10 | Word (32 bits) |
| 11 | Reserved |

relative addressing mode codes

The Lrm and Grm opcode fields allow the local address or global address units, respectively to select PP-relative addressing as shown in Table 28.

Table 28. Relative Addressing Mode Codes

| CODING | RELATIVE ADDRESSING MODE | | |
|--------|------------------------------|--|--|
| 00 | Normal (absolute addressing) | | |
| 01 | Reserved | | |
| 10 | PP-relative dba | | |
| 11 | PP-relative pba | | |

dba - Data RAM 0 base is base address pba - Parameter RAM base is base address

condition codes

In the four conditional parallel transfer opcodes (Formats 7-10), this field specifies one of sixteen condition codes to be applied to the data unit operation source, data unit result, or global transfer based on the setting of the c, r, and g bits, respectively. The condition codes are shown in Table 29. For the 32-bit immediate data unit opcode (Format D), the condition applies to the data unit result only.

Table 29. Condition Codes

| СО | CONDITION BITS | | MNEMONIC | DESCRIPTION | STATUS BIT COMBINATION | |
|----|----------------|----|----------|-------------|----------------------------|-------------------------------|
| 35 | 34 | 33 | 32 | | | |
| 0 | 0 | 0 | 0 | u | Unconditional (default) | None |
| 0 | 0 | 0 | 1 | р | Positive | ~N & ~Z |
| 0 | 0 | 1 | 0 | Is | Lower than or same | ~C Z |
| 0 | 0 | 1 | 1 | hi | Higher than | C & ~Z |
| 0 | 1 | 0 | 0 | lt | Less than | (N & ~V) (~N & V) |
| 0 | 1 | 0 | 1 | le | Less than or equal | (N & ~V) (~N & V) Z |
| 0 | 1 | 1 | 0 | ge | Greater than or equal | (N & V) (~N & ~V) |
| 0 | 1 | 1 | 1 | gt | Greater than | (N & V & ~Z) (~N & ~V & ~Z) |
| 1 | 0 | 0 | 0 | hs, c | Higher than or same, carry | c |
| 1 | 0 | 0 | 1 | lo, nc | Lower than, no carry | ~C |
| 1 | 0 | 1 | 0 | eq, z | Equal, zero | z |
| 1 | 0 | 1 | 1 | ne, nz | Not equal, not zero | ~Z |
| 1 | 1 | 0 | 0 | V | Overflow | V |
| 1 | 1 | 0 | 1 | nv | No overflow | ~V |
| 1 | 1 | 1 | 0 | n | Negative | N |
| 1 | 1 | 1 | 1 | nn | Nonnegative | ~N |

EALU operations

Extended ALU (EALU) operations allow the execution of more advanced ALU functions than those specified in the base set ALU opcodes. The opcode for EALU instructions contains the operands for the operation while the d0 register extends the opcode by specifying the EALU operation to be performed. The format of d0 for EALU operations is shown in Figure 24.

EALU Boolean functions

EALU operations support all 256 Boolean ALU functions plus the flexibility to add 1 or a carry-in to Boolean sum. The Boolean function performed by the ALU is:

(F0 & (~A & ~B & ~C)) | F1 & (A & ~B & ~C) | F2 & (~A & B & ~C) | F3 & (A & B & ~C) | F4 & (~A & ~B & C) | F5 & (A & ~B & C) | F6 & (~A & B & C) | F7 & (A & B & C)) [+1 | +cin]

| d0 BIT | ALU FUNCTION | PRODUCT TERM |
|--------|--------------|--------------|
| | SIGNAL | |
| 26 | F7 | A&B&C |
| 25 | F6 | ~A & B & C |
| 24 | F5 | A & ~B & C |
| 23 | F4 | ~A & ~B & C |
| 22 | F3 | A & B & ~C |
| 21 | F2 | ~A & B & ~C |
| 20 | F1 | A & ~B & ~C |
| 19 | F0 | ~A & ~B & ~C |

Table 30. EALU Boolean Function Codes

EALU arithmetic functions

EALU operations support all 256 arithmetic functions provided by the three-input ALU plus the flexibility to add 1 or a carry-in to the result. The arithmetic function performed by the ALU is:

$$f(A,B,C) = A & f1(B,C) + f2(B,C) [+1 | cin]$$

f1(B,C) and f2(B,C) are independent Boolean combinations of the B and C ALU inputs. The ALU function is specified by selecting the desired f1 and f2 subfunction and then XORing the f1 and f2 code from Table 31 to create the ALU function code for bits 19-26 of d0. Additional operations such as absolute values and signed shifts can be performed using d0 bits which control the ALU function based on the sign of one of the inputs.

EALU arithmetic functions (continued)

Table 31. ALU f1(B,C) and f2(B,C) Subfunctions

| f1 | f2 | SUBFUNCTION | COMMON USAGE |
|------|------|---------------------------|---|
| CODE | CODE | | |
| 00 | 00 | 0 | Zero the term |
| AA | FF | -1 | -1 (All 1s) |
| 88 | CC | В | В |
| 22 | 33 | -B -1 | Negate B |
| A0 | F0 | С | С |
| 0A | 0F | -C -1 | Negate C |
| 80 | C0 | B & C | Force bits in B to 0 where bits in C are 0 |
| 2A | 3F | -(B & C) - 1 | Force bits in B to 0 where bits in C are 0 and negate |
| A8 | FC | B C | Force bits in B to 1 where bits in C are 1 |
| 02 | 03 | -(B C) - 1 | Force bits in B to 1 where bits in C are 1 and negate |
| 08 | 0C | B & ~C | Force bits in B to 0 where bits in C are 1 |
| A2 | F3 | -(B & ~C) -1 | Force bits in B to 0 where bits in C are 1 and negate |
| 8A | CF | B ~C | Force bits in B to 1 where bits in C are 0 |
| 20 | 30 | -(B ~C) -1 | Force bits in B to 1 where bits in C are 0 and negate |
| 28 | 3C | (B & ~C) ((-B - 1) & C) | Choose B if C = all 0s and -B if C = all 1s |
| 82 | C3 | (B & C) ((-B - 1) & ~C) | Choose B if C = all 1s and -B if C = all 0s |

transfer controller architecture

The transfer controller (TC) is a combined memory controller and DMA (direct memory access) machine. It handles the movement of data within the 'C82 system as requested by the master processor, parallel processors, and external devices. The transfer controller performs the following data movement and memory control functions:

- MP and PP instruction cache fills
- MP data cache fills and dirty block write-back
- MP and PP direct external accesses (DEAs)
- MP and PP packet transfers
- Externally initiated packet transfers (XPTs)
- Shift register transfer (SRT) packet transfers for updating VRAM-based frame buffers
- DRAM/SDRAM refresh
- Host bus request

TC functional block diagram

A functional block diagram of the transfer controller is shown in Figure 47. Key features of the TC include:

- · Crossbar Interface
 - 64-bit data path
 - Single-cycle access
- · External Memory Interface
 - 4 GByte address range

TC functional block diagram (continued)

 Internal memory configuration-cache stores up to six sets of bank information. Features programmable:

bus size: 8, 16, 32, or 64 bits

page size

bank size

address multiplexing

cycle timing

block-write mode

bank priority

- Big or little endian operation
- Cache, VRAM, refresh controller
 - Programmable refresh rate
 - VRAM block write support
- Independent Src and Dst addressing
 - Autonomous addressing based on packet transfer parameters
 - Data read and write at different rates
 - Numerous data merging and alignment functions performed during transfer
- Intelligent request prioritization

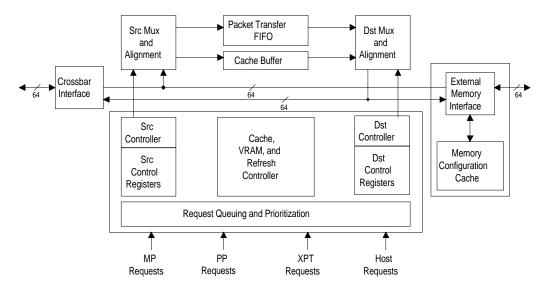


Figure 47. TC Block Diagram

transfer controller registers

The TC contains four on-chip memory-mapped registers accessible by the MP.

REFCNTL register (0x01820000)

The REFCNTL register controls refresh cycles.

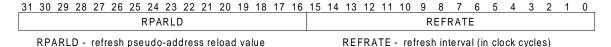


Figure 48. REFCNTL Register



PTMIN register (0x01820004)

The PTMIN register determines the minimum number of cycles that a packet transfer will execute before being suspended by a higher-priority packet transfer. Short-form XPTs may interrupt long-form PTs without suspending them.

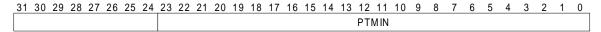


Figure 49. PTMIN Register

PTMAX register (0x01820008)

The PTMAX register determines the maximum number of cycles after PTMIN has elapsed that a packet transfer will execute before timing out.



Figure 50. PTMAX Register

FLTSTS register (0x0182000C)

The FLTSTS register indicates the cause of a memory-access fault. Fault status bits are cleared by writing a 1 to the appropriate bit.

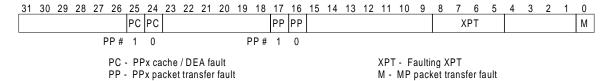
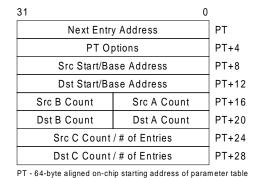
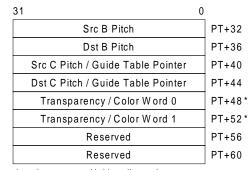


Figure 51. FLTSTS Register

packet transfer parameters

The most efficient method for data movement in a TMS320C82 system is through the use of packet transfers (PTs). Packet transfers allow the TC to autonomously move blocks of data between a specified src and dst memory region. Requests for the TC to execute a packet transfer may be made by the MP, PPs, or external devices. A packet transfer parameter table describing the data packet and how it is to be transferred must be programmed in on-chip memory before the transfer is requested. The TC on the TMS320C82 supports short- and long-form packet transfers. The PT parameter tables for both formats are shown in Figure 52 and Figure 53.



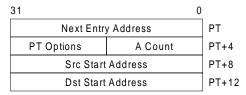


* words are swapped in big endian mode

Figure 52. Packet Transfer Parameter Table - Long Form



packet transfer parameters (continued)



PT - 16-byte aligned on-chip starting address of parameter table

Figure 53. Packet Transfer Parameter Table - Short Form

PT options field

The PT Options field of the parameter table controls the type of Src and Dst transfer that the TC performs. The format of the options field is shown in Figure 54.

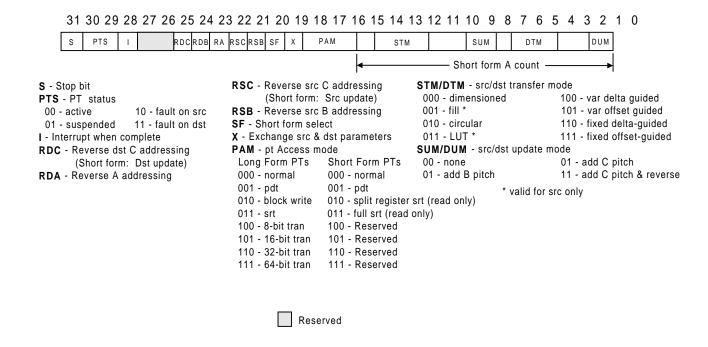


Figure 54. PT Options Field

LOCAL MEMORY INTERFACE

status codes

The TMS320C82 outputs status information on two busses which describe the type of cycle being performed. During row time, status codes are output on AD[39:32] and STATUS[1:0]. The cycle type may be latched using /RL and used by external logic to perform memory bank decoding or enable special hardware features. The STATUS[1:0] pins indicate idle cycles and ending XPT accesses.

Table 32. Row Time Status Codes (AD[39:32])

| Α | D[3 | 9:3 | 6] | SOURCE | 4 | D[3 | 5:32 | 2] | ACTIVITY |
|---|-----|-----|----|--------|---|-----|------|----|---------------------|
| 0 | 0 | 0 | 0 | 'C82 | 0 | 0 | 0 | 0 | Read |
| 0 | 0 | 0 | 1 | XPT1 | 0 | 0 | 0 | 1 | Write |
| 0 | 0 | 1 | 0 | XPT2 | 0 | 0 | 1 | 0 | PDT Read |
| 0 | 0 | 1 | 1 | XPT3 | 0 | 0 | 1 | 1 | PDT Write |
| 0 | 1 | 0 | 0 | XPT4 | 0 | 1 | 0 | 0 | PT Full SRT Read |
| 0 | 1 | 0 | 1 | XPT5 | 0 | 1 | 0 | 1 | Reserved |
| 0 | 1 | 1 | 0 | XPT6 | 0 | 1 | 1 | 0 | PT Split SRT Read |
| 0 | 1 | 1 | 1 | XPT7 | 0 | 1 | 1 | 1 | Reserved |
| 1 | 0 | 0 | 0 | XPT8 | 1 | 0 | 0 | 0 | SDRAM MRS |
| 1 | 0 | 0 | 1 | XPT9 | 1 | 0 | 0 | 1 | Block Write |
| 1 | 0 | 1 | 0 | XPTa | 1 | 0 | 1 | 0 | Reserved |
| 1 | 0 | 1 | 1 | XPTb | 1 | 0 | 1 | 1 | Load Color Register |
| 1 | 1 | 0 | 0 | XPTc | 1 | 1 | 0 | 0 | Refresh |
| 1 | 1 | 0 | 1 | XPTd | 1 | 1 | 0 | 1 | SDRAM DCAB |
| 1 | 1 | 1 | 0 | XPTe | 1 | 1 | 1 | 0 | Bank Configuration |
| 1 | 1 | 1 | 1 | XPTf | 1 | 1 | 1 | 1 | Idle |

Table 33. Memory Cycle Status

| STATU | JS[1:0] | ACTIVITY |
|-------|---------|-----------------|
| 0 | 0 | Idle/DCAB/Drain |
| 0 | 1 | Row access |
| 1 | 0 | XPT end |
| 1 | 1 | Column access |

memory bank configuration

Before an access can begin, the 'C82 must know certain information about the memory bank it is addressing. Information about the bus size, address shifting, memory speed, and bank size is read in during a special configuration cycle and stored in an on-chip memory configuration cache. The 'C82 memory configuration cache holds up to six entries, which are maintained with a multi-priority level least recently used algorithm. The memory configuration cache is only accessible by the TC; software may not modify the contents of the cache. The bank configuration fields are read in over the AD bus in four consecutive byte-wide reads, and have the format shown in Figure 55.

| R C A[| 1:0] | 7 | D[| | - | | - | 3:5 1 | - | FUNCTION GROUP |
|--------|------|------|---------|------|---|--|-----|----------|----|-----------------|
| 0 | 0 | Е | Т | 0 | - | | (| т | | cycle timing |
| 0 | 1 | | PS B AS | | | | | | | address control |
| 1 | 0 | R | - | - BW | | | S | Е | 38 | bus size |
| 1 | 1 | - PL | | | | | M S | 3 | | bank properties |

Figure 55. Bank Configuration Cycle Fields

memory exceptions

Retry and fault conditions are encoded on the /EXCEPT[1:0] pins on the 'C82. Additionally, a configuration cache flush may be requested over these pins. The /EXCEPT[1:0] codes are shown in Table 34.

Table 34. Memory Exception Codes

| /EXCE | PT[1:0] | MEMORY EXCEPTION |
|-------|---------|---------------------------|
| 0 | 0 | Configuration cache flush |
| 0 | 1 | Fault |
| 1 | 0 | Retry or page request |
| 1 | 1 | None |

Support for exceptions is not mandatory. Exception support may be enabled or disabled on a bank-by-bank basis. During the bank configuration cycle, if the E bit is set to one, exception support will be enabled for that particular bank. When E is set to 0, except codes of 00 and 01 are ignored during accesses to that bank. Page requests are not sensitive to the E bit.

read turn around

Data is driven by, and read into, the 'C82 over the AD[63:0] bus. Additionally, at row time address and status information is output over this bus. Because of this, the potential exists for a drive conflict, particularly when reading from slow devices such as EPROMs. To compensate for this, extra cycles may be added to the end of read bursts to allow memories and drivers to turn off. Similarly, PDT write cycles contain the minimum number of turnoff cycles as their PDT read cycle counterparts. The number of turnoff cycles is controlled by the TO field in the bank configuration cache entry. The TO encodings are shown in Table 35.

Table 35. TO (Turnoff) Cycle Encoding

| TO(| (1:0) | EXTRA TURNOFF CYCLES |
|-----|-------|----------------------|
| 0 | 0 | None |
| 0 | 1 | 1 |
| 1 | 0 | 2 |
| 1 | 1 | 3 |



cycle time selection

The 'C82 supports fourteen sets of memory timings to interface with various memory types. The cycle timing is selected by the value input in the CT(3:0) field during a bank configuration cycle. The selected timing remains in effect for all accesses made to that bank while its configuration is in cache.

Table 36. Cycle Timing Selection

| | CT(| 3:0) | | CYCLE TIMING |
|---|-----|------|---|--------------------------------------|
| 0 | 0 | 0 | 0 | DRAM: pipelined 1 cycle/column EDO |
| 0 | 0 | 0 | 1 | DRAM: unpipelined 1 cycle/column EDO |
| 0 | 0 | 1 | 0 | DRAM: unpipelined 2 cycle/column EDO |
| 0 | 0 | 1 | 1 | DRAM: unpipelined 3 cycle/column EDO |
| 0 | 1 | 0 | 0 | SRAM: synchronous 1 cycle/column |
| 0 | 1 | 0 | 1 | SRAM: asynchronous 1 cycle/column |
| 0 | 1 | 1 | 0 | SRAM: asynchronous 2 cycle/column |
| 0 | 1 | 1 | 1 | SRAM: asynchronous 3 cycle/column |
| 1 | 0 | 0 | 0 | SDRAM: burst length 1; CAS latency 2 |
| 1 | 0 | 0 | 1 | SDRAM: burst length 1; CAS latency 3 |
| 1 | 0 | 1 | 0 | SDRAM: burst length 1; CAS latency 4 |
| 1 | 0 | 1 | 1 | Reserved |
| 1 | 1 | 0 | 0 | SDRAM: burst length 2; CAS latency 2 |
| 1 | 1 | 0 | 1 | SDRAM: burst length 2; CAS latency 3 |
| 1 | 1 | 1 | 0 | SDRAM: burst length 2; CAS latency 4 |
| 1 | 1 | 1 | 1 | Reserved |

page sizing

Whenever the 'C82 performs an external access, it must track the current page boundary of the addressed bank. When a page boundary is crossed, a new row access must be performed. This is accomplished by comparing certain bits of the logical address bus. Because the location of the logical address on the RCA[16:0] bus is dependent on bus size (controlled by BS(1:0)), page size is also affected by the BS(1:0) inputs. Table 37 outlines the effective page sizes as a function of PS(3:0) and BS(1:0).

Table 37. Page Size

| | PS(| 3:0) | | BS(| 1:0) | LOGICAL ADDRESS BITS COMPARED | PAGE SIZE |
|---|-----|------|---|-----|------|--|-----------|
| 0 | 0 | 0 | 0 | 0 | 0 | None | 1 byte |
| | | | | 0 | 1 | None | 2 bytes |
| | | | | 1 | 0 | None | 4 bytes |
| | | | | 1 | 1 | None | 8 bytes |
| 0 | 0 | 0 | 1 | 0 | 0 | 31:3 | 8 bytes |
| | | | | 0 | 1 | 31:4 | 16 bytes |
| | | | | 1 | 0 | 31:5 | 32 bytes |
| | | | | 1 | 1 | 31:6 | 64 bytes |
| 0 | 0 | 1 | 0 | 0 | 0 | 31:4 | 16 bytes |
| | | | | 0 | 1 | 31:5 | 32 bytes |
| | | | | 1 | 0 | 31:6 | 64 bytes |
| | | | | 1 | 1 | 31:7 | 128 bytes |
| 0 | 0 | 1 | 1 | 0 | 0 | 31:5 | 32 bytes |
| | | | | 0 | 1 | 31:6 | 64 bytes |
| | | | | 1 | 0 | 31:7 | 128 bytes |
| | | | | 1 | 1 | 31:8 | 256 bytes |
| 0 | 1 | 0 | 0 | 0 | 0 | 31:6 | 64 bytes |
| | | | | 0 | 1 | 31:7 | 128 bytes |
| | | | | 1 | 0 | 31:8 | 256 bytes |
| | | | | 1 | 1 | 31:9 | 512 bytes |
| 0 | 1 | 0 | 1 | 0 | 0 | 31:7 | 128 bytes |
| | | | | 0 | 1 | 31:8 | 256 bytes |
| | | | | 1 | 0 | 31:9 | 512 bytes |
| | | | | 1 | 1 | 31:10 | 1K byte |
| 0 | 1 | 1 | 0 | 0 | 0 | 31:8 | 256 bytes |
| | | | | 0 | 1 | 31:9 | 512 bytes |
| | | | | 1 | 0 | 31:10 | 1K byte |
| | | | | 1 | 1 | 31:11 | 2K bytes |
| 0 | 1 | 1 | 1 | 0 | 0 | 31:9 | 512 bytes |
| | | | | 0 | 1 | 31:10 | 1K byte |
| | | | | 1 | 0 | 31:11 | 2K bytes |
| | | | | 1 | 1 | 31:12 | 4K bytes |

| | PS(| 3:0) | | BS(| (1:0) | LOGICAL ADDRESS BITS COMPARED | PAGE SIZE |
|---|-----|------|---|-----|-------|--|------------|
| 1 | 0 | 0 | 0 | 0 | 0 | 31:10 | 1K byte |
| | | | | 0 | 1 | 31:11 | 2K bytes |
| | | | | 1 | 0 | 31:12 | 4K bytes |
| | | | | 1 | 1 | 31:13 | 8K bytes |
| 1 | 0 | 0 | 1 | 0 | 0 | 31:11 | 2K bytes |
| | | | | 0 | 1 | 31:12 | 4K bytes |
| | | | | 1 | 0 | 31:13 | 8K bytes |
| | | | | 1 | 1 | 31:14 | 16K bytes |
| 1 | 0 | 1 | 0 | 0 | 0 | 31:12 | 4K bytes |
| | | | | 0 | 1 | 31:13 | 8K bytes |
| | | | | 1 | 0 | 31:14 | 16K bytes |
| | | | | 1 | 1 | 31:15 | 32K bytes |
| 1 | 0 | 1 | 1 | 0 | 0 | 31:13 | 8K bytes |
| | | | | 0 | 1 | 31:14 | 16K bytes |
| | | | | 1 | 0 | 31:15 | 32K bytes |
| | | | | 1 | 1 | 31:16 | 64K bytes |
| 1 | 1 | 0 | 0 | 0 | 0 | 31:14 | 16K bytes |
| | | | | 0 | 1 | 31:15 | 32K bytes |
| | | | | 1 | 0 | 31:16 | 64K bytes |
| | | | | 1 | 1 | 31:17 | 128K bytes |
| 1 | 1 | 0 | 1 | 0 | 0 | 31:15 | 32K bytes |
| | | | | 0 | 1 | 31:16 | 64K bytes |
| | | | | 1 | 0 | 31:17 | 128K bytes |
| | | | | 1 | 1 | 31:18 | 256K bytes |
| 1 | 1 | 1 | 0 | 0 | 0 | 31:16 | 64K bytes |
| | | | | 0 | 1 | 31:17 | 128K bytes |
| | | | | 1 | 0 | 31:18 | 256K bytes |
| | | | | 1 | 1 | 31:19 | 512K bytes |
| 1 | 1 | 1 | 1 | 0 | 0 | 31:17 | 128K bytes |
| | | | | 0 | 1 | 31:18 | 256K bytes |
| | | | | 1 | 0 | 31:19 | 512K bytes |
| | | | | 1 | 1 | 31:20 | 1M byte |

address multiplexing

In order to support various RAM devices, the TMS320C82 provides multiplexed row and column addresses on the RCA bus. A full 32-bit address is always output on AD[31:0] at row time. This value can be latched with /RL to provide bank-decoding. The actual address lines to memory should be connected to the RCA bus.

In order to support a wide variety of memory types, the logical address output on RCA is a function of both bus size and address shift. The row-column address multiplexing on the RCA bus is shown in Table 39. Memories and peripherals should be physically connected to RCA[N:0], where N is the number of address pins on the device. As the logical address bits output on the RCA bus is a function of both address shift and bus size, this connection is valid regardless of the memory architecture.

When performing peripheral device packet transfers, the lower bits (logical address bits 0, 1, and 2) may be lost depending on the configuration of the memory bank. To compensate for this, the B bit may be set for memory banks which must support PDTs. When set, the TC will place the missing lower address bits on the upper bits of the RCA bus during PDT accesses. External logic may decode these bits to access the byte information. The bit replacement functionality is shown in Table 38. Note that the row address output on RCA[16:0] is unaffected.

Table 38. PDT Address Bit Replacement (B=1)

| BUS | | | LOG | ICAL A | ADDRI | ESS B | ITS O | UTPU | T ON I | RCA[1 | 6:0] D | URIN | G COL | .UMN | TIME | | |
|---------|----|----|-----|--------|-------|-------|-------|------|--------|-------|--------|------|-------|------|------|---|---|
| WIDTH | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 1 byte | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 2 bytes | 0 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| 4 bytes | 1 | 0 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 |
| 8 bytes | 2 | 1 | 0 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 |

address multiplexing (continued)

Table 39. RCA Address Multiplexing (B = 0)

| Cycle | AS | S[2:0] | | BS | [1:0] | | | | | | Log | ical ad | dress b | its out | out on F | RCA (1 | 6:0) | | | | | |
|------------|----------|--------|---|----|-------|----------|----------|----------|----------|----------|----------|----------|----------|----------|----------|----------------|---------------|----------------|----------------|----------------|---------|---------|
| -, | | .[] | | | [] | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Row Col | 1 | 1 | 1 | 1 | 1 | x 19 | x 18 | 31 17 | 30 16 | 29 15 | 28 14 | 27 13 | 26 12 | 25 11 | 24 10 | 23 9 | 22 8 | 21 7 | 20 6 | 19 5 | 18 4 | 17 3 |
| Row | 1 | 1 | 1 | 1 | 0 | Х | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 |
| Col Row | 1 | 1 | 1 | 0 | 1 | 18 31 | 17 30 | 16 29 | 15 28 | 14 27 | 13 26 | 12 25 | 11 24 | 10 23 | 9 22 | <u>8</u> 21 | | 6 19 | 5 18 | <u>4</u> 17 | 3 16 | 2 15 |
| Col | | | | | | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| Row Col | 1 | 1 | 1 | 0 | 0 | 30 16 | 29 15 | 28 14 | 27 13 | 26 12 | 25 11 | 24 10 | 23 9 | 22 8 | 21 7 | 20 6 | 19 5 | 18 4 | 17 3 | 16 2 | 15 1 | 14 0 |
| Row | 1 | 1 | 0 | 1 | 1 | Х | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 |
| Col Row | 1 | 1 | 0 | 1 | 0 | 19 31 | 18 30 | 17 29 | 16 28 | 15 27 | 14 26 | 13 25 | 12 24 | 11 23 | 10 22 | 9 21 | 8 20 | 7 19 | 6 18 | <u>5</u> | 4 16 | 3 15 |
| Col | ļ., | | | | | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 |
| Row Col | 1 | 1 | 0 | 0 | 1 | 30 17 | 29 16 | 28 15 | 27 14 | 26 13 | 25 12 | 24 11 | 23 10 | 22 9 | 21 8 | 20 7 | 19 6 | 18 5 | 17 4 | 16 3 | 15 2 | 14 1 |
| Row Col | 1 | 1 | 0 | 0 | 0 | 29 16 | 28 15 | 27 14 | 26 13 | 25 12 | 24 11 | 23 10 | 22 9 | 21 8 | 20 7 | 19 6 | 18 5 | 17 4 | 16 | 15 | 14 1 | 13 0 |
| Row | 1 | 0 | 1 | 1 | 1 | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 3 18 | 2 17 | 16 | 15 |
| Col | 1 | 0 | 1 | 1 | 0 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 22 | 10 | 9 | 8 19 | 7 18 | 6 17 | 5 | 4 15 | 3 14 |
| Row Col | 1 | 0 | ı | - | U | 30 18 | 29 17 | 28 16 | 27 15 | 26 14 | 25 13 | 24 12 | 23 11 | 10 | 21 9 | 20 8 | 7 | 6 | 5 | 16 4 | 3 | 2 |
| Row Col | 1 | 0 | 1 | 0 | 1 | 29 17 | 28 16 | 27 15 | 26 14 | 25 13 | 24 12 | 23 11 | 22 10 | 21 9 | 20 8 | 19 7 | 18 6 | 17 5 | 16 4 | 15 3 | 14 2 | 13 1 |
| Row | 1 | 0 | 1 | 0 | 0 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 |
| Col Row | 1 | 0 | 0 | 1 | 1 | 16 30 | 15 29 | 14 28 | 13 27 | 12 26 | 11 25 | 10 24 | 9 23 | 8 22 | 7 21 | 6 20 | 5 19 | 4 18 | 3 17 | 2 16 | 1 15 | 0 14 |
| Col | <u> </u> | U | U | ' | ' | 19 | 18 | 26 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 |
| Row Col | 1 | 0 | 0 | 1 | 0 | 29 18 | 28 17 | 27 16 | 26 15 | 25 14 | 24 13 | 23 12 | 22 11 | 21 10 | 20 9 | 19 8 | 18 7 | 17 6 | 16 5 | 15 4 | 14 3 | 13 2 |
| Row | 1 | 0 | 0 | 0 | 1 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 |
| Col Row | 1 | 0 | 0 | 0 | 0 | 17 27 | 16 26 | 15 25 | 14 24 | 13 23 | 12 22 | 11 21 | 10 20 | 9 19 | 8 18 | 7 17 | 6 16 | 5 15 | 4 14 | 3 13 | 2 12 | 11 |
| Col Row | 0 | 1 | 1 | 1 | 1 | 16 29 | 15 28 | 14 27 | 13 26 | 12 25 | 11 24 | 10 23 | 9 22 | 8 21 | 7 | 6 19 | 5 18 | <u>4</u> 17 | 3 16 | 2 15 | 1 14 | 0 13 |
| Col | | | | | | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 |
| Row Col | 0 | 1 | 1 | 1 | 0 | 28 18 | 27 17 | 26 16 | 25 15 | 24 14 | 23 13 | 22 12 | 21 11 | 20 10 | 19 9 | 18 8 | 17 7 | 16 6 | 15 5 | 14 4 | 13 3 | 12 2 |
| Row | 0 | 1 | 1 | 0 | 1 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 |
| Col Row | 0 | 1 | 1 | 0 | 0 | 17 26 | 16 25 | 15 24 | 14 23 | 13 22 | 12 21 | 11 20 | 10 19 | 9 18 | 8 17 | 7 16 | 6 15 | 5 14 | 4 13 | 3 12 | 2 11 | 10 |
| Col | | | | | | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Row Col | 0 | 1 | 0 | 1 | 1 | 28 19 | 27 18 | 26 17 | 25 16 | 24 15 | 23 14 | 22 13 | 21 12 | 20 11 | 19 10 | 18 9 | 17 8 | 16 7 | 15 6 | 14 5 | 13 4 | 12 3 |
| Row | 0 | 1 | 0 | 1 | 0 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 |
| Col Row | 0 | 1 | 0 | 0 | 1 | 18 26 | 17 25 | 16 24 | 15 23 | 14 22 | 13 21 | 12 20 | 11 19 | 10 18 | 9 17 | 8 16 | 7 15 | 6 14 | 5 13 | 4 12 | 3 11 | 2 10 |
| Col | | | 0 | 0 | 0 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| Row Col | 0 | 1 | 0 | 0 | 0 | 25 16 | 24 15 | 23 14 | 22 13 | 21 12 | 20 11 | 19 10 | 18 9 | 17 8 | 16 7 | 15 6 | 14 5 | 13 4 | 12 3 | 11 2 | 10 1 | 9 0 |
| Row Col | 0 | 0 | 1 | 1 | 1 | 27 19 | 26 18 | 25 17 | 24 16 | 23 15 | 22 14 | 21 13 | 20 12 | 19 11 | 18 10 | 17 9 | 16 8 | 15 7 | 14 6 | 13 5 | 12 4 | 11 3 |
| Row | 0 | 0 | 1 | 1 | 0 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 |
| Col Row | 0 | 0 | 1 | 0 | 1 | 18 25 | 17 24 | 16 23 | 15 22 | 14 21 | 13 20 | 12 19 | 11 18 | 10 17 | 9 16 | 8 15 | 7 14 | 6 13 | 5 12 | 11 | 3 10 | 9 |
| Col Row | 0 | 0 | 1 | 0 | 0 | 17 24 | 16 23 | 15 22 | 14 21 | 13 20 | 12 19 | 11 18 | 10 17 | 9 16 | 8 15 | 7 14 | 6 13 | 5 12 | <u>4</u> 11 | 3 10 | 9 | 1 8 |
| Col | | | | | | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Row Col | 0 | 0 | 0 | 1 | 1 | 19 19 | 18 18 | 17 17 | 16 16 | 15 15 | 14 14 | 13 13 | 12 12 | 11 11 | 10 10 | 9 9 | 8 8 | 7 7 | 6 6 | 5 5 | 4 4 | 3 3 |
| Row Col | 0 | 0 | 0 | 1 | 0 | 18 18 | 17 17 | 16 16 | 15 15 | 14 14 | 13 13 | 12 12 | 11 11 | 10 10 | 9 9 | 8 8 | 7 7 | 6 6 | 5 5 | 4 | 3 3 | 2 |
| Row | 0 | 0 | 0 | 0 | 1 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| Col Row | 0 | 0 | 0 | 0 | 0 | 17 16 | 16 15 | 15 14 | 14 13 | 13 12 | 12 11 | 11 | 10 9 | 9 8 | 8 7 | 7 6 | <u>6</u> 5 | 5 4 | 3 | 2 | 2 1 | 0 |
| Col | | | | | | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |

user-defined wait states

Some memory architectures (most notably DRAM and SDRAM) may require wait states to be added to the 'C82's external interface. For memories and peripherals requiring a larger row time for decoding purposes, the R bit may be set in the configuration cache entry for those memory banks which will cause the 'C82 to automatically insert a single additional state into row time of the external memory cycle. For DRAM and SRAM accesses, the additional state is inserted between ad2 and rl1 (with /RAS high). For SDRAM accesses, the state is inserted between ac2 and the column pipeline (to increase the time between ACTV and a READ/WRT command).

| | | · |
|--------------------|---|---------------------------------------|
| MEMORY TYPE | R | ADDITIONAL CYCLE INSERTED |
| CT=00xx (EDO DRAM) | 0 | None |
| | 1 | 1 between ad2 and rl1 (/RAS high) |
| CT=01xx (SRAM) | 0 | None |
| | 1 | 1 between ad2 and rl1 (/RAS high) |
| CT=1xxx (SDRAM) | 0 | None |
| | 1 | 1 between ac2 and first column access |

Table 40. Row (R) Time Wait State Selection

Additionally, the WS field in the configuration cache entry for each memory bank allows the user to automatically insert a predefined number of wait states into the column time pipeline without using the READY input. This significantly enhances the 'C82s ability to interface with slower peripherals at higher clock rates. When WS(1:0) is set to a nonzero value, wait states will be inserted into the column time pipeline. If the READY signal is asserted, then additional wait states will be inserted as per the normal sampling mechanism of the READY input (during the final cycle of each column access).

Similar to the READY input, the WS(1:0) field should only be set to a nonzero value for 2 and 3 cyc/col accesses. Wait states inserted due to this field will output a status code of 11 (column time) on STATUS[1:0] so that the system may differentiate between the default wait states and pipeline bubbles.

ADDITIONAL CYCLES MEMORY TYPE WS[1:0] INSERTED (REFERENCES /CAS/DQM) 00 None CT=001x (EDO DRAM) 01 1 low 10 1 low, 1 high 2 low, 1 high 11 00 None CT=011x (SRAM) 01 1 low 10 2 low 11 3 low

Table 41. WS (Wait State) Encoding

Note: The WS(1:0) field should be set to 00 for single-cycle memory banks.

block write support

The TMS320C82 supports three modes of VRAM block write. The block-write mode is selectable so that software may specify block writes without knowing what type of block-write the addressed memory supports. Block writes are only supported for 64-bit busses. During block-write and load-color-register cycles, the block-write mode specified by the BW(1:0) bits of the bank configuration block will be used. Table 42 lists the block-write modes associated with the BW(1:0) bits.

Table 42. Block Write Selection

| BW(1:0) | BLOCK-WRITE MODE |
|---------|------------------|
| 00 | Simulated |
| 01 | Reserved |
| 10 | 4x |
| 11 | 8x |

bus sizing

The 'C82 supports data bus sizes of 8, 16, 32, or 64 bits. The value input in the BS(1:0) field of the bank-configuration cycle indicates the bus size of the addressed memory. This determines the maximum number of bytes that the 'C82 can transfer during each column access. If the number of bytes to be transferred exceeds the bus size, multiple accesses will automatically be performed to complete the transfer.

Table 43. Bus Size Selection

| BS(1:0) | BUS SIZE |
|---------|----------|
| 00 | 8 bits |
| 01 | 16 bits |
| 10 | 32 bits |
| 11 | 64 bits |

The selected bus size also determines which portion of the data bus will be used for the transfer. For 64-bit memory, the entire data bus is used. For 32-bit memory, AD[31:0] are used in little-endian mode and AD[63:32] are used in big-endian mode. 16-bit busses use AD[15:0] and AD[63:48]; and 8-bit busses use AD[7:0] and AD[63:56] for little- and big-endian, respectively. The 'C82 always aligns data to the proper portion of the bus and activates the appropriate /CAS/DQM strobes. During read cycles, all /CAS/DQM strobes will be active (low). During write cycles, only those /CAS/DQM strobes corresponding to bytes actually being written will be activated.

cache priority level

The 'C82 memory configuration cache can contain up to six entries. Once full, memory accesses to unconfigured banks require that one of the entries in cache be flushed and a configuration cycle for the desired bank be performed. The cache uses a multilevel, least-recently-used algorithm to determine which entry to flush. Because certain entries (i.e., code space, data space) may pertain to more time-critical functions than others, each of the six entries in the cache can be assigned a priority of high, medium, or low; indicated by the PL(1:0) bits of the configuration cycle fields for that bank. The LRU algorithm is implemented for each priority level separately; that is, when it becomes necessary to discard an entry, the least recently used entry of lowest priority present is discarded. The priority level encoding is shown below.

Table 44. Cache Priority Levels

| PL(| 1:0) | PRIORITY LEVEL |
|-----|------|----------------|
| 0 | 0 | Low |
| 0 | 1 | Medium |
| 1 | 0 | Reserved |
| 1 | 1 | High |



bank size

Since many memory types may require the same configuration, the bank configuration contains a memorybank-size field called MS(4:0). This field specifies the size of the memory bank to which the cache entry pertains, and thus which address bits should be compared to determine if a cache miss has occurred. The MS(4:0) codings are shown in Table 45.

Table 45. Memory Bank Size

| MS(4:0) | | | | | ADDRESS BITS | BANK SIZE | | |
|---------|---|---|---|---|--------------|------------|--|--|
| | | • | • | | COMPARED | | | |
| 0 | 0 | 0 | 0 | 0 | None | 4G bytes | | |
| 0 | 0 | 0 | 0 | 1 | 31 | 2G bytes | | |
| 0 | 0 | 0 | 1 | 0 | 31:30 | 1G byte | | |
| 0 | 0 | 0 | 1 | 1 | 31:29 | 512M bytes | | |
| 0 | 0 | 1 | 0 | 0 | 31:28 | 256M bytes | | |
| 0 | 0 | 1 | 0 | 1 | 31:27 | 128M bytes | | |
| 0 | 0 | 1 | 1 | 0 | 31:26 | 64M bytes | | |
| 0 | 0 | 1 | 1 | 1 | 31:25 | 32M bytes | | |
| 0 | 1 | 0 | 0 | 0 | 31:24 | 16M bytes | | |
| 0 | 1 | 0 | 0 | 1 | 31:23 | 8M bytes | | |
| 0 | 1 | 0 | 1 | 0 | 31:22 | 4M bytes | | |
| 0 | 1 | 0 | 1 | 1 | 31:21 | 2M bytes | | |
| 0 | 1 | 1 | 0 | 0 | 31:20 | 1M byte | | |
| 0 | 1 | 1 | 0 | 1 | 31:19 | 512K bytes | | |
| 0 | 1 | 1 | 1 | 0 | 31:18 | 256K bytes | | |
| 0 | 1 | 1 | 1 | 1 | 31:17 | 128K bytes | | |
| 1 | 0 | 0 | 0 | 0 | 31:16 | 64K bytes | | |
| 1 | 0 | 0 | 0 | 1 | 31:15 | 32K bytes | | |
| 1 | 0 | 0 | 1 | 0 | 31:14 | 16K bytes | | |
| 1 | 0 | 0 | 1 | 1 | 31:13 | 8K bytes | | |
| 1 | 0 | 1 | 0 | 0 | 31:12 | 4K bytes | | |
| 1 | 0 | 1 | 0 | 1 | 31:11 | 2K bytes | | |
| 1 | 0 | 1 | 1 | 0 | 31:10 | 1K bytes | | |
| 1 | 0 | 1 | 1 | 1 | 31:9 | 512 bytes | | |
| 1 | 1 | 0 | 0 | 0 | 31:8 | 256 bytes | | |
| 1 | 1 | 0 | 0 | 1 | 31:7 | 128 bytes | | |
| 1 | 1 | 0 | 1 | 0 | 31:6 | 64 bytes | | |
| 1 | 1 | 0 | 1 | 1 | 31:5 | 32 bytes | | |
| 1 | 1 | 1 | 0 | 0 | 31:4 | 16 bytes | | |
| 1 | 1 | 1 | 0 | 1 | 31:3 | 8 bytes | | |
| 1 | 1 | 1 | 1 | 0 | 31:2 | 4 bytes | | |
| 1 | 1 | 1 | 1 | 1 | 31:1 | 2 bytes | | |

refresh controller

The 'C82 has an on-chip refresh controller that schedules refresh cycles to be performed by the TC. Refresh rate is programmable via the TC's REFCNTL register. A refresh pseudo-address is output on AD[16:1] during refreshes, which may be used for bank-decoding. The refresh pseudo-address is decremented once for each refresh cycle that is performed. When it decrements to 0, it is reloaded with the value in the upper 16 bits of the REFCNTL register.

refresh controller (continued)

A refresh cycle is indicated by the status code 0x00001100 on AD[39:32] at row time. During a refresh cycle, information input on /EXCEPT[1:0] tells the TC what type of refresh cycle to perform. The /EXCEPT[1:0] encoding for refresh cycles is shown in Table 46. A retried refresh cycle is immediately terminated, and the refresh pseudo-address is not decremented.

Table 46. Refresh Cycles

| /EXCE | PT[1:0] | REFRESH MODE |
|-------|---------|---------------------------|
| 0 | 0 | DRAM (3 cycles /RAS high) |
| 0 | 1 | DRAM (4 cycles /RAS high) |
| 1 | 0 | Retry |
| 1 | 1 | SDRAM |

SDRAM support

The TMS320C82 provides direct support for synchronous DRAM (SDRAM) and graphics RAM (SGRAM). During 'C82 power-up refresh cycles, the external system must signal the presence of these memories by inputting an /EXCEPT[1:0] code of 11. This causes the 'C82 to perform an SDRAM deactivate (DCAB) command.

Additionally, the 'C82 will perform an SDRAM mode register set (MRS) cycle following a memory bank configuration cycle if that cycle specifies an SDRAM cycle timing code. No further MRS cycles will be performed for that bank as long as it remains in cache.

The MRS cycle is required to initialize the SDRAM for operation. Information about the burst length and read latency (CAS latency) is input to the SDRAM via its address inputs. The MRS value generated by the 'C82 is shown in Figure 56. It should be noted that CAS latency four reads are intended for use with CAS latency three SDRAMs, and thus the MRS cycle is performed as such.

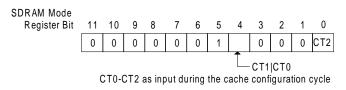


Figure 56. MRS Value

Because the MRS register is programmed through the SDRAM address inputs, the alignment of the MRS data to the 'C82 logical address bits is adjusted for the bus size as shown in Figure 57. The appearance of the MRS bits on the 'C82 physical address bus (RCA[16:0]) is dependent on the address multiplexing as selected by the AS(2:0) field.

| | | C82 Logical Address Bits | | | | | | | | | | | | | | |
|---------|-----|--------------------------|-----|-----|-----|----|----|----|----|----|----|----|----|----|----|----|
| BS(1:0) | A15 | A14 | A13 | A12 | A11 | | Α9 | A8 | Α7 | A6 | A5 | A4 | A3 | A2 | A1 | A0 |
| 0 0 | Х | Х | Х | Х | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0 1 | Х | Х | Х | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | Х |
| 10 | Х | Х | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | Х | Х |
| 11 | Х | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | Χ | Χ | Χ |

Figure 57. MRS Value Alignment

memory cycles

TMS320C82 external memory cycles are generated by the TC's external memory controller. The controller's state machine generates a sequence of states which define the transition of the memory interface signals. The state sequence is dependent on the cycle timing selected for the bank being accessed. Memory cycles consist of row states and the column pipeline.

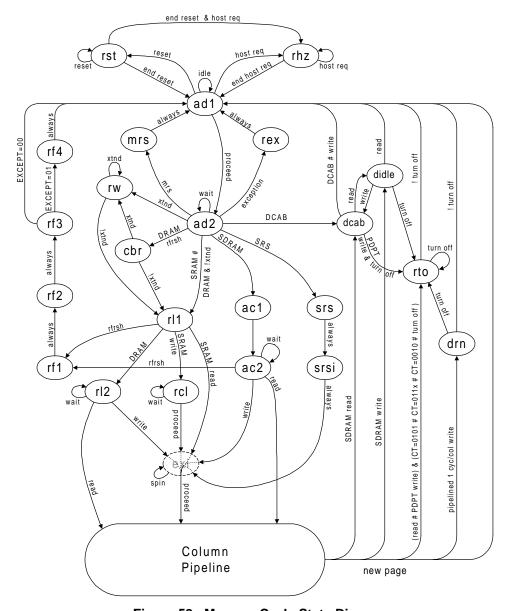


Figure 58. Memory Cycle State Diagram

row states

The row states make up the row time of each memory access. They occur when each new page access begins. The transition indicators determine the conditions that cause transitions to another state.

row states (continued)

Table 47. Row Time Memory States

| STATE | DESCRIPTION |
|-------|--|
| ad1 | The first address state, common to all memory accesses. All signals are driven inactive and outputs are address and status. State is repeated if idle. |
| ad2 | The second address state, common to all memory accesses. /RL is asserted and /DDIN is driven according to the data transfer direction. READY is sampled. |
| rl1 | For DRAM and SRAM cycles. /RAS is asserted, AD[63:0] is placed in high impedance, and /DBEN is asserted if required. READY is sampled during cbr refresh cycles. |
| rl2 | For DRAM cycles. Transitions of /TRG/CAS, /W, and /DSF may occur. State ensures sufficient /RAS low time before /CAS/DQM[7:0] are activated. READY is sampled. |
| ac1 | For SDRAM cycles. ACTV command is generated on /RAS, /TRG/CAS, and /W. /DBEN is asserted if required, and AD[63:0] is placed in high impedance. |
| ac2 | For SDRAM cycles. No transitions occur, but state ensures sufficient time between ACTV command and subsequent READ or WRT commands. |
| mrs | MRS command cycle. |
| cbr | Occurs before rl1 for DRAM refreshes to ensure /CAS/DQM is asserted a sufficient amount of time prior to assertion of /RAS. |
| rw | For all DRAM cycles, one or more of these states may be inserted if the previous page access was to the same bank. No transitions occur. State ensures sufficient /RAS high time. |
| rcl | Column pipeline load; common to all SRAM write cycles. One or more of these states may be inserted to ensure that the pipeline is properly loaded. READY is sampled. |
| srs | For SDRAM SRS cycles. /DBEN is asserted. |
| srsi | For SDRAM SRS cycles. Idle cycle required to allow the pipeline to load. |
| rex | Row time exception state. Ensures sufficient /RAS low time before returning to state ad1. State may be repeated as required. |
| rf1 | First refresh cycle. Common to all refreshes. No signal transitions occur. |
| rf2 | Second refresh cycle. Common to all refreshes. No signal transitions occur. |
| rf3 | Third refresh cycle. Common to all refreshes. No signal transitions occur. |
| rf4 | For slow (/EXCEPT[1:0] = 01) DRAM refresh cycles. Fourth refresh cycle which allows an additional cycle of /RAS low time. |
| exi | One or more of these states may be inserted when exceptions are enabled for the addressed bank of memory. State may be repeated as required. State is not present if exceptions are not supported. |
| didle | Idle cycle for SDRAM write cycles ensures enough time between the WRT command and bank deactivation (DCAB). |
| dcab | Deactivation cycle for SDRAM cycles. |
| drn | For 1 cycle/column pipelined DRAM writes, all /CAS/DQM[7:0] are activated to drain the DRAM pipeline. |
| rto | Turnoff cycle for all DRAM and SRAM reads; and DRAM and nonsynchronous SRAM PDT writes. All output signals except for /RL are driven inactive. Additional rto cycles will be performed according to the value of the TO[1:0] bank configuration field. |
| rst | Reset state. During reset, all 'C82 signals with the exceptions of /HACK, REQ, and CLKOUT are placed in the high-impedance state. |
| rhz | High-impedance state. Occurs during host requests and repeats until bus is released by the host. All 'C82 signals with the exceptions of /HACK, REQ, and CLKOUT are placed in the high-impedance state. |

row states (continued)

Table 48. State Transition Indicators

| INDICATOR | DESCRIPTION |
|------------|--|
| any cycle | Continuation of current cycle. |
| /EXCEPT=xx | State change occurs for indicated /EXCEPT[1:0] value (as latched in ad2). |
| exception | Memory exception—retry, fault, or configuration cache flush request. |
| retry | /EXCEPT = 10. |
| wait | READY input sampled low in ad2, rl1 (CBR refresh only), rl2, rcl, and last column state; repeat current state. |
| spin | Internally generated wait state to allow TC pipeline to load/resolve contention. |
| new page | The next access requires a page change (new row access) |
| turn off | Turn off, specified by default or by TO[1:0] field in bank configuration. |
| xtnd | Internally generated transition to insert additional cycles in order to support exceptions. |

external memory timing examples

The following sections contain descriptions of the various C82 memory cycles and illustrate the signal transitions for those cycles. Memory cycles may be separated into three basic categories: DRAM cycles for use with EDO DRAM and VRAM; SRAM cycles for use with SRAM and peripherals; and SDRAM cycles for use with SDRAM and SGRAM.

DRAM cycles

The DRAM cycles are page-mode accesses consisting of a row access followed by one or more column accesses. Column accesses may be one, two, or three clock cycles in length with 2 and 3 cycle accesses allowing the insertion of wait states to accommodate slow devices. Idle cycles can occur after necessary column accesses have completed or between column accesses due to "bubbles" in the TC data flow pipeline. The pipeline diagrams in Figure 59 show the pipeline stages for each access type and when the /CAS/DQM signal corresponding to the column access is activated.

DRAM cycles (continued)

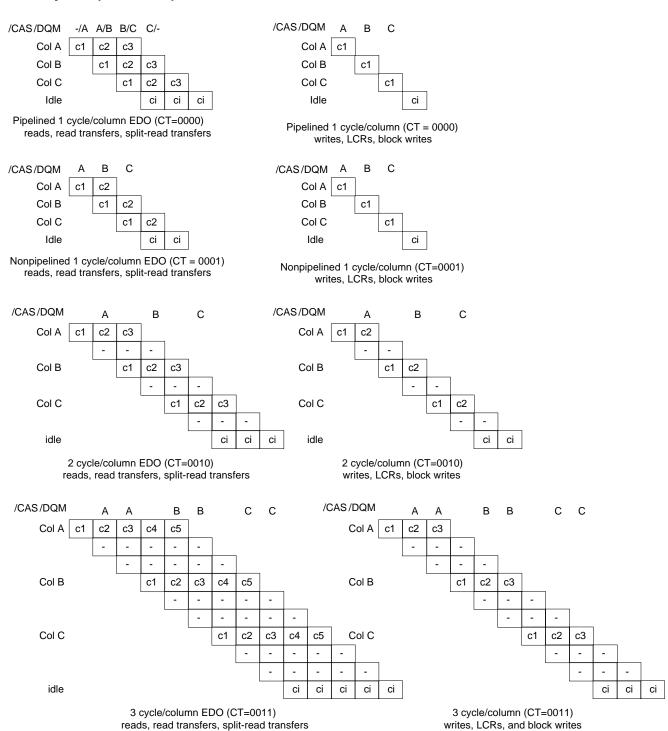
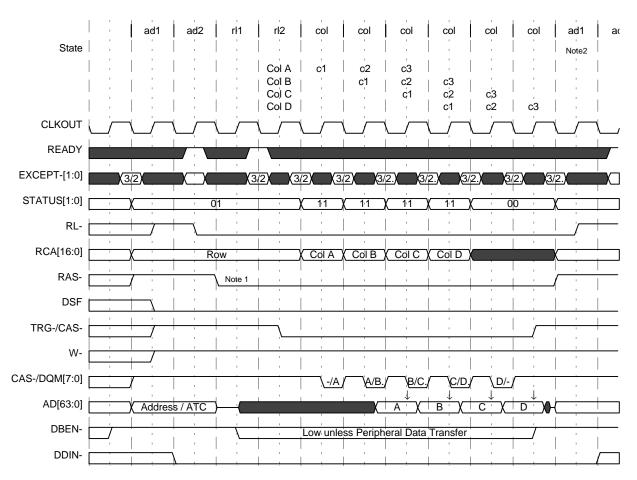


Figure 59. DRAM Cycle Column Pipelines

read cycles

Read cycles transfer data or instructions from external memory to the 'C82. The cycles can occur as a result of a packet transfer, cache request, or DEA request. During the cycle, /W is held high, /TRG/CAS is driven low after /RAS to enable memory output drivers, and /DBEN and /DDIN are low so that data transceivers may drive into the 'C82. During column time, the TC places AD[63:0] into high impedance, allowing it to be driven by the memory, and latches input data during the appropriate column state. The TC always reads 64 bits and extracts and aligns the appropriate bytes. Invalid bytes for bus sizes of less than 64 bits are discarded. During peripheral device packet transfers, /DBEN and /DDIN remain high.

For DRAM reads, the minimum number of cycles between ad1 and the first column access is four whether exceptions are supported or not.

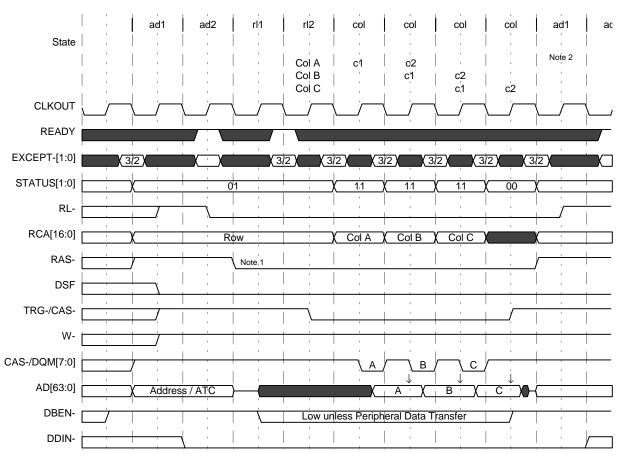


- 1. Additional cycles will be inserted between ad2 and rl1 as required to ensure RAS- high of at least 3 cycles.
- 2. Turnoff cycles will be inserted between rto and ad1 as specified by the bank configuration.

Figure 60. 1 cycle/column Pipelined EDO DRAM Read Cycle

SPRS048 — APRIL 1998

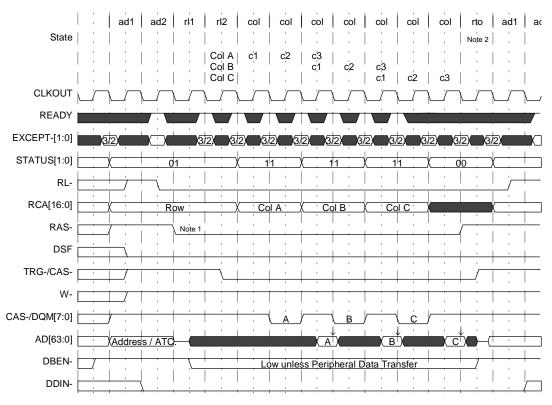
read cycles (continued)



- 1. Additional cycles will be inserted between ad2 and rl1 as required to ensure RAS- high of at least 3 cycles.
- 2. Turnoff cycles will be inserted between rto and ad1 as specified by the bank configuration.

Figure 61. 1 cycle/column EDO DRAM Read Cycle

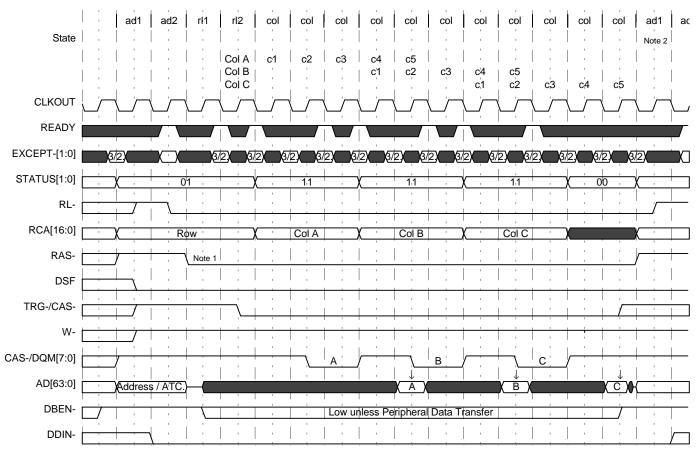
read cycles (continued)



- 1. Additional cycles will be inserted between ad2 and rl1 as required to ensure RAS- high of at least 3 cycles.
- 2. Turnoff cycles will be inserted between rto and ad1 as specified by the bank configuration.

Figure 62. 2 cycles/column EDO DRAM Read Cycle

read cycles (continued)



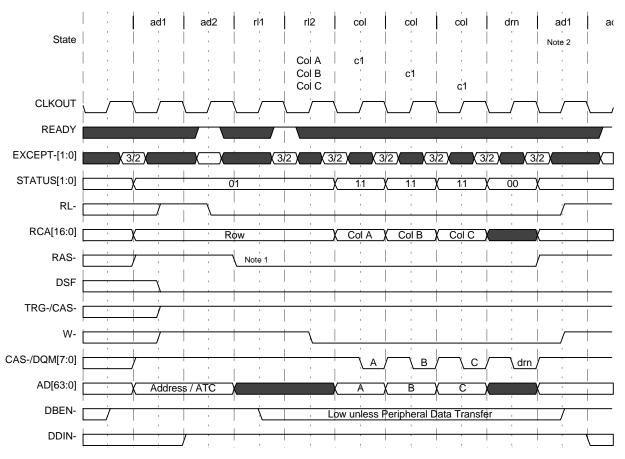
- 1. Additional cycles will be inserted between ad2 and rl1 as required to ensure RAS- high of at least 4 cycles.
- 2. Turnoff cycles will be inserted between rto and ad1 as specified by the bank configuration.

Figure 63. 3 cycle/column EDO DRAM Read Cycle

write cycles

Write cycles transfer data from the 'C82 to external memory. These cycles can occur as a result of a packet transfer, a DEA request, or an MP data cache write-back. During the cycle /TRG/CAS is held high, /W is driven low after the fall of /RAS to enable early write cycles, and /DDIN is high so that data transceivers drive toward memory. The TC drives data out on AD[63:0] and indicates valid bytes by activating the appropriate /CAS/DQM strobes. During peripheral device packet transfers, /DBEN remains high and AD[63:0] is placed in high impedance so that the peripheral device may drive data into the memory. Additionally, the number of turnoff cycles identified by the TO(1:0) field for the addressed bank of memory will be applied during PDT write cycles.

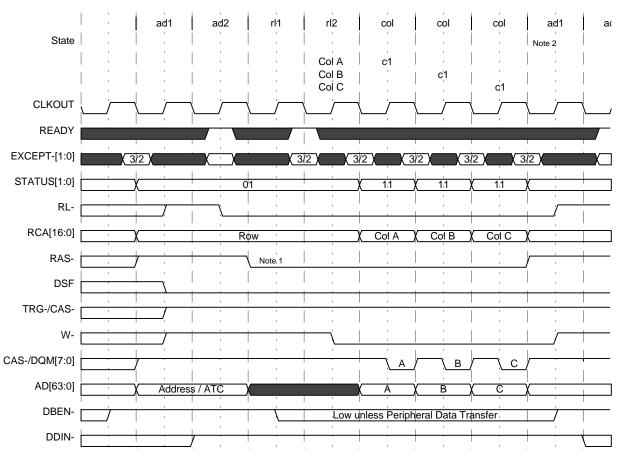
Exceptions are not supported in the following diagrams. Support for exceptions increases the minimum number of cycles between ad1 and the first column state from 4 to 6.



Notes: 1. Additional cycles will be inserted between ad2 and rl1 as required to ensure RAS- high of at least 3 cycles.

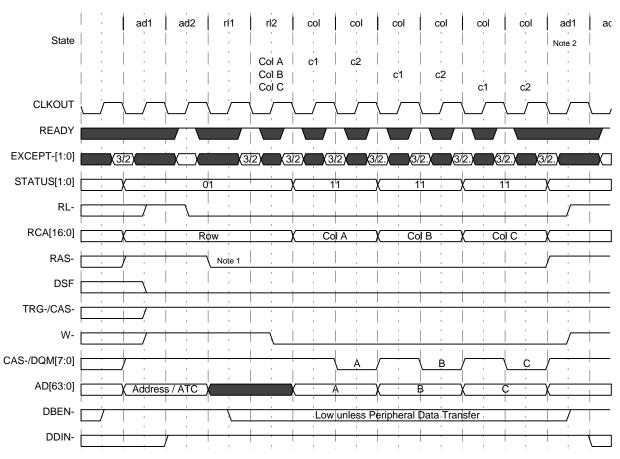
2. During peripheral data transfer, turnoff cycles will be inserted prior to ad1 as specified by the bank configuration.

Figure 64. 1 cycle/column Pipelined DRAM Write Cycle



- 1. Additional cycles will be inserted between ad2 and rl1 as required to ensure RAS- high of at least 3 cycles.
- 2. During peripheral data transfer, turnoff cycles will be inserted prior to ad1 as specified by the bank configuration.

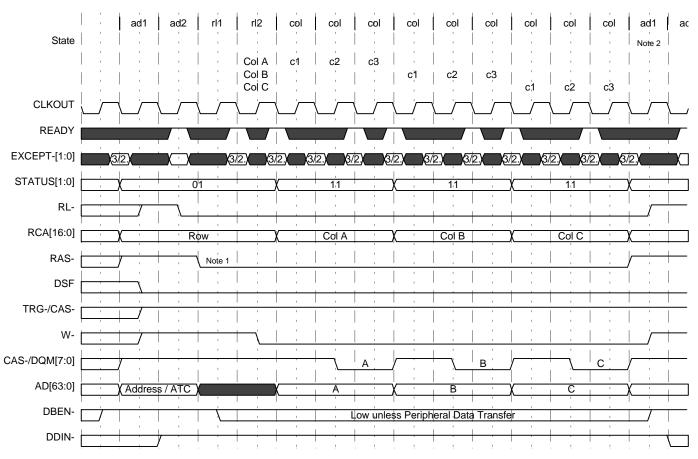
Figure 65. 1 cycle/column DRAM Write Cycle



Notes: 1. Additional cycles will be inserted between ad2 and rl1 as required to ensure RAS- high of at least 3 cycles.

2. During peripheral data transfer, turnoff cycles will be inserted prior to ad1 as specified by the bank configuration.

Figure 66. 2 cycle/column DRAM Write Cycle



- 1. Additional cycles will be inserted between ad2 and rl1 as required to ensure RAS- high of at least 4 cycles.
- 2. During peripheral data transfer, turnoff cycles will be inserted prior to ad1 as specified by the bank configuration.

Figure 67. 3 cycle/column DRAM Write Cycle

SPRS048 — APRIL 1998

load color register cycles

Load color register (LCR) cycles are used to load a VRAM's color register prior to performing a block write. LCR cycles are supported only on 64-bit data busses. Because an LCR writes into a VRAM, it closely resembles a normal write cycle. The difference is that the DSF output is high at both the fall of /RAS and the fall of /CAS/DQM. Also, because the VRAM color register is a single location, only one column access occurs.

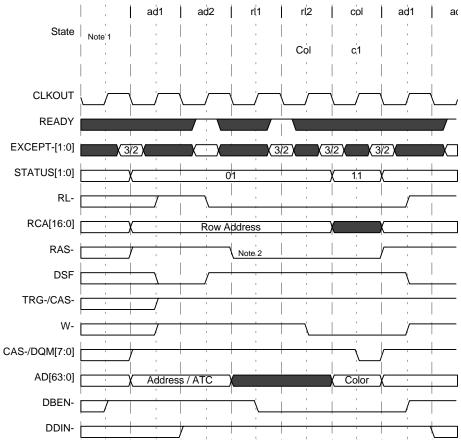
The row address output by the TC is used for bank decode only. Normally all VRAM banks should be selected during an LCR cycle because another LCR will not occur when a block write memory page change occurs. The column address output during an LCR is likewise irrelevant as the VRAM color register is the only location written. All /CAS/DQM strobes are active during an LCR cycle.

If exception support for a given bank is enabled, the /EXCEPT[1:0] inputs are sampled during LCR column states and must be at valid levels. A retry code (/EXCEPT[1:0] = 10) at column time has no effect, however, because only one column access is performed.

If the BW (block write) field of the configuration cache entry for the given bank indicate that the addressed memory supports only simulated block writes, the LCR cycle will be changed into a normal write cycle at the start of the simulated block write.

Exceptions are not supported in the following diagrams. Support for exceptions increases the minimum number of cycles between ad1 and the first column state from 4 to 6.

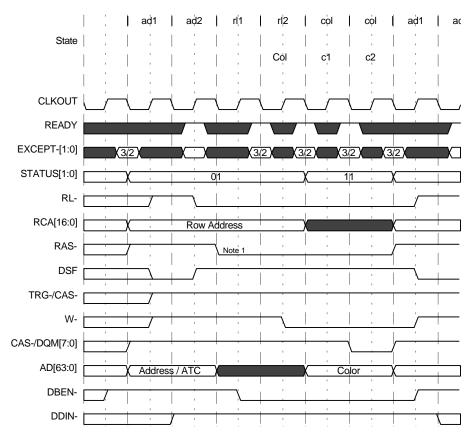
load color register cycles (continued)



- 1. These timings apply to piplined and nonpiplined 1 cycle/column DRAM.
- 2. Additional cycles will be inserted between ad2 and rl1 as required to ensure RAS- high of at least 3 cycles.

Figure 68. 1 cycle/column Load Color Register (LCR) Cycle

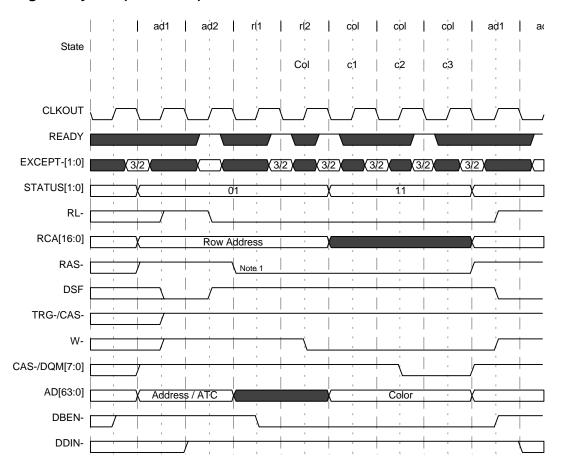
load color register cycles (continued)



Note 1: Additional cycles will be inserted between ad2 and rl1 as required to ensure RAS- high of at least 3 cycles.

Figure 69. 2 cycle/column Load Color Register (LCR) Cycle

load color register cycles (continued)



Note 1: Additional cycles will be inserted between ad2 and rl1 as required to ensure RAS- high of at least 4 cycles.

Figure 70. 3 cycle/column Load Color Register (LCR) Cycle

SPRS048 — APRIL 1998

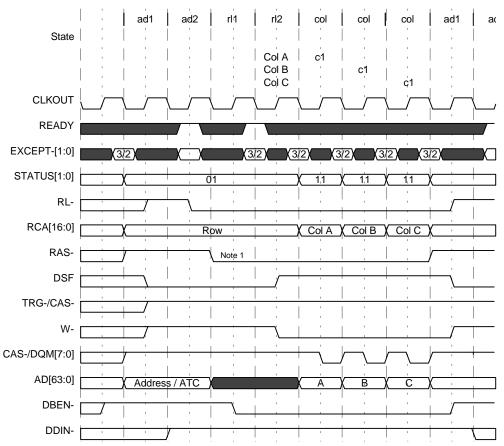
block-write cycles

Block-write cycles cause the data stored in the VRAM color registers to be written to the memory locations enabled by the appropriate data bits on the AD[63:0] bus. This allows up to a total of 64 bytes (depending on the block-write type) to be written in a single column access. The TMS320C82 supports 4x and 8x block-writes. Selection of block-write type is controlled by the BW field input during the appropriate bank configuration cycle. A block-write cycle is indicated by a row-time status code of 1001 output on AD[35:32]. The block-write cycle is identical to a standard write cycle with the following exceptions:

- DSF is high at the fall of /CAS/DQM, enabling the block-write function of the VRAMs.
- Only 64-bit data bus widths are supported; consequently, all /CAS/DQM signals will be active (low).
- Block writes always begin with a new row access. Upon completion of a block-write, the memory interface returns to the ad1 state to await the next access.
- The address output on AD[63:0] during column accesses represent the column locations to be written
 using the color register value. Depending on the type of block-write being performed, all of the data bits
 may not be used by the VRAM.
- The two or three LSBs of address output on RCA[16:0] are ignored by the VRAMs because the column locations are specified by the value on the data bus.

Exceptions are not supported in Figure 71, Figure 72, and Figure 73. Support for exceptions increases the minimum number of cycles between ad1 and the first column state from 4 to 6.

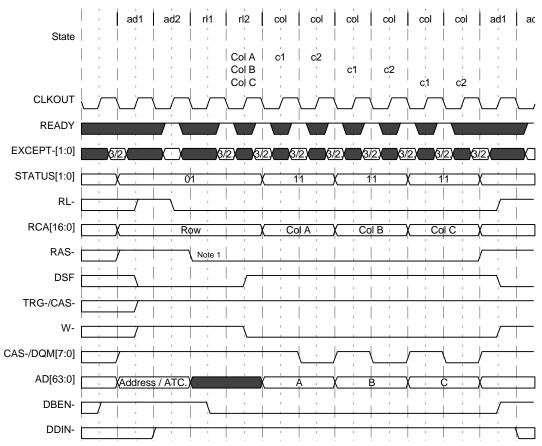
block-write cycles (continued)



Note 1: Additional cycles will be inserted between ad2 and rl1 as required to ensure RAS- high of at least 3 cycles.

Figure 71. 1 cycle/column Block-Write Cycle

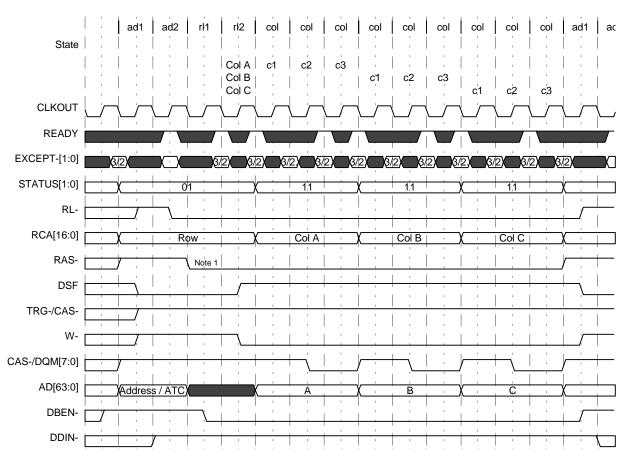
block-write cycles (continued)



Note 1: Additional cycles will be inserted between ad2 and rl1 as required to ensure RAS- high of at least 3 cycles.

Figure 72. 2 cycle/column Block-Write Cycle

block-write cycles (continued)



Note 1: Additional cycles will be inserted between ad2 and rl1 as required to ensure RAS- high of at least 4 cycles.

Figure 73. 3 cycle/column Block-Write Cycle

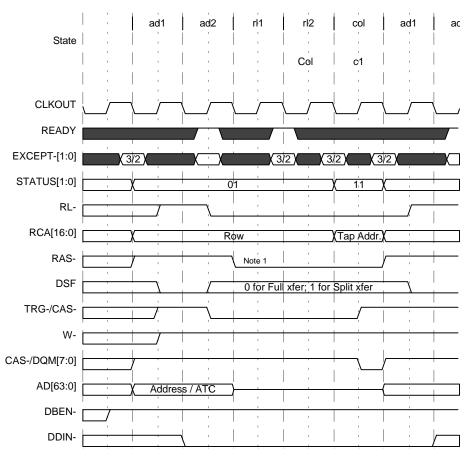
SPRS048 — APRIL 1998

read and split-read transfers

Read and split-read transfers resemble a standard read cycle. These cycles are performed as the result of a packet transfer submission to the TC which specifies the SRT mode. The 'C82 supports both read and split-read transfers. These cycles are designed to transfer a row of data from the VRAM memory array into the VRAM SAM register. Since no data is actually transferred over the system bus during an SRT cycle, the AD[63:0] bus is placed in high impedance. The /TRG/CAS output is driven low prior to the fall of /RAS to indicate a transfer cycle. Only a single column access is performed, therefore, while /EXCEPT[1:0] are required to be at valid levels, retries will have no effect if asserted at column time. The value output on RCA[16:0] at column time represents the SAM tap point.

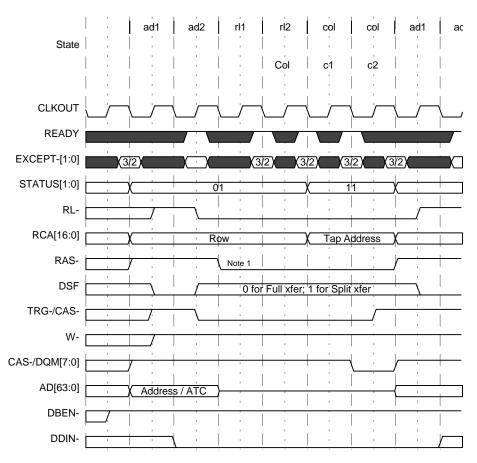


read and split-read transfers (continued)



1. Additional cycles will be inserted between ad2 and rl1 as required to ensure RAS- high of at least 3 cycles. Notes: 2. These timings apply to piplined and nonpiplined 1 cycle/column DRAM.

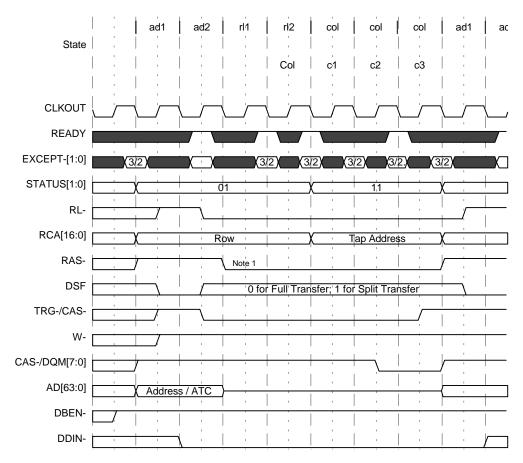
read and split-read transfers (continued)



Note 1: Additional cycles will be inserted between ad2 and rl1 as required to ensure RAS- high of at least 3 cycles.

Figure 75. 2 cycle/column Memory-to-Register Transfer Cycle

read and split-read transfers (continued)

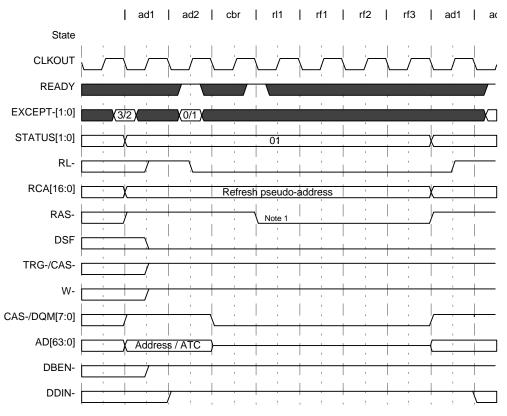


Note 1: Additional cycles will be inserted between ad2 and rl1 as required to ensure RAS- high of at least 4 cycles.

Figure 76. 3 cycle/column Memory-to-Register Transfer Cycle

DRAM refresh cycle

The DRAM refresh cycle is performed when the TC receives a DRAM cycle timing input (/EXCEPT[1:0] = 0X) at the start of a refresh cycle. The TC performs /CAS-before-/RAS (CBR) refresh cycles, wherein the refresh address is generated internal to the memory device. The 'C82 outputs a 16-bit pseudo-address (used for refresh bank decode) on RCA[16:1]. The pseudo-address is decremented once for each refresh that is performed.



Note 1: RAS- cannot be high for less than the 3 cycles required when /EXCEPT[1:0] = 00.

An additional cycle will be inserted between cbr and rl1 when /EXCEPT[1:0] = 01.

An additional cycle will be inserted between rf3 and ad1 when /EXCEPT[1:0] = 01.

Figure 77. DRAM Refresh

TMS320C82 DIGITAL SIGNAL PROCESSOR

SPRS048 — APRIL 1998

SRAM cycles

Similar to DRAM cycles, the SRAM cycles are page-mode accesses consisting of a row access followed by one or more column accesses. Column accesses may be one, two, or three clock cycles in length with 2 and 3 cycle accesses allowing the insertion of wait states to accommodate slow devices. Idle cycles can occur after necessary column accesses have completed or between column accesses due to "bubbles" in the TC data flow pipeline. The pipeline diagrams in Figure 78 show the pipeline stages for each access type and when the /CAS/DQM signal corresponding to the column access is activated.

SRAM cycles (continued)

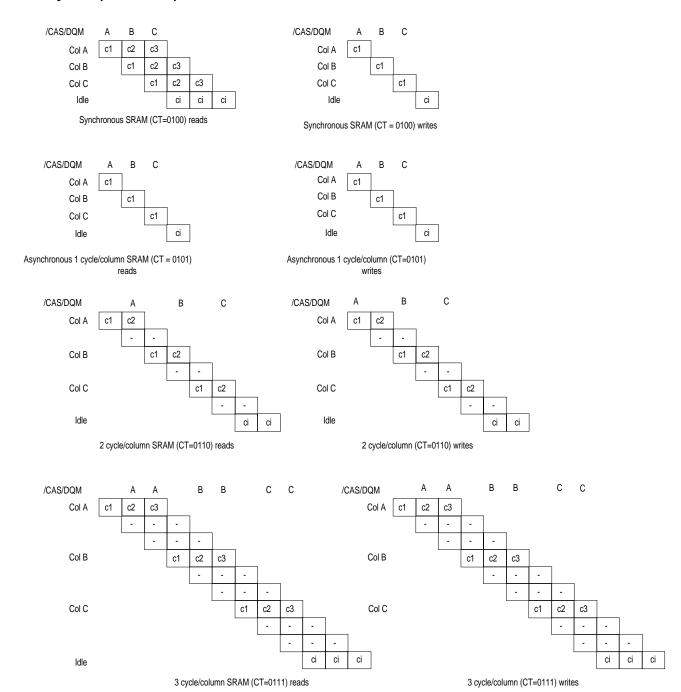


Figure 78. SRAM Cycle Column Pipelines

TMS320C82 DIGITAL SIGNAL PROCESSOR

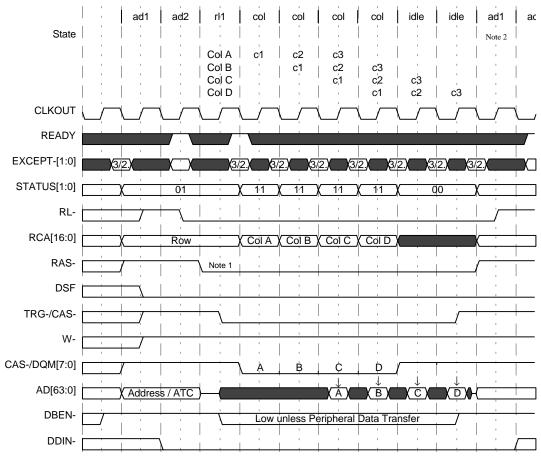
SPRS048 — APRIL 1998

read cycles

SRAM read cycles transfer data or instructions from external memory to the 'C82. SRAM read cycles are designed to interface with SRAM and other peripherals with SRAM-like I/O interfaces. During the cycle, /W is held high, /TRG/CAS is driven low after /RAS to enable memory output drivers, and /DBEN and /DDIN are low so that data transceivers may drive into the 'C82. During column time, the TC places AD[63:0] into high impedance, allowing it to be driven by the memory, and latches input data during the appropriate column state. The TC always reads 64 bits and extracts and aligns the appropriate bytes. Invalid bytes for bus sizes of less than 64 bits are discarded. During peripheral device packet transfers, /DBEN and /DDIN remain high.

Exceptions are not supported in Figure 79, Figure 80, Figure 81, and Figure 82. Support for exceptions increases the minimum number of cycles between ad1 and the first column state from 3 to 4.

read cycles (continued)

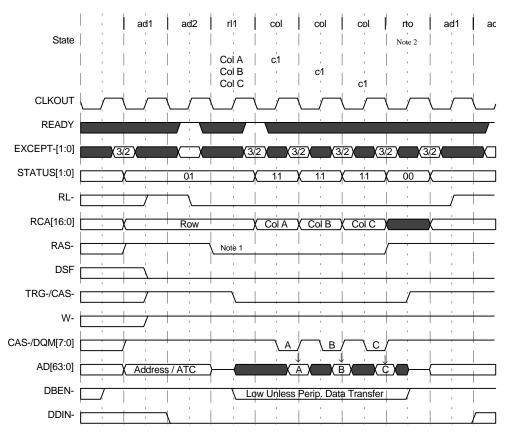


- 1. No RAS- high time requirements apply to these cycles.
- 2. Turnoff cycles will be inserted between rto and ad1 as specified by the bank configuration.

Figure 79. Synchronous SRAM Read Cycle

SPRS048 — APRIL 1998

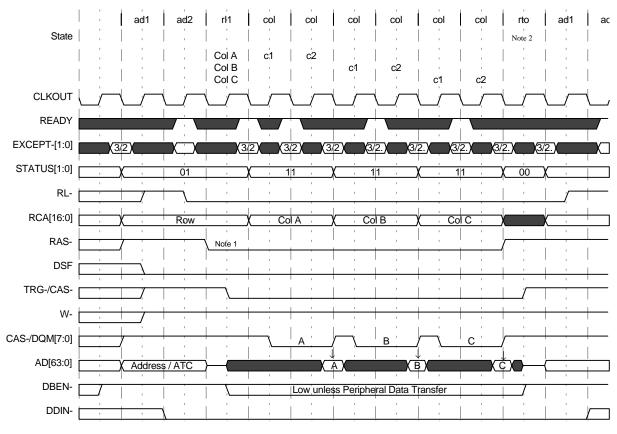
read cycles (continued)



- 1. No RAS- high time requirements apply to these cycles.
- 2. Additional turnoff cycles will be inserted between rto and ad1 as specified by the bank configuration.

Figure 80. 1 cycle/column SRAM Read Cycle

read cycles (continued)

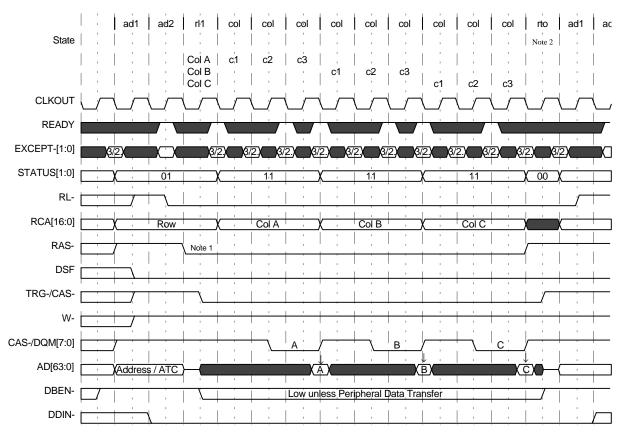


- 1. No RAS- high time requirements apply to these cycles.
- 2. Additional turnoff cycles will be inserted between rto and ad1 as specified by the bank configuration.

Figure 81. 2 cycle/column SRAM Read Cycle

SPRS048 — APRIL 1998

read cycles (continued)



- 1. No RAS- high time requirements apply to these cycles.
- 2. Additional turnoff cycles will be inserted between rto and ad1 as specified by the bank configuration.

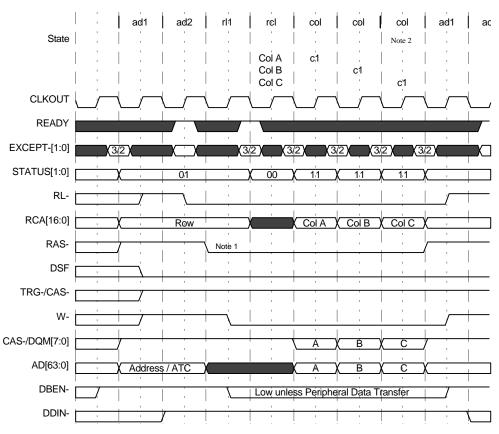
Figure 82. 3 cycle/column SRAM Read Cycle

SPRS048 — APRIL 1998

write cycles

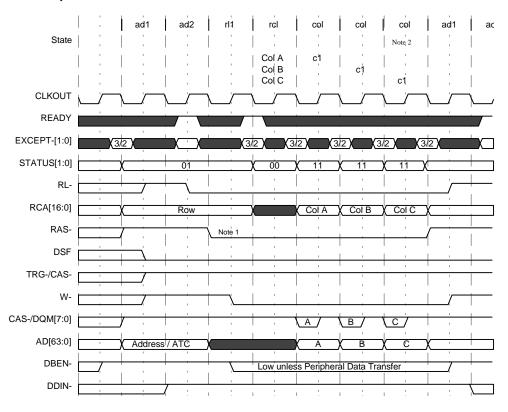
Write cycles transfer data from the 'C82 to external memory. These cycles can occur as a result of a packet transfer, a DEA request, or an MP data cache write-back. During the cycle /TRG/CAS is held high. /W is driven low after the fall of /RAS to enable early write cycles, and /DDIN is high so that data transceivers drive toward memory. The TC drives data out on AD[63:0] and indicates valid bytes by activating the appropriate /CAS/DQM strobes. The /CAS/DQM signals may be used as chip enables (/CE) for SRAMs and peripherals (i.e., /CE-controlled writes). During peripheral device packet transfers, /DBEN remains high and AD[63:0] is placed in high impedance so that the peripheral device may drive data into the memory. Additionally, the number of turnoff cycles identified by the TO(1:0) field for the addressed bank of memory will be applied during PDT write cycles.

Exceptions are not supported in Figure 83, Figure 84, Figure 85, and Figure 86. Support for exceptions increases the minimum number of cycles between ad1 and the first column state from 4 to 6.



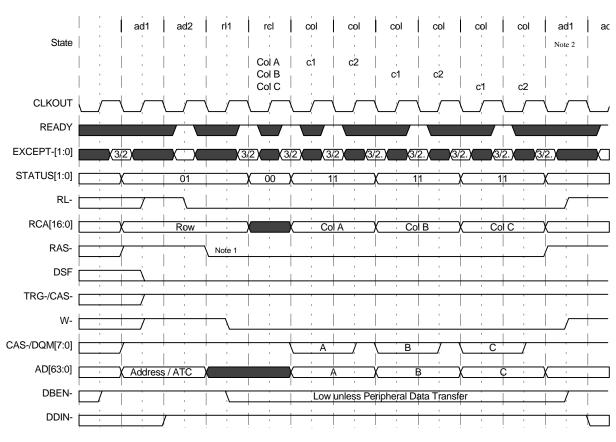
- 1. No RAS- high time requirements are applicable to these cycles.
- 2. During peripheral data transfer, turnoff cycles will be inserted prior to ad1 as specified by the bank configuration.

Figure 83. Synchronous SRAM Write Cycle



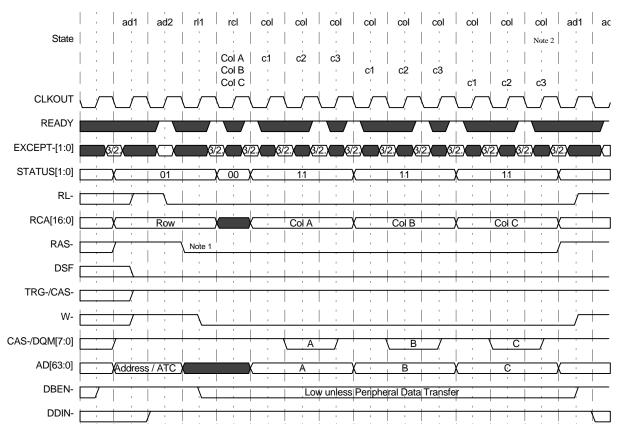
- 1. No RAS- high time requirements are applied to these cycles.
- 2. During peripheral data transfer, turnoff cycles will be inserted prior to ad1 as specified by the bank configuration.

Figure 84. 1 cycle/column SRAM Write Cycle



- 1. No RAS- high time requirements apply to these cycles.
- 2. During peripheral data transfer, turnoff cycles will be inserted prior to ad1 as specified by the bank configuration.

Figure 85. 2 cycle/column SRAM Write Cycle



- 1. No RAS- high time requirements are applied to these cycles.
- 2. During peripheral data transfer, turnoff cycles will be inserted prior to ad1 as specified by the bank configuration.

Figure 86. 3 cycle/column SRAM Write Cycle

TMS320C82 DIGITAL SIGNAL PROCESSOR

SPRS048 — APRIL 1998

SDRAM cycles

The SDRAM cycles support the use of SDRAM and SGRAM devices for single-cycle memory accesses. While SDRAM cycles use the same state sequences as DRAM cycles, the memory control signal transitions are modified to perform SDRAM command cycles. The supported SDRAM commands are:

- DCAB Deactivate (precharge) all banks
- · ACTV Activate the selected bank and select the row
- READ Input starting column address and start read operation
- · WRT Input starting column address and start write operation
- MRS Set SDRAM mode register
- REFR Auto-refresh cycle with internal address
- SRS Set special register (color register)
- BLW Block write

SDRAM cycles begin with an activate (ACTV) command followed by the requested column accesses. When a memory page change occurs, the selected bank is deactivated with a DCAB command.

The TMS320C82 supports CAS latencies of 2, 3, or 4 cycles and burst lengths of 1 or 2. These are selected by the CT field read in during a bank-configuration cycle for the given bank. It should be noted that CAS latency 4 accesses are intended for use with CAS latency 3 SDRAM-like devices.

The column pipelines for SDRAM accesses are shown in Figure 87. Idle cycles can occur after necessary column accesses have completed or between column accesses due to "bubbles" in the TC data flow pipeline. The pipeline diagrams show the pipeline stages for each access type and when the /CAS/DQM signal corresponding to the column access is activated.

SDRAM cycles (continued)

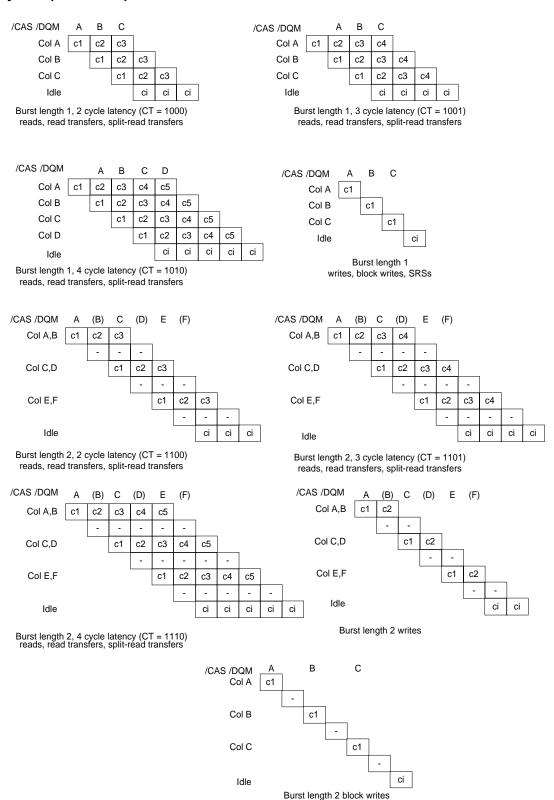
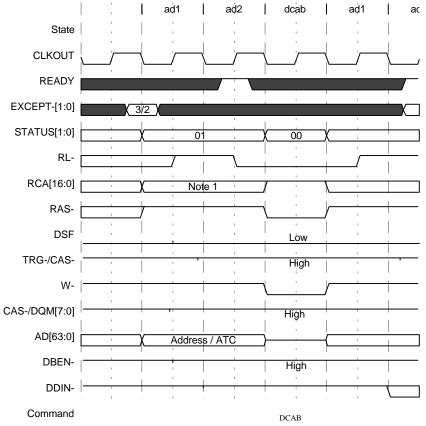


Figure 87. SDRAM Column Pipelines

special SDRAM cycles

In order to properly initialize SDRAM, the TMS320C82 provides support for two special SDRAM cycles. During the power-up refresh sequence, the first refresh cycle that receives an SDRAM bank code (/EXCEPT[1:0] = 11) will be abandoned and a power-up deactivate (DCAB) cycle is performed. Only one DCAB operation is performed, so it is expected that all SDRAM banks will be decoded for this operation. The 'C82 also performs an MRS cycle immediately following a bank-configuration cycle if that cycle returned a SDRAM CT code. No further MRS cycles for that bank are performed as long as the bank configuration remains cached.



Note 1: The row address is a don't care.

Figure 88. SDRAM Power-up Deactivate

special SDRAM cycles (continued)

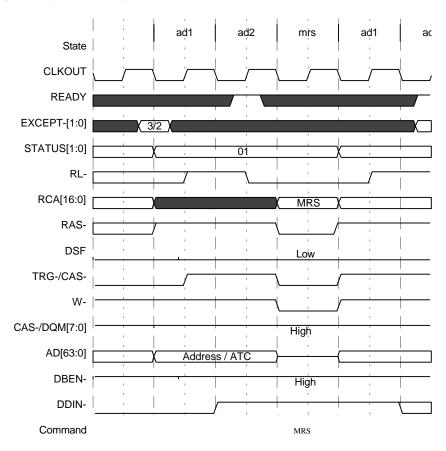


Figure 89. SDRAM Mode Register Set

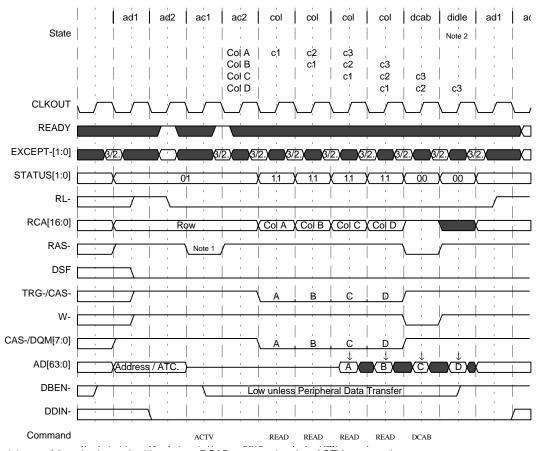
TMS320C82 DIGITAL SIGNAL PROCESSOR

SPRS048 — APRIL 1998

SDRAM read cycles

Read cycles begin with an activate command to activate the bank and select the row. The TC outputs the column address and activates the /TRG/CAS strobe for each read command. For burst length 1 accesses, a read command can occur on each cycle. For burst length 2 accesses, a read command may occur every two cycles. During column time, the TC places AD[63:0] into high impedance, allowing it to be driven by the memory and latches input data during the appropriate column state. The TC always reads 64 bits and extracts and aligns the appropriate bytes. Invalid bytes for bus sizes of less than 64 bits are discarded. The /CAS/DQM strobes are activated two cycles before input data is latched (three cycles before in the case of CAS latency 4 accesses). If the second column in a burst is not required, then /CAS/DQM is not activated. During peripheral device packet transfers, /DBEN remains high.

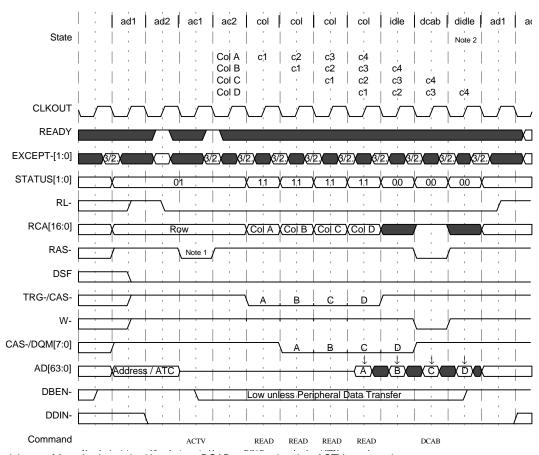
For SDRAM reads, the minimum number of cycles between ad1 and the first column access is four whether exceptions are supported or not.



Notes: 1. A minimum of 3 cycles is required between a DCAB command and an ACTV command.

2. Turnoff cycles will be inserted between didle and ad1 as specified by the bank configuration.

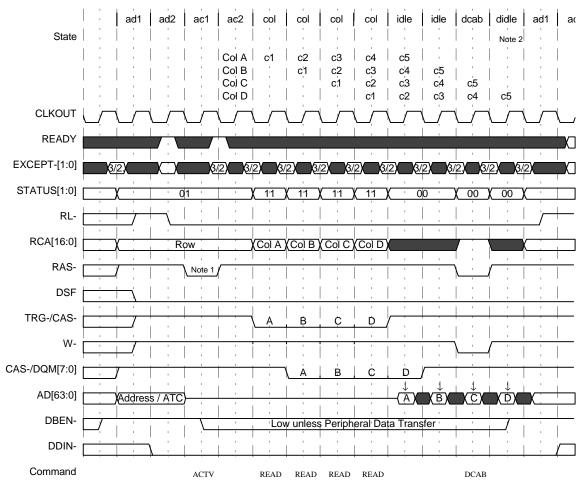
Figure 90. SDRAM Burst Length 1, 2 Cycle Latency Read



Notes: 1. A minimum of 3 cycles is required between a DCAB command and an ACTV command.

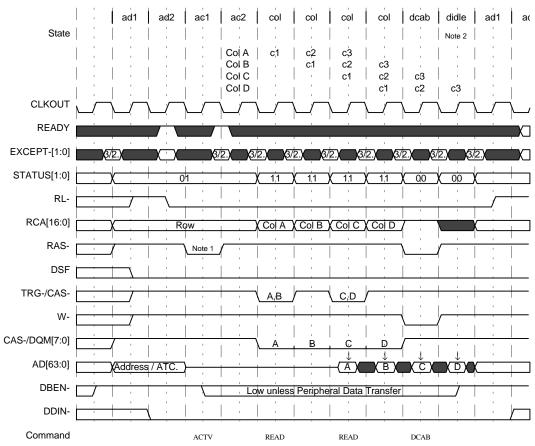
2. Turnoff cycles will be inserted between didle and ad1 as specified by the bank configuration.

Figure 91. SDRAM Burst Length 1, 3 Cycle Latency Read



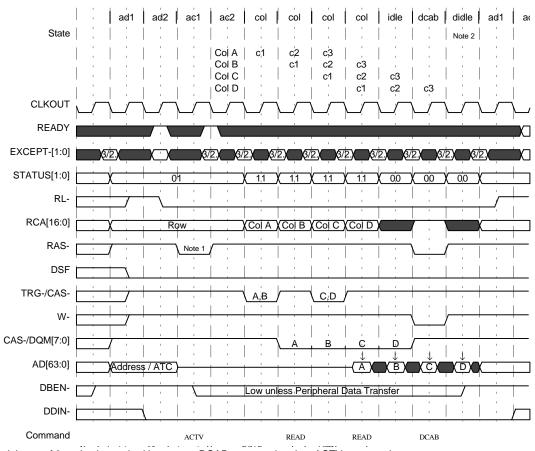
- 1. A minimum of 3 cycles is required between a DCAB command and an ACTV command.
- 2. Turnoff cycles will be inserted between didle and ad1 as specified by the bank configuration.

Figure 92. SDRAM Burst Length 1, 4 Cycle Latency Read



- 1. A minimum of 3 cycles is required between a DCAB command and an ACTV command.
- 2. Turnoff cycles will be inserted between didle and ad1 as specified by the bank configuration.

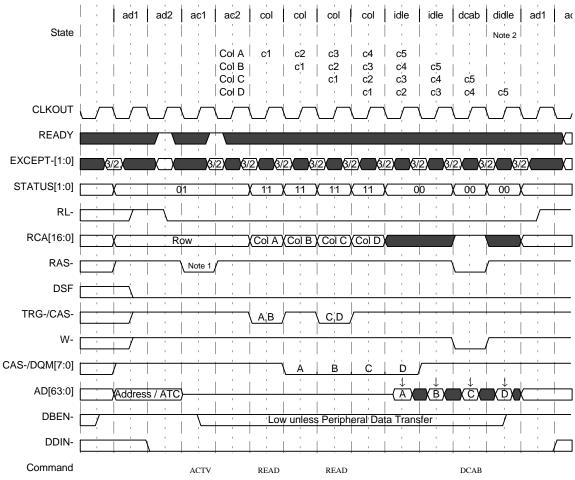
Figure 93. SDRAM Burst Length 2, 2 Cycle Latency Read



Notes: 1. A minimum of 3 cycles is required between a DCAB command and an ACTV command.

2. Turnoff cycles will be inserted between didle and ad1 as specified by the bank configuration.

Figure 94. SDRAM Burst Length 2, 3 Cycle Latency Read



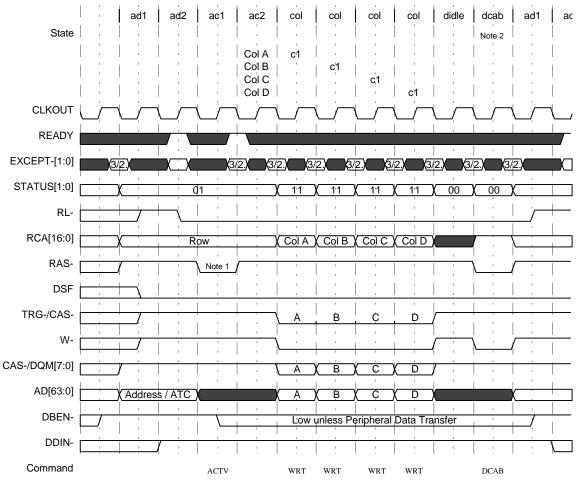
- 1. A minimum of 3 cycles is required between a DCAB command and an ACTV command.
- 2. Turnoff cycles will be inserted between didle and ad1 as specified by the bank configuration.

Figure 95. SDRAM Burst Length 2, 4 Cycle Latency Read

SDRAM write cycles

Write cycles begin with an activate command to activate the bank and select the row. The TC outputs the column address and activates the /TRG/CAS and /W strobes for each write command. For burst length 1 accesses, a write command can occur on each cycle. For burst length 2 accesses, a write command may occur every two cycles. The TC drives data out on AD[63:0] during each cycle of an active write command and indicates valid bytes by driving the appropriate /CAS/DQM strobes low. During peripheral device packet transfers, /DBEN remains high and AD[63:0] is placed in high impedance so that the peripheral may drive data into the memories. Additionally, the number of turn off cycles identified by the TO(1:0) field for the addressed bank of memory will be applied during PDT write cycles.

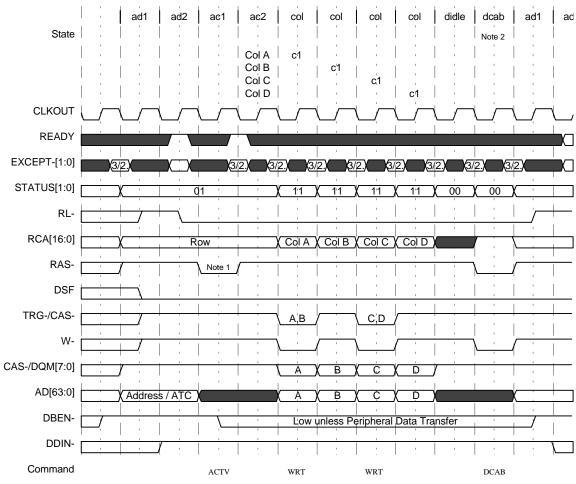
Exceptions are not supported in Figure 96 and Figure 97. Support for exceptions increases the minimum number of cycles between ad1 and the first column state from 4 to 6.



- 1. A minimum of 3 cycles is required between a DCAB command and an ACTV command.
- 2. During peripheral data transfers, turnoff cycles will be inserted prior to ad1 as specified by the bank configuration.

Figure 96. SDRAM Burst Length 1 Write

SDRAM write cycles (continued)



- 1. A minimum of 3 cycles is required between a DCAB command and an ACTV command.
- 2. During peripheral data transfers, turnoff cycles will be inserted prior to ad1 as specified by the bank configuration.

Figure 97. SDRAM Burst Length 2 Write

special register set cycle

Special register set (SRS) cycles are used to program control registers within an SGRAM. The 'C82 only supports programming of the color register for use with block writes. The cycle is similar to a single-burst-length-1 write cycle but DSF is driven high. The values output on the 'C82's RCA[16:0] bus causes the color register to be selected as shown in Figure 98. The color register value is output on the AD[63:0] bus.

Exception are not supported in Figure 99; support for exceptions increases the number of cycles between ad1 and the column access from 4 to 6.

| SDRAM Addr Pin | BS | Α8 | A7 | A6 | A5 | A4 | A3 | A2 | A1 | A0 |
|-------------------|----|----|----|----|----|----|----------|----|----|----|
| SDRAM Function | 0 | 0 | 0 | LC | LM | LS | Stop Reg | | | |
| 'C82 Output Value | | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 |

Figure 98. Special Register Set Value

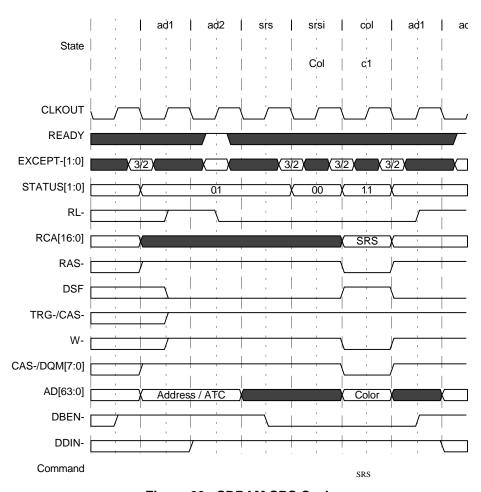
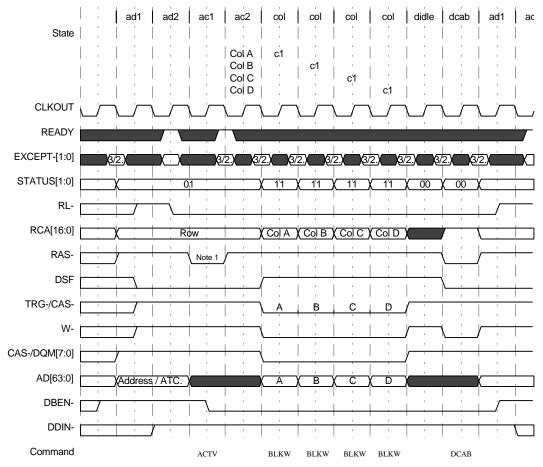


Figure 99. SDRAM SRS Cycle

SDRAM block-write cycles

Block-write cycles allow SGRAMs to write a stored color value to multiple column locations in a single access. Block-write cycles are similar to write cycles except that DSF is driven high to indicate a block-write command. Because burst is not supported for block write, burst length 2 accesses generate a single block write every other clock cycle.

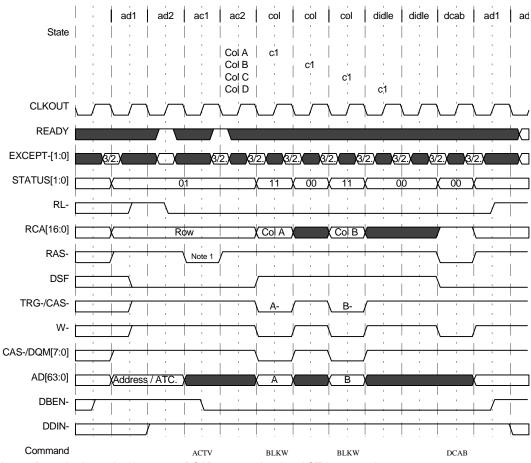
Exceptions are not supported in Figure 100 and Figure 101. Support for exceptions increases the minimum number of cycles between ad1 and the first column state from 4 to 6.



Note 1: A minimum of 3 cycles is required between a DCAB command and an ACTV command.

Figure 100. SDRAM Burst Length 1 Block Write

SDRAM block-write cycles (continued)

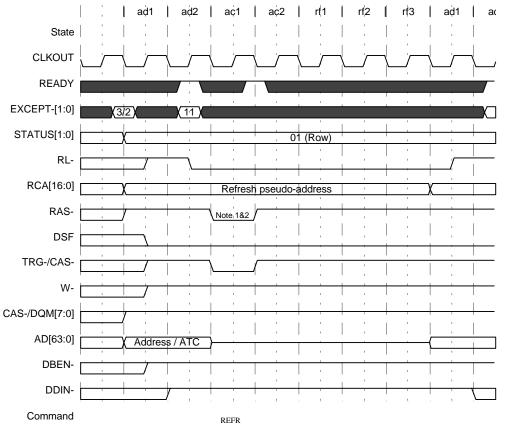


Note 1: A minimum of 3 cycles is required between a DCAB command and an ACTV command.

Figure 101. SDRAM Burst Length 2 Block Write

SDRAM refresh cycle

The SDRAM refresh cycle is performed when the TC receives an SDRAM cycle timing input (/EXCEPT[1:0] = 11) at the start of a refresh cycle. The /RAS and /TRG/CAS outputs are driven low for 1 cycle to strobe a refresh command (REFR) into the SDRAM. The refresh address is generated internal to the SDRAM. The 'C82 outputs a 16-bit pseudo-address (used for refresh bank decode) on RCA[16:1]. The pseudo-address is decremented once for each refresh that is performed.



- 1. A minimum of three cycles is required between the CLKOUT edges of a DCAB command and a subsequent ACTV command.
- 2. A minimum of seven cycles is required between the CLKOUT edges of a REFR command and a subsequent REFR or ACTV command.

Figure 102. SDRAM Refresh

bank configuration cycle

The 'C82 bank configuration cycle is required each time a new bank of memory is to be accessed whose configuration is not in the memory-configuration cache. The memory cache contains six entries. Entry replacement is based on a multiple-level least-recently-used algorithm. The least-recently-used lowest-priority entry will be flushed from the cache if all six entries are used.

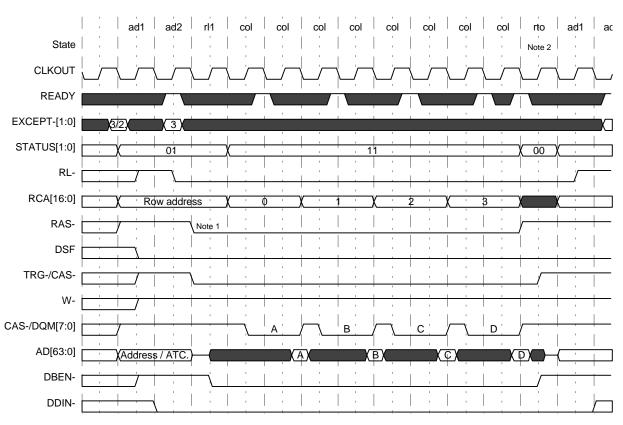
Bank configuration cycles may occur as the result of a cache miss, packet transfer, DEA, or may be requested by the system by inputting an exception code of 00 on the /EXCEPT[1:0] inputs during the ad2 state of a memory access. This exception code forces the bank configuration to be flushed and a new configuration for that bank to be read in. This is particularly useful for systems that use "shadow mapping" to decode two different memory types to the same address.

A configuration cache fill resembles a normal read cycle, with a few exceptions. Most notable are:

- Accesses are byte width only.
- Only four accesses are performed.

In four consecutive reads, the bank configuration fields described in Figure 55 are read in over either AD[63:56] (big-endian mode) or AD[7:0] (little-endian mode). This sequence is atomic, and no pipeline bubbles will occur. The RCA bus outputs the sequence 00, 01, 02, and 03 for the four accesses. The configuration cache cycle is indicated by a row time status code of 1110 output on AD[35:32]. It is anticipated that external logic will latch that status code (using /RL) and several upper address bits (AD[31:xx]) and decode RCA[1:0] to respond with the appropriate bank configuration information.

bank configuration cycle (continued)



- 1. No RAS- high time requirements are applied to these cycles.
- 2. Additional turnoff cycles can be inserted by adding waitstates during the rto (turnoff) cycle. This capability is unique to this cycle.

Figure 103. Bank Configuration Cycle

host interface

The 'C82 contains a simple three-pin mechanism by which a host or other device may gain control of the 'C82 local memory bus. The /HREQ input may be driven low by the host to request the 'C82's bus. Once the TC has completed the current memory access, it will place the local bus (except CLKOUT) into a high-impedance state. It will then drive the /HACK output low to indicate that the host device owns and may drive the bus. The REQ output reflects the highest-priority cycle request being received internally by the TC. The host can monitor this output to determine if It needs to relinquish the local bus back to the 'C82.

Table 49. REQ Output

| REQ | ASSOCIATED INTERNAL TC REQUEST |
|-----|--------------------------------|
| 1 | Urgent refresh or XPT |
| 0 | All other activity |

device reset

The TMS320C82 is reset when the /RESET input is driven low. The 'C82 outputs will immediately go into a high-impedance state with the exception of CLKOUT, /HACK, and REQ. While /RESET is low, all internal register are set to their default values and internal logic is reset.

On the rising edge of /RESET, the state of READY is sampled to determine if big-endian (READY=0) or little-endian (READY=1) operation is selected. The state of /HREQ is also sampled to determine if the master processor will come up running (/HREQ=0) or halted (/HREQ=1). All other inputs and data lines are don't cares during device reset.

Once /RESET is high, the 'C82 will drive the high-impedance signals to their inactive values. The TC will then perform 32 refresh cycles to initialize system memory. If, during initialization refresh, the TC receives an SDRAM cycle timing code (/EXCEPT[1:0] = 11), it will perform an SDRAM DCAB cycle to initialize SDRAM and then continue with the refresh cycles.

After completing initialization refresh, if the MP is running, the TC will perform a bank configuration cycle for the bank at address 0xFFFFFC0. This is the cache subblock which contains the starting MP instruction located at 0xFFFFFFF8. If the MP comes up halted, the configuration cycle and instruction cache fills will not take place until the first occurrence of an /EINT3 interrupt to unhalt the MP.

absolute maximum ratings†

| Supply voltage range, V _{DD} (see Note 1) | 0.3 V to 4 \ |
|--|--------------|
| Input voltage range, V _I | |
| Output voltage range | |
| Operating case temperature range, T _C | |
| Storage temperature range | |

NOTE 1: All voltage levels are with respect to ground (V_{SS}).

recommended operating conditions

| | PARAMETER | MIN | NOM | MAX | UNIT |
|--------------------|---|-------|-----|-------|------|
| V_{DD} | Supply voltage | 3.165 | 3.3 | 3.465 | V |
| V _{DDPLL} | Phase-locked loop supply voltage (see Note 2) | 3.165 | 3.3 | 3.465 | V |
| V _{SS} | Supply voltage (see Note 3) | 0 | 0 | 0 | V |
| V _{SSPLL} | Phase-locked loop supply voltage (see Note 2) | 0 | 0 | 0 | V |
| I _{ОН} | High-level output current | | | -400 | μΑ |
| l _{OL} | Low-level output current | | | 2 | mA |
| T _C | Operating case temperature | 0 | | 85 | °C |

- NOTES: 2. The VDDPLL pin should be supplied through an EMI filter coupled to VSSPLL. Care should be taken to provide a minimum inductance path between VSSPLL and system ground.
 - 3. In order to minimize noise on VSS, care should be taken to provide a minimum inductance path between the VSS pins and system

electrical characteristics over full ranges of supply voltage and operating case temperature (unless otherwise noted)

| • | PARAMETER | TEST CONDITIONS [‡] | MIN | TYP | MAX | UNIT |
|-----------------|--|--|------|-----|-----------------------|------|
| V _{IH} | High-level input voltage | | 2 | | V _{DD} + 0.3 | V |
| V_{IL} | Low-level input voltage | | -0.3 | | 0.8 | V |
| V _{OH} | High-level output voltage | V _{DD} = min, I _{OH} = max | 2.4 | § | | V |
| V _{OL} | Low-level output voltage | V _{DD} = max, I _{OH} = min | | | 0.6 | V |
| IO | Output current, leakage (high-impedance) | $V_{DD} = max, V_{O} = 2.8V$ | | | 20 | μA |
| | (except EMU0, and EMU1) | $V_{DD} = max, V_{O} = 0.6V$ | | | -20 | |
| I | Input current (except TCK, TDI, and TMS) | $V_I = V_{SS}$ to V_{DD} | | | ±20 | μA |
| I _{DD} | Supply current (See Note 4) | V _{DD} = max, 60 MHz | | 1.2 | 2.2 | Α |
| | | V _{DD} = max, 50 MHz | | 1.1 | 2.1 | |
| IDDPLL | PLL supply current | | | | 150 | mA |
| Cl | Input capacitance | | | 10 | | pF |
| СО | Output capacitance | | | 10 | | pF |

NOTE 4: Maximum supply current is derived from a test case that generates the theoretical maximum data flow using a worst casecheckerboard data pattern on a sustained cycle-by-cycle basis. Typical supply current is derived from a test case which attempts to emulate typical use conditions of the on-chip processors with random data. Typical IDD will vary from application to application based on data flow, transitions, and on-chip processor utilization.

For conditions shown as MIN/MAX, use the appropriate value specified under the recommended operating conditions.



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

 $[\]ddagger$ All typical values are at V_{DD} = 3.3 V, T_A = 25°C \S Typical steady state V_{OH} will not exceed V_{DD}

PARAMETER MEASUREMENT INFORMATION

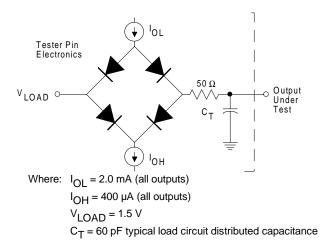


Figure 104. Test Load Circuit

signal transition levels

TTL-level outputs are driven to a minimum logic-high level of 2.4 V and to a maximum logic-low level of 0.6 V. Figure 105 shows the TTL-level outputs.



Figure 105. TTL Level Outputs

TTL-output transition times are specified as follows:

For a high-to-low transition on a TTL-compatible output signal, the level at which the output is said to be no longer high is 2 V, and the level at which the output is said to be low is 0.8 V.

For a low-to high transition, the level at which the output is said to be no longer low is 0.8 V, and the level at which the output is said to be high is 2 V.

Figure 106 shows the LVTTL-level inputs

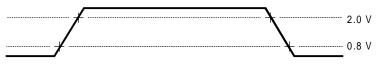


Figure 106. LVTTL Level Inputs

LVTTL-compatible input transition times are specified as follows:

For a high-to-low transition on a input signal, the level at which the input is said to be no longer high is 2 V, and the level at which the input is said to be low is 0.8 V.

For a low-to-high transition on an input signal, the level at which the input is said to be no longer low is 0.8 V, and the level at which the input is said to be high is 2 V.

timing parameter symbology

Timing parameter symbols used herein were created in accordance with JEDEC Standard 100-A. In order to shorten the symbols, some of the pin names and other related terminology have been abbreviated as follows:

| A AD ADS | AD[31:0] AD[63:0] AD[39:32] | OUT | AD[63:0], /CAS/DQM[7:0], /DBEN, /DDIN, DSF, /RAS, /RL, STATUS[1:0], /TRG/CAS, /W |
|----------------|-----------------------------------|-----|--|
| CAS | /CAS/DQM[7:0] | STS | STATUS[1:0] |
| CKI | CLKIN | RAS | /RAS |
| CKO | CLKOUT | RCA | RCA[16:0] |
| CMP | /EXCEPT[1:0], READY | RDY | READY |
| D | AD[63:0] | RST | /RESET |
| EIN | /EINT1, /EINT2, /EINT3 | REQ | REQ |
| EMU | EMU0, EMU1 | RL | /RL |
| EXC | /EXCEPT[1:0] | TCK | TCK |
| HAK | /HACK | TDI | TDI |
| HRQ | /HREQ | TDO | TDO |
| LIN | /LINT4 | TMS | TMS |
| MID | AD[63:0], RCA[16:0], STATUS[1:0] | TRS | /TRST |
| | | XPT | /XPT[3:0] |

LOWERCASE SUBSCRIPTS AND THEIR MEANINGS ARE:

| а | access time |
|----|------------------------|
| С | cycle time (period) |
| d | delay time |
| h | hold time |
| su | setup time |
| t | transition time |
| w | pulse duration (width) |

THE FOLLOWING LETTERS AND SYMBOLS AND THEIR MEANINGS ARE:

| D | Driven |
|---|--|
| Н | High |
| L | Low |
| V | Valid |
| Χ | Unknown, changing, or don't-care level |
| Z | High impedance |

general notes on timing parameters

The period of CLKOUT may be equal to, or is twice the period of CLKIN $(t_{C(CKI)})$ depending on whether or not PLL mode is selected. In PLL mode, CLKOUT is the same period as CLKIN. In non-PLL mode, the period of CLKOUT will be twice the period of CLKIN, or 2t_{C(CKI)}. The half cycle time (t_H) that appears in the following tables is one-half the output clock period.

All output signals from the 'C82 (including CLKOUT) are derived from an internal clock such that all output transitions for a given half-cycle occur with a minimum of skewing relative to each other.

The signal combinations shown in the following timing diagrams may not necessarily represent actual cycles. For actual cycle examples, refer to the appropriate cycle description section of this data sheet.

CLKIN timing requirements

| NO. | PARAMETER | | C82 | C82-50 | | C82-60 | |
|-----|----------------------|-------------------------------|------|--------|-----|--------|-----|
| | | | MIN | MAX | MIN | MAX | |
| 1 | ^t c(CKI) | Period of CLKIN | 10.0 | | 8.3 | | ns |
| 2 | ^t w(CKIH) | Pulse duration of CLKIN high | 4.2 | | 3.9 | | ns |
| 3 | ^t w(CKIL) | Pulse duration of CLKIN low | 4.2 | | 3.9 | | ns |
| 4 | t _t (CKI) | Transition time of CLKIN † | | 1.5 | | 1.5 | ns |
| 5 | FLOCK | Phased-locked loop lock range | 40 | 80 | 40 | 80 | MHz |

[†] This parameter is verified by computer simulation and is not tested.

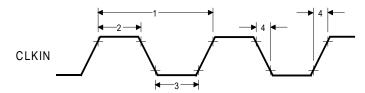


Figure 107. CLKIN Timing

local bus switching characteristics - CLKOUT

CLKOUT may switch at either the CLKIN rate (PLL mode) or ½ the CLKIN rate (non-PLL mode). In either mode, no skew or phase relationship is guaranteed (function of PLL is to allow for higher processor rates with lower frequency oscillator). Each state of a memory access begins on the falling edge of CLKOUT.

| NO. | PARAMETER | | C82-50 | | C82-60 | | UNIT |
|-----|---------------------|---------------------------------|-----------------------------------|------------------|-----------------------------------|----------------|------|
| | | | MIN | MAX | MIN | MAX | |
| 6 | ^t c(CKO) | Period of CLKOUT (non-PLL mode) | ^{2t} c(CKI) [†] | | ^{2t} c(CKI) [†] | | ns |
| 6 | ^t c(CKO) | Period of CLKOUT (PLL mode) | t _{c(CKI)} † | | t _{c(CKI)} † | | ns |
| 7 | tw(CKOH) | Pulse duration of CLKOUT high | t _H -4.5 | | t _H -3.7 | | ns |
| 8 | tw(CKOL) | Pulse duration of CLKOUT low | t _H -4.5 | | t _H -3.7 | | ns |
| 9 | ^t t(CKO) | Transition time of CLKOUT | | 2 [‡] | | 2 [‡] | ns |
| 10 | ^t JITTER | CLKOUT jitter (PLL mode only) | | 1.2 [§] | | 0.8§ | ns |

[†] This is a functional minimum and is not tested. This parameter may also be specified as 2t_H.

[§] This parameter is characterized and is not tested.

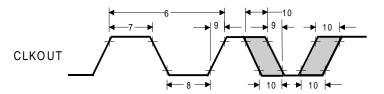


Figure 108. CLKOUT Timing

[‡] This parameter is specified by computer simulation and is not tested.

device reset timing requirements

| NO. | | Р | ARAMETER | MIN | MAX | UNIT |
|-----|----------------------------|--|--|-----------------|-----|------|
| 11 | ^t w(RSTL) | Duration of /RESET low Initial reset during power-up (non-PLL mode) | | 6t _H | | ns |
| | | | Initial reset during power-up (PLL mode) | 2 | | μs |
| | | | Reset during active operation | ^{6t} H | | |
| 12 | ^t su(HRQL-RSTH) | Setup time of /HREQ low to / self-bootstrap mode | ^{4t} H | | ns | |
| 13 | ^t h(RSTH-HRQL) | Hold time, /HREQ low after /F mode | RESET high to configure self-bootstrap | 0 | | ns |
| 14 | ^t su(RDYL-RSTH) | Setup time of READY low to /RESET high to configure big-endian operation | | ^{4t} H | | ns |
| 15 | ^t h(RSTH-RDYL) | Hold time, READY low after /RESET high to configure big-endian operation | | 0 | | ns |

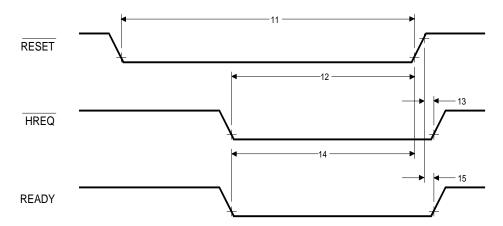


Figure 109. Device Reset Timing

local bus timing: memory exceptions

Memory exceptions are signaled to the 'C82 via the /EXCEPT[1:0] inputs. The /EXCEPT[1:0] inputs are sampled at the beginning of each row access during the ad2 state, and on each CLKOUT falling edge following rl1. The READY input is also sampled during the ad2 state and during each column access (2 and 3 cyc/col accesses only). The value *n* as used in the parameters represents the integral number of half-cycles between the transitions of the two signals in question.

| NO. | PARAMETER | | C8 | 2-50 | C8 | 2-60 | UNIT |
|-----|---------------------------|--|-----|----------------------|-----|----------------------|------|
| | | | MIN | MAX | MIN | MAX | |
| 16 | ta(MIDV-CMPV) | Access time, /EXCEPT[1:0] [†] , READY valid after memory identification (address, status) valid | | nt _H -8 | | nt _H -8 | ns |
| 17 | tsu(CMPV-CKO) | Setup time, /EXCEPT[1:0] [†] , READY valid to CLKOUT no longer high/low | 7.5 | | 7.5 | | ns |
| 18 | th(CKO-CMPV) | Hold time, /EXCEPT[1:0] [†] , READY valid after CLKOUT no longer high/low | 2.0 | | 2.0 | | ns |
| 19 | ^t a(RASL-RRV) | Access time /EXCEPT[1:0], READY valid from /RAS low | | nt _H -7.5 | | nt _H -7.5 | ns |
| 20 | ^t a(RLL-RRV) | Access time, /EXCEPT[1:0], READY valid from /RL low | | nt _H -7.5 | | nt _H -7.5 | ns |
| 21 | ^t a(CASL-RDYV) | Access time, READY valid from /CAS low | | nt _H -8 | | nt _H -8 | ns |

[†] This parameter also applies to refresh cycles, wherein cycle timing is determined via the /EXCEPT[1:0] pin codings.

local bus timing: memory exceptions (continued)

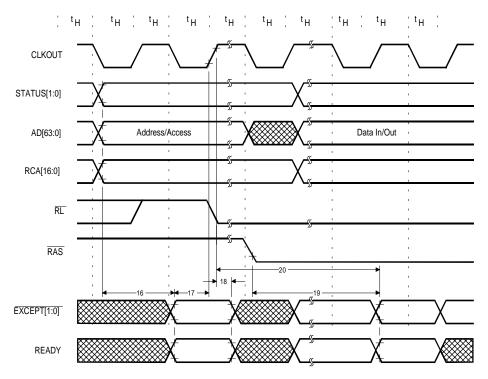


Figure 110. Row Time Cycle Completion Input Timing

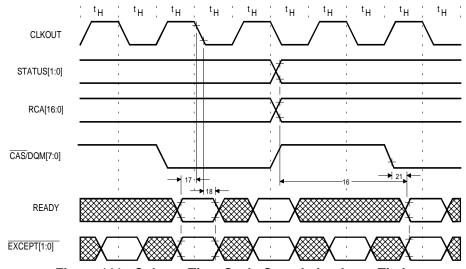


Figure 111. Column Time Cycle Completion Input Timing

TMS320C82 DIGITAL SIGNAL PROCESSOR

SPRS048 — APRIL 1998

general output signal characteristics

The following general timing parameters apply to all TMS320C82 output signals unless otherwise specifically given. The value n as used in the parameters represents the integral number of half-cycles between the transitions of the two outputs in question. For timing purposes, outputs fall into one of three groups: the address/data bus (AD[63:0]); the other output busses (RCA[16:0], STATUS[1:0], /CAS/DQM[7:0]); and non-bus outputs (/DBEN, /DDIN, DSF, /RAS, /RL, /TRG/CAS, /W). When measuring output to output, the named group refers to the first output to transition (Output A), and the second output (Output B) refers to any output group.

general output signal characteristics (continued)

| NO. | | PARAMETER | C82 | 2-50 | C82 | UNIT | |
|-----|----------------------------|---|--|--|--|--|----|
| | | | MIN | MAX | MIN | MAX | |
| 22 | ^t h(OUTV-CKOL) | Hold time, CLKOUT high after output valid AD[63:0] | nt _H -5.3 | | nt _H -5.3 | | ns |
| | | RCA[16:0], STATUS[1:0], | nt _H -4.5 nt _H -4.8 | | nt _H -4.4 nt _H -4.7 | | |
| | | /CAS/DQM[7:0] (CT = 0X0X) /CAS/DQM[7:0] (CT != 0X0X) | nt _H -4.4 | | nt _H -4.4 | | |
| | | /DBEN, /DDIN, DSF, /RAS, /RL, /TRG/CAS, /W | nt _H -3.9 | | nt _H -3.9 | | |
| 23 | th(OUTV-CKOH) | Hold time, CLKOUT low after output valid AD[63:0] | nt _H -5.5 | | nt _H -5.3 | | ns |
| | | RCA[16:0], STATUS[1:0], | nt _H -4.5 | | nt _H -4.5 | | |
| | | /CAS/DQM[7:0] (CT = 0X0X) | nt _H -5.0 | | nt _H -4.7 | | |
| | | /CAS/DQM[7:0] (CT != 0X0X) | nt _H -4.6 | | nt _H -4.5 | | |
| | | /DBEN, /DDIN, DSF, /RAS, /RL, /TRG/CAS, /W | nt _H -4.1 | | nt _H -4.1 | | |
| 24 | ^t h(CKOL-OUTV) | Hold time, output valid after CLKOUT low | nt _H -5 | | nt _H -5 | | ns |
| 25 | ^t h(CKOH-OUTV) | Hold time, output valid after CLKOUT high | nt _H -5.4 | | nt _H -5 | | ns |
| 26 | ^t h(OUTV-OUTV) | Hold time, output valid after output valid | nt _H -6.5 | | nt _H -6.3 | | ns |
| | | AD[63:0] RCA[16:0], STATUS[1:0], | nt _H -5.5 | | nt _H -5.5 | | |
| | | /CAS/DQM[7:0] (CT = 0X0X) | nt _H -5.9 | | nt _H -5.7 | | |
| | | /CAS/DQM[7:0] (CT != 0X0X) | nt _H -5.5 | | nt _H -5.5 | | |
| | | /DBEN, /DDIN, DSF, /RAS, /RL, /TRG/CAS, /W | nt _H -5 | | nt _H -4.8 | | |
| 27 | t _d (CKOL-OUTV) | Delay time, CLKOUT no longer high to output valid | | nt 16.5 | | nt JEO | ns |
| | | AD[63:0] | | nt _H +6.5 nt _H +5.5 | | nt _H +5.9 nt _H +5.5 | |
| | | RCA[16:0], STATUS[1:0], /CAS/DQM[7:0] /DBEN, /DDIN, DSF, /RAS, /RL, /TRG/CAS, /W | | nt _H +5 | | nt _H +4.7 | |
| 28 | + | Delay time, CLKOUT no longer low to output valid | | н | | н. | ns |
| | ^t d(CKOH-OUTV) | AD[63:0] | | nt _H +6.5 | | nt _H +5.9 | |
| | | RCA[16:0], STATUS[1:0], /CAS/DQM[7:0] | | nt _H +5.5 | | nt _H +5.5 | |
| | | /DBEN, /DDIN, DSF, /RAS, /RL, /TRG/CAS, /W | | nt _H +5 | | nt _H +4.7 | |
| 29 | ^t d(OUTV-OUTV) | Delay time, output no longer valid to output valid | | nt _H +6.5 | | nt _H +6.3 | ns |
| | | AD[63:0] RCA[16:0], STATUS[1:0], | | nt _H +5.5 | | nt _H +5.5 | |
| | | /CAS/DQM[7:0] (CT = 0X0X) | | nt _H +5.9 | | nt _H +5.7 | |
| | | /CAS/DQM[7:0] (CT != 0X0X) | | nt _H +5.6 | | nt _H +5.5 | |
| | | /DBEN, /DDIN, DSF, /RAS, /RL, /TRG/CAS, /W | | nt _H +5 | | nt _H +4.8 | |
| 30 | ^t d(OUTV-CKOL) | Delay time, output no longer valid to CLKOUT low | | nt _H +5 | | nt _H +5 | ns |
| 31 | ^t d(OUTV-CKOH) | Delay time, output no longer valid to CLKOUT high | | nt _H +5.4 | | nt _H +5 | ns |
| 32 | ^t w(OUTV) | Pulse width, output valid | nt _H -6.5 | | nt _H -6.3 | | ns |
| | | AD[63:0] | nt _H -5.5 | | nt _H -5.5 | | |
| | | RCA[16:0], STATUS[1:0], /CAS/DQM[7:0] (CT = 0X0X) | nt _H -5.9 | | nt _H -5.6 | | |
| | | /CAS/DQM[7:0] (CT != 0X0X) | nt _H -5.6 | | nt _H -5.5 | | |
| | | /DBEN, /DDIN, DSF, /RAS, /RL, /TRG/CAS, /W | nt _H -5 | | nt _H -5 | | |
| 33 | ^t h(CKOL-ADZ) | Hold time, AD[63:0] driven after CLKOUT low [†] | nt _H -5 | | nt _H -5 | | ns |
| 34 | th(CKOH-ADZ) | Hold time, AD[63:0] driven after CLKOUT high [†] | nt _H -5 | | nt _H -5 | | ns |
| 35 | t _d (CKOL-ADZ) | Delay time, CLKOUT no longer high to AD[63:0] Hi-Z [‡] | | nt _H +5 | | nt _H +5 | ns |
| 36 | t _d (CKOH-ADZ) | Delay time, CLKOUT no longer low to AD[63:0] Hi-Z [‡] | | nt _H +5 | | nt _H +5 | ns |

[†] This parameter is a functional minimum specified by logic and is not tested. ‡ This parameter is specified by characterization and is not tested.



general output signal characteristics (continued)

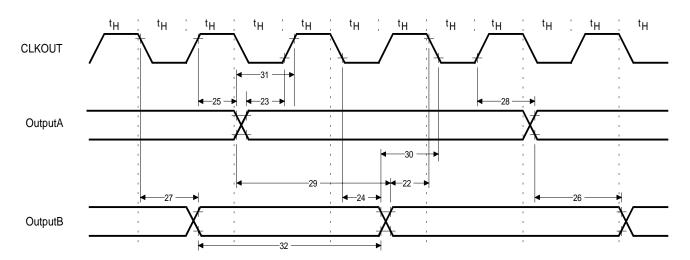


Figure 112. General Output Timing

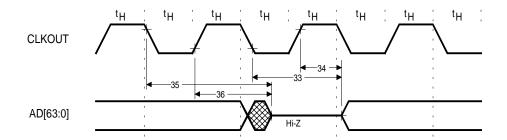


Figure 113. AD[63:0] Turnoff/Turn-Around Timing

data input signal characteristics

The following general timing parameters apply to the AD[63:0] inputs unless otherwise specifically given. The value *n* as used in the parameters represents the integral number of half cycles between the transitions of the output and input in question.

| NO. | | PARAMETER | C8 | 32-50 | C8 | UNIT | |
|-----|--------------------------|--|---------------|--|---------------|--|----|
| | | | MIN | MAX | MIN | MAX | |
| 37 | ^t a(CKOH-DV) | Access time, CLKOUT high to AD[63:0] valid | | nt _H -5.3 | | nt _H -5.3 | ns |
| 38 | ^t a(CKOL-DV) | Access time, CLKOUT low to AD[63:0] valid | | nt _H -6.5 | | nt _H -6.5 | ns |
| 39 | t _{su(DV-CKOH)} | Setup time, AD[63:0] valid to CLKOUT no longer low | 6.5 | | 6.1 | | ns |
| 40 | t _{su(DV-CKOL)} | Setup time, AD[63:0] valid to CLKOUT no longer high | 6.1 | | 6.1 | | ns |
| 41 | th(CKOL-DV) | Hold time, AD[63:0] valid after CLKOUT low | 2.5 | | 2.5 | | ns |
| 42 | th(CKOH-DV) | Hold time, AD[63:0] valid after CLKOUT high | 2.5 | | 2.5 | | ns |
| 43 | t _a (OUTV-DV) | Access time, output valid to AD[63:0] inputs valid AD[39:0] RCA[16:0], /CAS/DQM[7:0], STATUS[1:0] /DBEN, /DDIN, DSF, /RAS, /RL, /TRG/CAS, /W | | nt _H -7.6 nt _H -7 nt _H -6.5 | | nt _H -7.6 nt _H -7 nt _H -6.5 | ns |
| 44 | ^t h(OUTV-DV) | Hold time, AD[63:0] valid after output valid RCA[16:0], /CAS/DQM[7:0] (CT = 00xx) RCA[16:0], /CAS/DQM[7:0] (CT = 01xx) /RAS | 2.5 2 2 | | 2.5 2 2 | | ns |

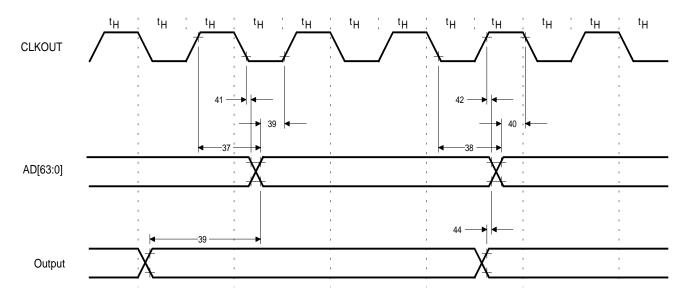


Figure 114. Data Input Timing

external interrupt timing

The following description defines the timing of the edge-triggered interrupts /EINT1 - /EINT3 and the level-triggered interrupt /LINT4 (see Note 5).

| NO. | | PARAMETER | C8 | 2-50 | C82-60 | | UNIT |
|-----|----------------------------|--|-----|------|--------|-----|------|
| | | | MIN | MAX | MIN | MAX | |
| 45 | ^t w(EINL) | Pulse duration, /EINTx low [†] | 6 | | 6 | | ns |
| 46 | ^t su(EINH-CKOH) | Setup time, /EINTx high before CLKOUT no longer low [‡] | 10 | | 10 | | ns |
| 47 | ^t w(EINH) | Pulse duration, /EINTx high [†] | 6 | | 6 | | ns |
| 48 | t _{su(LINL-CKOH)} | Setup time, /LINT4 low before CLKOUT no longer low [‡] | 9.5 | | 9.5 | | ns |

[†] This parameter is specified by characterization and is not tested.

NOTE 5: In order to ensure recognition, /LINT4 must remain low until cleared by the interrupt service routine.

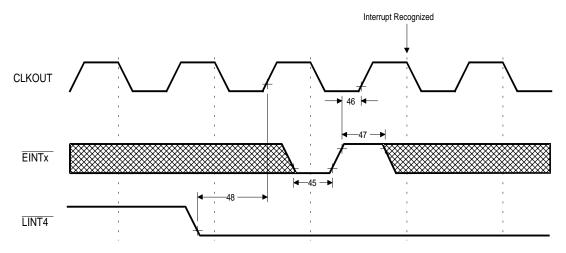


Figure 115. External Interrupt Timing

[‡] This parameter must only be met to ensure that the interrupt is recognized on the indicated cycle.

XPT input timing

The following description defines the sampling of the /XPT[3:0] inputs. The value encoded on the /XPT[3:0] inputs is synchronized over multiple cycles to ensure that a stable value is present.

| NO. | | C82 | 2-50 | C82-60 | | UNIT | |
|-----|---------------------------|--|------------------|-----------------|------------------|-----------------|----|
| | | | MIN | MAX | MIN | MAX | |
| 49 | ^t w(XPTV) | Pulse duration, /XPTx valid [¶] | ^{12t} H | | ^{12t} H | | ns |
| 50 | tsu(XPTV-CKOH) | Setup time, /XPT[3:0] valid before CLKOUT no longer low [†] | 12 | | 12 | | ns |
| 51 | ^t h(CKOH-XPTV) | Hold time, /XPT[3:0] valid after CLKOUT high | 5 | | 5 | | ns |
| 52 | ^t h(RLL-XPTV) | Hold time, /XPT[3:0] valid after /RL low [‡] | | 6t _H | | 6t _H | ns |

[†] This parameter must only be met to ensure that the XPT input is recognized on the indicated cycle.

[¶] This parameter is a functional minimum specified by logic and is not tested.

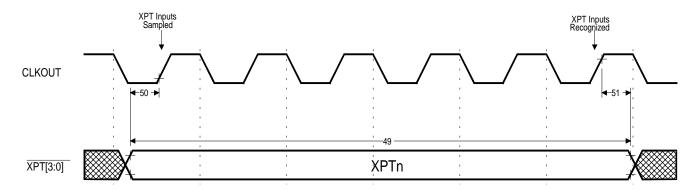


Figure 116. XPT Input Timing - XPT Recognition

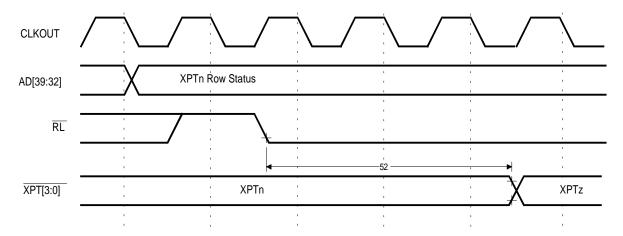


Figure 117. XPT Input Timing - XPT Service

[‡] This parameter must be met to ensure that a second XPT request does not occur. This parameter is a functional maximum specified by logic and is not tested.

host interface timing

| NO. | | PARAMETER | C82 | -50 | C82 | -60 | UNIT |
|-----|----------------------------|--|---------------------|-----|---------------------|-----|------|
| | | | MIN | MAX | MIN | MAX | 1 |
| 53 | ^t h(REQV-CKOH) | Hold time, CLKOUT low after REQ valid | t _H -7 | | t _H -5.5 | | ns |
| 54 | ^t h(CKOH-REQV) | Hold time, REQ valid after CLKOUT high | t _H -7 | | t _H -5.5 | | ns |
| 55 | ^t h(HRQL-HAKL) | Hold time, /HACK high after /HREQ low [‡] | 4t _H -12 | | 4t _H -12 | | ns |
| 56 | ^t d(HAKL-OUTZ) | Delay time, /HACK low to output Hi-Z [†] | | | | | |
| | | All signals except AD[63:0] | | 0 | | 0 | ns |
| | | AD[63:0] | | 1 | | 1 | |
| 57 | ^t d(HRQH-HAKH) | Delay time, /HREQ high to /HACK no longer low | | 10 | | 10 | ns |
| 58 | ^t d(HAKH-OUTD) | Delay time, /HACK high to outputs driven [‡] | 6t _H | | 6t _H | | ns |
| 59 | ^t su(HRQL-CKOH) | Setup time, /HREQ low to CLKOUT no longer low (see Note 6) | 8.5 | | 8.5 | | ns |

[†] This parameter is specified by characterization and is not tested.

This parameter must be met only to ensure /HREQ is sampled low on the indicated clock cycle.

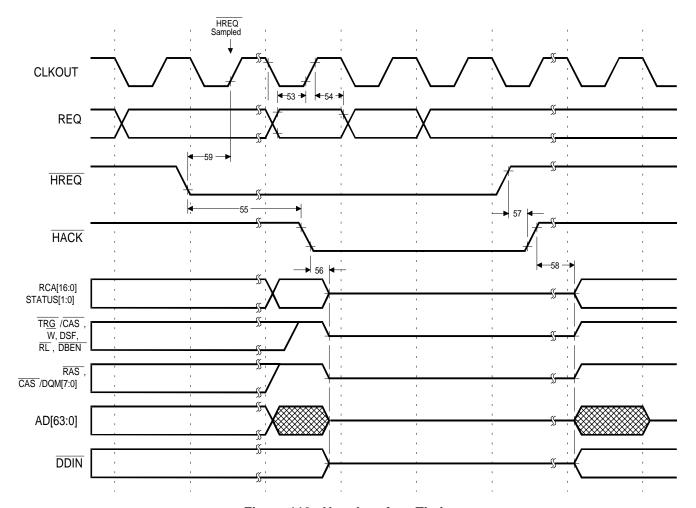


Figure 118. Host Interface Timing

[‡] This parameter is a functional minimum and is not tested.

thermal resistance

The following graph illustrates the maximum ambient temperature allowed for various air flow rates across the TMS320C82 to ensure that the case temperature is kept below the maximum operating temperature (85°C). (See Note 7.)

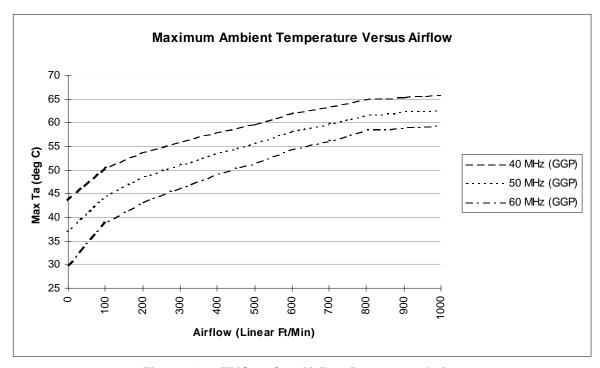
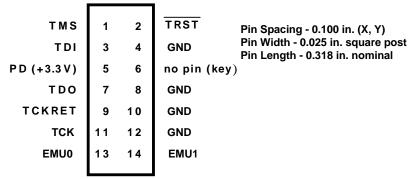


Figure 119. TMS320C82 Airflow Recommendations

Note 7: TMS320C82 power consumption is based on the "typical" values of I_{DD} measured at V_{DD} = 3.3 V. Power consumption will vary by application based on TMS320C82 processor activity and I/O pin loadings. Users must ensure that the case temperature (T_C) specifications are met when defining airflow and other thermal constraints of their system.

emulator interface connection

The TMS320C82 supports emulation through a dedicated emulation port which is a superset of the IEEE 1149.1 (JTAG) standard. To support the TMS320C82 emulator, a target system must include a 14-pin header (2 rows of 7 pins) with the connections shown below.



| XDS 510 [™] SIGNAL | XDS 510 STATE | TARGET STATE | DESCRIPTION |
|--------------------------------|------------------|-----------------|---|
| TMS | 0 | I | JTAG test mode select |
| TDI | 0 | I | JTAG test data input |
| TDO | I | 0 | JTAG test data output |
| TCK | 0 | I | JTAG test clock - 10 MHz clock source from emulator. Can be used to drive system test clock. |
| /TRST | 0 | I | JTAG test reset |
| EMU0 | I | I/O | Emulation pin 0 |
| EMU1 | I | I/O | Emulation pin 1 |
| PD | I | 0 | Presence detect - Indicates that the target is connected and powered-up. Should be tied to +3.3 V on |
| (+3.3 V) | | | target system |
| TCKRET | I | 0 | JTAG test clock return - Test clock input to the XDS510 emulator. May be buffered or unbuffered version of TCK. |

For best results, the emulation header should be located as close as possible to the TMS320C82. If the distance exceeds 6 inches, the emulation signals should be buffered.

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emulator interface connection (continued)

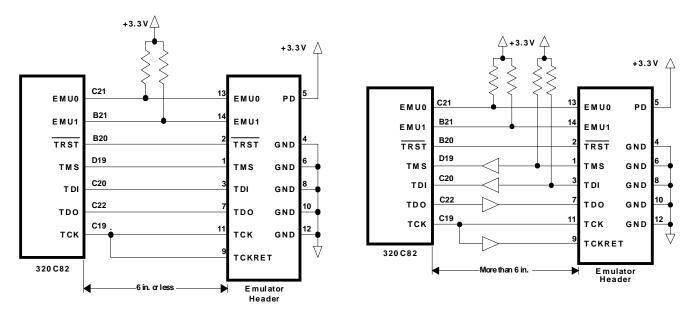


Figure 120. Emulation Header Connections - Emulator-Driven Test Clock

The target system may also generate the test clock. This allows the user to:

- Set test clock frequency to match system requirements. (The emulator provides a 10-MHz test clock)
- Have other devices in the system that require a test clock when the emulator is not connected.

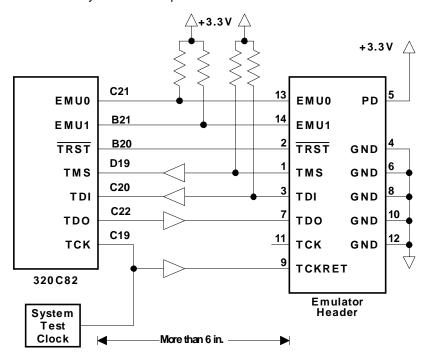


Figure 121. Emulation Header Connections - System-Driven Test Clock

emulator interface connection (continued)

For multiprocessor applications, the following are recommended:

- Buffer TMS, TDI, TDO, and TCK through the same physical package to reduce timing skew.
- Buffer inputs for TMS, TDI, and TCK should be pulled high (3.3 V). A pullup resistor of 4.7 kΩ or greater is suggested.
- Buffering EMU0 and EMU1 is highly recommended to provide isolation. The buffers need not be in the same physical package as TMS, TCK, TDI, or TDO. Pullups to 3.3 V are required and should provide a signal rise time of less than 10 μs. A 4.7-kΩ resistor is suggested for most applications.
- To ensure high quality signals, special PWB routing and use of termination resistors may be required. The emulator provides fixed series termination (33 Ω) on TMS and TDI and optional parallel terminators (180 Ω pullup and 270 Ω pulldown) on TCKRET and TDO.

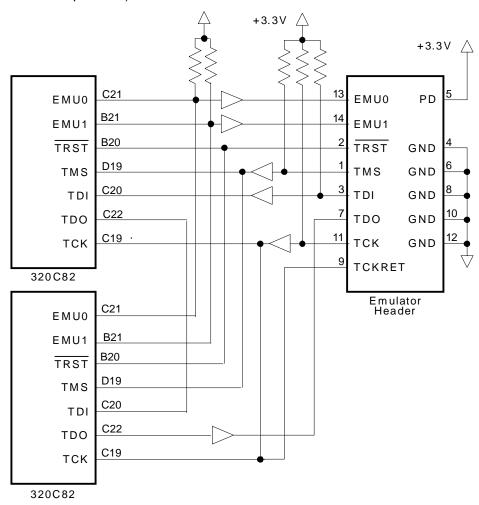
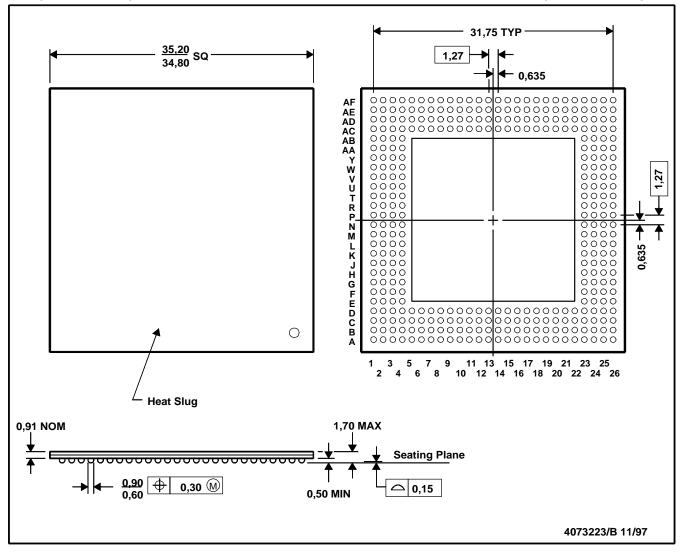


Figure 122. Emulation Header Connections - Multiprocessor Applications

MECHANICAL DATA

GGP (S-PBGA-N352)

PLASTIC BALL GRID ARRAY (CAVITY DOWN)



NOTES: 1. All linear dimensions are in millimeters

- 2. This drawing is subject to change without notice.
- 3. Thermally enhanced plastic package with metal heat slug (HSL)





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PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|---------------------|-------------------------|------------------|------------------------------|
| TMS320C82GGP50 | NRND | BGA | GGP | 352 | TBD | Call TI | Call TI |
| TMS320C82GGP60 | NRND | BGA | GGP | 352 | TBD | Call TI | Call TI |
| TMX320C82GGP | OBSOLETE | BGA | GGP | 352 | TBD | Call TI | Call TI |
| TMX320C82GGP50 | OBSOLETE | BGA | GGP | 352 | TBD | Call TI | Call TI |
| TMX320C82GGP60 | OBSOLETE | BGA | GGP | 352 | TBD | Call TI | Call TI |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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